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PRELIMINARY DATA SHEET BCM4325

IEEE 802.11 a/b/g MAC/Baseband/Radio Plus Bluetooth 3.0 + HS and FM Receiver Single-Chip Combination

GENERAL DESCRIPTION

The Broadcom[®] BCM4325 single-chip device provides the highest level of integration for a mobile or handheld wireless systems with integrated IEEE 802.11[™] a/b/g MAC/baseband/radio, Bluetooth[®] 3.0 + HS and a FM radio receiver.

Designed to address the needs of highly mobile devices that require minimal power consumption and board area, the BCM4325 provides a compact ultra-small form-factor solution with minimal external components. This solution drives down the costs of mass volumes, while allowing for flexibility in the size, form, and function of handheld devices.

Utilizing advanced design techniques and process technologies to deliver low active and idle power, the BCM4325 extends system battery life while maintaining consistent connectivity and high throughput.

An SDIO system interface (4b, 1b, or SPI) is provided for WLAN and an independent, high-speed UART is provided for the Bluetooth section.

A unique feature of the BCM4325 is its implementation of highly sophisticated InConcert[™] (IEEE 802.15.2) radio coexistence algorithms and hardware mechanisms.

InConcert provides the highest possible degree of collaboration between Bluetooth[®] and WLAN using a shared 2.4 GHz antenna, along with coexistence support for external radio technologies such as GPS, WiMax and Ultra Wide-Band (UWB).

As a result, the overall quality of simultaneous voice, video, and data transmission on a handheld system is enhanced while minimizing the PCB footprint.

Designed to support flexible power supply topologies, including operation directly from the rechargeable battery in a mobile platform, the BCM4325 integrates a power management unit with five LDOs and two switching regulators.

The integrated CMOS WLAN 2.4 GHz and 5 GHz power amplifiers provide sufficient output power to meet the needs of most WLAN devices, without the need for an external PA. Furthermore, the integrated buck-boost regulator allows the internal power amplifiers to operate at optimal performance, even at low Vbatt supply voltages. Transmit and receive baluns are also integrated.



Figure 1: Functional Block Diagram

FEATURES

General Features

- Supports a battery voltage ranging from 2.3V to 5.5V with the internal buck-boost switching regulator
- Low power consumption and dynamic power management maximize battery life of handheld devices
- Five LDO regulators and two switching regulators with an on-chip, programmable power management unit
- Integrated CMOS power amplifiers deliver greater than 20 dBm of linear output power
- Supports a single 2.4 GHz antenna shared between WLAN and Bluetooth
- Internal fractional nPLL allows support for a wide range of reference clock frequencies.
- 2k-bit OTP for storing board parameters
- 196-ball flip-chip FBGA package (7.5 mm x 7.5 mm x 1.05 mm, 0.5 mm pitch) and 339-pin WLCSP package (6.51 mm x 5.81 mm x 0.42 mm, 0.25 mm pitch). Dimensions are nominal, see Figure 35 on page 115 and Figure 36 on page 116 for maximum dimensions)
- Provides an ultra-small form-factor solution and ultra low-power consumption to support low-cost requirements

IEEE 802.11x Features

- Single-band 2.4 GHz 802.11 b/g or dual-band 2.4 GHz and 5 GHz 802.11 a/b/g pin-compatible options
- Integrated WLAN CMOS power amplifiers deliver greater than 20 dBm of linear output power.
- Provides external coexistence handshake interface to support additional wireless technologies such as GPS, WiMax, or UWB
- Supports SDIO v1.2 (4-bit and 1-bit) and SPI, with SDIO clock speeds up to 50 MHz
- Integrated ARM7[®] RISC processor and on-chip memory for complete WLAN subsystem functionality minimizing the need to wake up the applications processor for standard WLAN functions. This allows for further minimization of power consumption, while maintaining the capability to field upgrade with future features.

Security

- WPA™ and WPA2™ (Personal) support for powerful encryption and authentication
- AES and TKIP acceleration hardware for faster data encryption and 802.11i compatibility
- Cisco[®] Compatible Extension—(CCX, CCX 2.0, CCX 3.0, CCX 4.0) certified
- SecureEasySetup[™] for simple Wi-Fi[®] setup and WPA2/ WPA security configuration
- Wi-Fi Protected Setup (WPS)
- Supports IEEE 802.11d, e (WMM, QoS, WMM-PS), h, i, j (k, r, and w in the future)
- Worldwide regulatory support Global products supported with worldwide homologated design

Bluetooth Features

- Bluetooth Core specification 3.0 + HS compliant when combined with Bluetooth 3.0 + HS qualified host software, including Alternate MAC/PHY, read encryption key size, enhanced power control, and unicast connectionless data.
- Supports extended Synchronous Connections (eSCO), for enhanced voice quality by allowing for retransmission of dropped packets
- Adaptive Frequency Hopping (AFH) for reducing radio frequency interference
- Bluetooth Class 1 support with PA bias adjust
- Interface support—Host Controller Interface (HCI) using a high-speed UART interface and PCM for audio data
- Integrates the InConcert collaborative WLAN coexistence, including the 802.15.2 3-wire coexistence support
- Supports dual Advanced Audio Distribution Profile (A2DP) for stereo sound
- Automatic frequency detection for standard crystal and TCXO values
- Embedded ARM7 RISC processor and on-chip memory

FM Radio Features

- FM receiver
 - 76 MHz to 108 MHz FM bands
 - European Radio Data Systems (RDS) and North American Radio Broadcast Data System (RBDS) modulation support
- I²C-compatible BSC communications support
- Stereo analog output
- I²S and PCM interfaces

REVISION HISTORY

| Revision | Date | Description |
|-------------|---------|---|
| 4325-DS04-R | 6/30/09 | Updated: Title "General Decsription: on page i "Bluetooth Features" on page ii "Overview" on page 1 Table 2, "Crystal Interface Signal Characteristics," on page 6 Table 3, "LPO Signal Requirements," on page 9 "Bluetooth Features" on page 11 "Bluetooth Features" on page 14 "Bluetooth UART Interface" on page 20 "One-Time-Programmable (OTP) Memory" on page 33 "JTAG Interface" on page 34 Table 8, "196-Ball FBGA Signal Descriptions," on page 43 Table 9, "339-Pin WLCSP Signal Descriptions," on page 52 Table 14, "WLAN GPIO Functions and Strapping Options," on page 67 Table 21, "ESD Specifications," on page 75 Table 22, "Environmental Ratings," on page 76 Table 23, "Recommended Operating Conditions and DC Characteristics," on page 76 "WLAN Receiver Blocking Performance" on page 86 "SDIO Host Timing Requirement" on page 107 |
| | | Table 57, "Ordering Information," on page 120 |
| 4325-DS03-R | 3/11/09 | Updated: General Description on page i Features on page ii "Overview" on page 1 "Mobile Phone Usage Model" on page 2 "Power Supply Topology" on page 4 "Reset Circuits" on page 5 "Crystal Interface and Clock Generation" on page 6 Table 2, "Crystal Interface Signal Characteristics," on page 6 Figure 6, "Recommended Oscillator Configuration," on page 7 "Frequency Selection" on page 8 Table 3, "LPO Signal Requirements," on page 9 "Broadcom Serial Control (BSC) Bus" on page 23 Table 6, "196-Ball FBGA Signal Assignments by Ball Number," on page 37 Table 6, "196-Ball FBGA Signal Descriptions," on page 43 Table 8, "196-Ball FBGA Signal Descriptions," on page 53 Table 14, "WLAN GPIO Functions and Strapping Options," on page 68 Table 15, "BT GPIO Signals," on page 69 Table 17, "BT/FM Interface I/O Status," on page 72 Table 18, "WLAN Interface I/O Status," on page 74 Table 20, "Absolute Maximum Ratings," on page 76 |

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| Revision | Date | Description |
|----------|------|---|
| | | Section 16 "Operating Conditions and DC Characteristics" on page 76 (title changed; was DC Characteristics) |
| | | Section "Recommended Operating Conditions" on page 77 (heading changed; was DC Characteristics) |
| | | Table 21, "ESD Specifications," on page 76 |
| | | Table 22, "Environmental Ratings," on page 77 |
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| | | Table 26, "Bluetooth Receiver RF Specifications," on page 80 |
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| | | Table 31, "2.4 GHz Band Local Oscillator Specifications," on page 87 |
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| | | Table 40, "LNLDOi," on page 94 |
| | | Table 42, "Buck-Boost Regulator," on page 96 |
| | | Figure 16, "UART Timing," on page 97 |
| | | Table , "SDIO Host Timing Requirement," on page 108 |
| | | Table, "Reset and Regulator Control Signal Sequencing," on page 108 |
| | | Table, "Signal and Power-up Sequence Timing Diagrams," on page 108 |
| | | "Package Thermal Characteristics" on page 114 |
| | | "Miscellaneous Characteristics" on page 115 |
| | | Table 57, "Ordering Information," on page 121 |
| | | Added: |
| | | Figure 32, "Power-Up Timing for WL ON and BT ON (WL REG_ON signal connected to WL_RST_N, BT separated)," on page 112 |
| | | Figure 33, "Power-Up Timing for WL OFF and BT ON (WL REG_ON signal connected to WL_RST_N, BT separated)," on page 113 |
| | | Figure 34, "Power-Up Timing for WL ON and BT OFF (WL REG_ON signal connected to WL_RST_N, BT separated)," on page 113 |



| Revision | Date | Description |
|-------------|----------|---|
| 4325-DS02-R | 08/15/08 | Updated: |
| | | • Figure 8, "Power Supply Building Blocks," on page 27. |
| | | Table 3, "Crystal Interface Signal Characteristics," on page 31. |
| | | Voltage for integrated LDO pins in Table 7 on page 44 and Table 8 on page 53. |
| | | Table 19, "Absolute Maximum Ratings," on page 75. |
| | | Table 20, "Recommended Operating Conditions and DC Characteristics," on page 75. |
| | | Table 28, "2.4-GHz Band Transmitter RF Specifications," on page 85. |
| | | Table 30, "2.4-GHz Receiver Performance Specifications," on page 86. |
| | | Table 49, "196-Ball FBGA Package Thermal Characteristics," on page 110. |
| | | Figure 28, "339-Pin WLCSP Mechanical Information," on page 113. |
| | | Table 52, "Ordering Information," on page 118.Added: |
| | | Figure 9, "Power Topology Example," on page 28. |
| | | Table 15, "Pin Default Pull-Up/Pull-Down," on page 69. |
| | | Table 16, "BT/FM Interface I/O Status," on page 71. |
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| | | Table 21, "Bluetooth and FM Current," on page 76. |
| | | "SDIO Timing" on page 102. |
| | | Section 21 "Power-Up Sequence and Liming" on page 105. |
| | | Figure 24, "Power-Up Timing for WL Off and BT Off (VDDC Provided Externally)," on page 108. |
| | | Table 51, "Miscellaneous Characteristics," on page 111. |
| | | Figure 30, "WLAN Section Second Metal Keepout Area," on page 115. |
| 4325-DS01-R | 12/14/07 | Updated: |
| | | General Description on page i |
| | | Features on page II |
| | | Figure 2, "BCM4325 Block Diagram," on page 1 |
| | | Section 2 "Bluetooth + FM Subsystem Overview" on page 2 Interpreted Ocether Original Costing 0 "Bluete the FM Ocheveters Overview" on page 2 |
| | | Integrated Section 3 into Section 2 "Bluetooth + FM Subsystem Overview" on page 2 |
| | | Section 4 "Microprocessor and Memory Unit for Bluetooth": "External Reset" on page 11 |
| | | Section 6 "FM Receiver Subsystem": DC/DDDC" on normal 19 |
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| | | Control Features on page to Section 9 "MI AN 902 11 Radio Subsystem": "Transmitter Rath" on page 25 |
| | | Section 12 "BCM4325 On-Chin Power Supplies": |
| | | Figure 8 "BCM4325 Power Supply Building Blocks" on page 28 |
| | | BCM4325 Example Power Supply Dailaing Diology" on page 29 |
| | | Removed "BCM4325 Power Supply Applications-Power Efficiency |
| | | Section 13 "Frequency References": |
| | | Table 3. "Crystal Interface Signal Characteristics." on page 32 |
| | | Figure 11, "Recommended Oscillator Configuration." on page 33 |
| | | - Figure 12, "Recommended TCXO Connection," on page 33 |

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| 4325-DS01-R | 12/14/07 | Added: |
|-------------|----------|---|
| (Cont.) | | Section 14 "Pinout and Signal Descriptions": |
| | | Table 6, "339-Pin WLCSP Signal Assignments by Pin Number and X- and Y- Coordinates," on page 38 |
| | | - Table 7, "196-Ball FBGA Signal Descriptions," on page 42 |
| | | - Table 8, "339-Pin WLCSP Signal Descriptions," on page 51 |
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| | | - Table 10, "VDDIO Domain (1.8V to 3.3V)," on page 64 |
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| | | Section 18 "BCM4325 Internal Regulator Electrical Specifications": |
| | | - Table 31, "CLDO," on page 85 |
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| | | - Table 34, "Core Buck Regulator," on page 87 |
| | | - Table 35, "Buck-Boost Regulator," on page 88 |
| | | - Added: "Regulator Current" on page 89 |
| | | - Removed Analog/RF Buck Regulator section |
| | | Section 22 "Mechanical Information": "339-Pin WLCSP Mechanical Information" on page 107 |
| | | Table 46, "Environmental Characteristics," on page 105 |
| | | Section 24 "WLCSP Keepout Area" |
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Section 1: BCM4325 Overview

OVERVIEW

The Broadcom® BCM4325 single-chip device provides the highest level of integration for a mobile or handheld wireless system, with integrated IEEE 802.11[™] a/b/g (MAC/baseband/radio), Bluetooth[®] 3.0 + HS, and an FM receiver. Designed to address the needs of highly mobile devices that require minimal power consumption and board area, the BCM4325 provides a compact ultra-small form-factor solution with minimal external components. This solution drives down the costs for mass volumes, while allowing for flexibility in size, form, and function of handheld devices. It is targeted at addressing the needs of highly mobile devices that require minimal power consumption and reliable operation.

Figure 2 shows the interconnects for the major physical blocks in the BCM4325 and associated external interfaces, which are described in greater detail in subsequent sections of this document.



Figure 2: BCM4325 Block Diagram



MOBILE PHONE USAGE MODEL

The BCM4325 incorporates a number of unique features to simplify integration into mobile phone platforms. Its flexible PCM and UART interfaces enable it to transparently connect with the existing circuits. In addition, the TCXO and LPO inputs allow the use of existing handset features to further minimize the size, power, and cost of the complete system.

- The PCM interface provides multiple modes of operation to support both master and slave as well as hybrid interfacing to single or multiple external codec devices.
- The UART interface supports hardware flow control with tight integration to power control side band signaling to support the lowest power operation.
- The TCXO interface accommodates any of the typical reference frequencies used by cell phones.
- The BSC and analog FM interfaces are available for legacy systems.
- New FM digital interfaces can use either I²S or PCM.
- The highly linear design of the radio transceiver ensures that the device has the lowest output of spurious emissions regardless of the state of operation. It has been fully characterized in the global cellular bands.
- The transceiver design has excellent blocking (eliminating desensitization of the Bluetooth receiver) and intermodulation performance (distortion of the transmitted signal caused by the mixing of the cellular and Bluetooth transmissions) in the presence of any cellular transmission (GSM, GPRS, CDMA, WCDMA, or iDEN). Minimal external filtering is required for integration inside the handset.

The BCM4325 is designed to provide direct interface with new and existing handset designs, as shown in Figure 3.







Section 2: On-Chip Power Supplies and Reset

The BCM4325 contains power supply building blocks, including one buck-boost switching regulator, one buck switching regulator, and five low-noise LDOs to simplify power supply design for Bluetooth and WLAN interfaces in embedded designs. From a single host power supply, power configurations can be implemented using the BCM4325 on-chip power elements to create a self contained design. All of the regulators are available with the 339-pin WLCSP package. The 196-ball FBGA package does not provide access to LNLDO4.

Figure 4 shows available voltage and current from each integrated regulator.



Figure 4: Power Supply Building Blocks

POWER SUPPLY TOPOLOGY

At least seven different power supply topologies can be supported by the voltage regulators available on the BCM4325. Figure 5 shows one example of a power topology for an application with Bluetooth Class 1 PA, FM and WLAN supplied by a variable battery voltage (Vbatt).

To achieve maximum performance from the integrated WLAN Power Amplifiers (PAs), the VDDPA power supply voltages must remain within the recommended operating voltage range. If the supply voltage to the PA deviates outside this range, the linearity of the PA will be degraded, resulting in lower throughput and shorter range. To avoid this condition, the buckboost regulator can be used to provide a constant 3.3V supply to the PA over the full range of the Vbatt voltage variation. The trade-off is the additional components required for the buck-boost regulator versus the impaired performance if it is not used.

Complete details of all seven power supply topologies are provided in the *BCM4325 Power Supply Topologies* application note (document number 4325-AN60X-R), available on docSAFE.



Figure 5: Power Topology Example

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RESET CIRCUITS

The BCM4325 has four signals (see Table 1) that enable or disable the Bluetooth and WLAN circuits, and the internal regulator blocks, allowing the host to control power consumption.

| Signal | Description |
|-----------|---|
| WL_REG_ON | This signal is used by the PMU (with BT_REG_ON) to decide whether or not to power down the internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. If WL_RST_N is low (regardless of the BT_RST_N state), the WLAN core is powered off. |
| BT_REG_ON | This signal is used by the PMU (with WL_REG_ON) to decide whether or not to power down the internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. |
| WL_RST_N | Low asserting reset for the WLAN core. This pin must be driven high or low (not left floating). |
| BT_RST_N | Low asserting reset for the Bluetooth core. This pin must be driven high or low (not left floating). |

Table 1: Reset Control Signals



Note: WL_REG_ON and BT_REG_ON are OR gated together in the BCM4325.

For detailed timing diagrams of these signals and the required power-up sequences, see Section 22: "Power-Up Sequence and Timing" on page 107.

Section 3: Frequency References

The BCM4325 uses the following external frequency references for normal and low-power operational modes:

- An external crystal or external frequency reference driven by a temperature-compensated crystal oscillator (TCXO) signal for generating all radio frequencies and normal operation clocking.
- An external 32.768-kHz Low Power Oscillator (LPO) for low-power mode timing.

CRYSTAL INTERFACE AND CLOCK GENERATION

The BCM4325 uses a fractional-N synthesizer to generate the radio frequencies, clocks, and data/packet timing that enables it to operate using a wide range of frequency references. An external source, such as a TCXO or a crystal interfaced directly to the BCM4325, can be used. The default frequency reference setting is a 26 MHz crystal or TCXO. Table 2 list the requirements and characteristics for the crystal or frequency reference.

| Parameter | Crystal | External Freq. Reference | Units |
|--|---|---|--------|
| Frequency range | 12–52 MHz in 2 ppm steps ^d | 12–52 MHz, in 2-ppm steps ^b | _ |
| Crystal load capacitance | 12 ^e | N/A | pF |
| ESR (maximum) | 60 | - | Ω |
| Power dissipation, max | 200 | - | uW |
| Input signal AC amplitude | N/A | 400 to 1200 ^f | mVp-p |
| Signal type | N/A | Square wave or sine wave | _ |
| Input impedance | N/A | ≥ 1 | MΩ |
| | | ≤ 4.7 | pF |
| Phase noise (maximum for $f = 26 \text{ MHz}^{a}$) | | | |
| 1 kHz | _ | ≤ −100 | dBc/Hz |
| 10 kHz | _ | ≤ –115 | dBc/Hz |
| 100 kHz | _ | ≤ –120 | dBc/Hz |
| 1 MHz | - | ≤ −140 | dBc/Hz |
| Auto-detection frequencies when using LPO ^{b, c} | 12, 13, 14.4, 15.36, 16.2, 16.8, 18, 19.2, 19.44, 19.68, 19.8, 20, 24, 26, 38.4 | 12, 13, 14.4, 15.36, 16.2, 16.8, 18, 19.2, 19.44, 19.68, 19.8, 20, 24, 26, 38.4 | MHz |
| Frequency tolerance plus over temperature without trimming | ±20 | ±20 | ppm |
| Initial frequency tolerance trimming range | ±50 | ±50 | ppm |
| Time for stable system clock after power up or XTAL_PU assertion | Warm-up time < 6 ms | Maximum hold time for host < 6 ms | ms |

Table 2: Crystal Interface Signal Characteristics

a. For a clock reference other than 26 MHz, 20*log10(f/26) dB should be added to the limits, where f = the reference clock frequency in MHz.

b. Auto-detection of frequencies requires that the crystal or external frequency reference have less than 50 ppm of variation, and the external LPO frequency have less than 200 ppm of variation at the time of auto-detection.

c. 52 MHz frequency reference is also supported. The BT_TM6 signal should be pulled low for 52 MHz clock reference.

d. The frequency step size is approximately 80 Hz resolution.

e. The precise value of load capacitance to center the frequency tolerance is dependent on board layout; see Broadcom reference schematics for exact values.

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f. If the input signal amplitude is below 800 mV p-p, contact your Broadcom representative for applications assistance. DC coupled digital clock with swing less than 1.32V is supported.

CRYSTAL OSCILLATOR

The BCM4325 can use an external crystal to provide a frequency reference. The recommended configuration for the crystal oscillator including all external components is shown in Figure 6.





EXTERNAL FREQUENCY REFERENCE

As an alternative to a crystal, an external frequency reference, such as a TCXO signal, can be connected to the OSCIN pin on the BCM4325 via a D.C. blocking capacitor, as shown in Figure 7. The external frequency reference input is designed to not change the loading on the TCXO when the BCM4325 is powered up or powered down.



Figure 7: Recommended TCXO Connection

FREQUENCY SELECTION

Any frequency within the ranges specified for the crystal and TCXO reference may be used. These include not only the standard handset references frequencies of 12, 13, 14.4, 16.2, 16.8, 18, 19.2, 19.44, 19.68, 19.8, 20, 24, 26, 38.4, and 52 MHz, but any other frequency between these as desired by the system designer. The BCM4325 must have the reference frequency set correctly in order for any of the UART or PCM interfaces to function correctly, since all bit timing is derived from the reference frequency.

The reference frequency for the BCM4325 may be set in one of the following ways:

- Specify the frequency in the nvram.txt file.
- Auto-detect the standard handset reference frequencies using an external LPO clock.

The BCM4325 is set at the factory to a default frequency of 26 MHz. For a typical design using a crystal it is recommended that the default frequency be used.

For applications such as handsets and portable smart communication devices, where the reference frequency is one of the standard frequencies commonly used, the BCM4325 automatically detects the reference frequency and programs itself to the correct reference frequency. In order for auto-frequency detection to work correctly, the BCM4325 must have a valid and stable 32.768-kHz LPO clock present during power-on reset.

FREQUENCY TRIMMING

The BCM4325 uses a fractional-N synthesizer to digitally fine tune the frequency reference input to within ±2 ppm tuning accuracy. This trimming function can be applied to either the crystal or an external frequency source such as a TCXO. Unlike the typical crystal trimming methods used, the BCM4325 changes the frequency using a fully digital implementation and is much more stable and unaffected by either the crystal characteristics or the temperature. The input impedance and loading characteristics remain unchanged on either the TCXO or the crystal during the trimming process and are unaffected by process and temperature variations.

The option of whether to use frequency trimming would be determined by a cost trade-off between the cost of the crystal and the added manufacturing cost associated with frequency trimming. Frequency trimming value can be stored in the host and written back to the BCM4325.



LPO Clock Interface

An additional frequency reference is the LPO clock that the BCM4325 uses to provide low-power mode timing for park, hold, and sniff. The LPO clock should be provided externally to the device from a stable and accurate 32.768-kHz source.

Table 3: LPO Signal Requirements

| Parameter | LPO Clock | Units |
|------------------------------|--------------------------|---------------------------------------|
| Nominal input frequency | 32.768 | kHz |
| Frequency accuracy | ±200 ^a | ppm |
| Duty cycle | 30% to 70% | - |
| Jitter (when FM is used) | less than 1 | Hz (integrated from 300 Hz to 15 kHz) |
| Input signal amplitude | 200 to 1800 | mV, p-p |
| Signal type | Square wave or sine wave | - |
| Input impedance ^b | >100k | Ω |
| | < 5 | рF |

a. ±150 if FM is used. See Broadcom Bluetooth® SoC Crystal, TCXO, RFIC, and LPO User Guide (43XX_20XX-1xx-R) for

details.

b. When power is applied, or switched off.

Section 4: Bluetooth + FM Subsystem Overview

The Broadcom BCM4325 includes a Bluetooth[®] 3.0 + HS compliant standalone baseband processor with an integrated 2.4 GHz transceiver, integrated FM and RDS/RBDS receiver, and an integrated FM baseband processor. It features the highest level of integration and eliminates all critical external components, thus minimizing the footprint and system cost of implementing a Bluetooth and FM solution. The BCM4325 is firmware upgradable for future specifications.

The BCM4325 is the optimal solution for any voice or data application that requires the Bluetooth SIG standard Host Controller Interface (HCI) using a high-speed UART and PCM. The BCM4325 incorporates all Bluetooth 2.1 + EDR features including eSCO, AFH, Fast Connect, all EDR packet types and lengths, and all errata. The BCM4325 also includes InConcert and other industry-collaborative coexistence solutions.



Note: The BCM4325 is designed to be firmware upgradable to any foreseeable future enhancements to the Bluetooth specification by the Bluetooth SIG.

The Bluetooth radio transceiver provides enhanced radio performance to meet the most stringent industrial temperature applications and the tightest integration into mobile handsets and portable devices. It is fully compatible with all standard TCXO frequencies and provides full radio compatibility to operate simultaneously with GPS and cellular radios.

The BCM4325 also integrates a complete FM and RDS/RBDS solution. The integrated solution saves power and board space, minimizes the BOM, and maximizes interface flexibility over a separate Bluetooth and FM solution. The FM subsystem can operate independently of Bluetooth and achieve full performance while Bluetooth is operating. It is designed to cover from 76 MHz, up to 108 MHz, bands (US, Europe, Japan) and to operate from a 32 kHz LPO input. The FM subsystem supports an I²C-compliant Broadcom Serial Control (BSC) interface and analog outputs for legacy systems, as well as digital interface options, such as I²S and PCM. The I²S and PCM interfaces support 48 kHz operation and can be configured as either master or slave. The analog interface consists of high-quality, line-level stereo DACs.

The BCM4325 FM subsystem includes advanced RDS/RBDS capability. The BCM4325 synchronizes, demodulates, and decodes RDS/RBDS signals including CRC processing, post data filter detection, signal quality estimation, and buffering thus making it easy for an external application to read and process the RDS/RBDS data.

The FM radio provides excellent reception, with 1 μ V for 26 dB (S+N)/N typical sensitivity and greater than 60 dB SNDR capability, allowing easier system integration and antenna design. The FM subsystem includes many sought after features, including signal-dependant mono/stereo blend, soft mute, and signal bandwidth control. The system has digital RSSI, signal quality, and IF frequency error indicators for system monitoring. The FM subsystem contains embedded automatic search and scan features, and large RDS data buffers to simplify the interface with an external host.



FEATURES

BLUETOOTH FEATURES

Major Bluetooth features of the BCM4325 include:

- Supports key features of upcoming Bluetooth standards
- Class 1 support with PA bias adjust
- Support for BT v3.0 + HS features combined with Broadcom's v3.0 + HS qualified host software, including alternate MAC/PHY, read encryption key size, enhanced power control, and unicast connectionless data.
- Fully supports Bluetooth Core Specification version 2.1 + EDR features:
 - Adaptive Frequency Hopping (AFH)
 - Quality of Service (QoS)
 - Extended Synchronous Connections (eSCO)—Voice Connections
 - Fast Connect
 - Secure Simple Pairing (SSP)
 - Sniff Subrating (SSR)
 - Encryption Pause Resume (EPR)
 - Extended Inquiry Response (EIR)
 - Link Supervision Timeout (LST)
- Maximum UART baud rates up to four Mbps
- Supports Bluetooth Enhanced Data Rate (EDR)
- Supports maximum Bluetooth data rates over HCI UART
- · Multipoint operation with up to seven active slaves
 - Maximum of seven simultaneous active ACL links
 - Maximum of three simultaneous active SCO and eSCO with scatternet support
- Scatternet operation with up to four active piconets with background scan and support for scatter mode
- High-speed HCI UART transport support with low-power out-of-band BT_WAKE and HOST_WAKE signaling (see "Host Controller Power Management" on page 16)
- Channel quality driven data rate and packet type selection
- Standard Bluetooth test modes
- Extended radio and production test mode features
- Full support for power savings modes
 - Bluetooth clock request
 - Bluetooth standard park, hold, and sniff
 - Deep sleep modes and software regulator shutdown
- TCXO input and auto-detection of all standard handset clock frequencies. Also supports a low-power oscillator (LDO), which can be used during power save mode for better timing accuracy

FM RADIO FEATURES

Major FM Radio features include:

- 76 MHz to 108 MHz FM bands supported (US, Europe, and Japan)
- Excellent FM radio performance with 1 μ V sensitivity for 26 dB (S+N)/N
- FM subsystem control using the BSC bus or through the Bluetooth HCl interface
- Signal dependent stereo/mono blending
- Signal dependent soft mute
- Auto search and tuning modes
- Audio silence detection
- RSSI, IF frequency, status indicators
- RDS and RBDS demodulator and decoder with filter and buffering functions
- Automatic frequency jump
- · FM subsystem operates from 32 kHz low-power oscillator (LPO) or reference clock inputs
- Improved audio interface capabilities with full-featured PCM, I²S, and analog stereo DAC
- I²S can be master or slave

BLUETOOTH RADIO

The BCM4325 includes an integrated radio transceiver, optimized for use in 2.4 GHz Bluetooth wireless systems. Its design provides low-power, low-cost, robust communications for applications operating in the globally available, 2.4 GHz, unlicensed ISM band. The radio transceiver is fully compliant with Bluetooth radio and EDR specifications and meets or exceeds the requirements to provide the highest communication link quality of service.



Note: Sharing a single 2.4 GHz antenna between the Bluetooth and WLAN sections is supported when an appropriate SP3T switch is used in the external RF signal path.

TRANSMIT

The BCM4325 features a fully integrated zero-IF transmitter. The baseband transmit data is digitally GFSK-modulated in the modem block and upconverted to the 2.4 GHz ISM band in the transmitter path. The transmitter path consists of signal filtering, I/Q upconversion, output power amplifier (PA), and RF filtering. The transmitter path also incorporates new modulation schemes π /4-DQPSK for 2 Mbps and 8-DPSK for 3 Mbps to support EDR.

Digital Modulator

The digital modulator performs the data modulation and filtering required for the GFSK, Π /4DQPSK, and 8-DPSK signal. The fully digital modulator minimizes any frequency drift or anomalies in the modulation characteristics of the transmitted signal and is much more stable than direct VCO modulation schemes.

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Power Amplifier

The fully integrated PA provides a maximum output signal level (see Table 27: "Bluetooth Transmitter RF Specifications," on page 81) using a highly linearized, temperature compensated design. This provides greater flexibility in front-end matching and filtering. Due to the linear nature of the PA combined with some integrated filtering, no external filters are required for meeting Bluetooth and regulatory harmonic and spurious requirements. For integrated mobile handset applications where the Bluetooth is integrated next to the cellular radio minimal external filtering can be applied to achieve near thermal noise levels for spurious and radiated noise emissions.

The integrated power amplifier is Bluetooth Class 2 compliant and includes power control adjustment with a 28 dB range and 4 dB nominal step size. The integrated power amplifier can be configured as a PA driver to an external power amplifier for full Bluetooth Class 1 compliance.

RECEIVE

The receiver path uses a low-IF scheme to down convert the received signal for demodulation in the digital demodulator and bit synchronizer. The receiver path provides a high degree of linearity, an extended dynamic range, and high-order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band. The front end topology with built-in out-of-band attenuation enables the BCM4325 to be used in most applications with no off-chip filtering. For integrated handset operation where the Bluetooth function is integrated close to the cellular transmitter, minimal external filtering is required to eliminate the desensitization of the receiver by the cellular transmit signal.

Digital Demodulator and Bit Synchronizer

The digital demodulator and bit synchronizer takes the low-IF received signal and performs an optimal frequency tracking and bit synchronization algorithm.

Receiver Signal Strength Indicator

The radio portion of the BCM4325 provides an Receiver Signal Strength Indicator (RSSI) signal to the baseband so that the controller can take part in a Bluetooth power-controlled link by providing a metric of its own receiver signal strength to determine whether the transmitter should increase or decrease its output power.

LOCAL OSCILLATOR GENERATION

Local Oscillator generation provides fast frequency hopping (1600 hops/second) across the 79 maximum available channels. The local oscillator generation subblock employs an architecture for high immunity to local oscillation pulling during PA operation. The BCM4325 uses an internal RF and IF loop filter.

CALIBRATION

The BCM4325 radio transceiver features an automated calibration scheme that is fully self contained in the radio. No user interaction is required during normal operation or during manufacturing to provide the optimal performance. Calibration optimizes the performance of all the major blocks within the radio to within 2% of optimal conditions, including gain and phase characteristics of filters, matching between key components, and key gain blocks. This takes into account process variation and temperature variation. Calibration occurs transparently during normal operation during the settling time of the hops and calibrates for temperature variations as the device cools and heats during normal operation in its environment.

Section 5: Bluetooth Baseband Core

The Bluetooth Baseband Core (BBC) implements all of the time critical functions required for high performance Bluetooth operation. The BBC manages the buffering, segmentation, and routing of data for all connections. It also buffers data that passes through it, handles data flow control, schedules SCO/ACL TX/RX transactions, monitors Bluetooth slot usage, optimally segments and packages data into baseband packets, manages connection status indicators, and composes and decodes HCI packets. In addition to these functions, it independently handles HCI event types, and HCI command types.

The following transmit and receive functions are also implemented in the BBC hardware to increase reliability and security of the TX/RX data before sending over the air:

- Symbol timing recovery, data deframing, forward error correction (FEC), header error control (HEC), cyclic redundancy check (CRC), data decryption, and data dewhitening in the receiver.
- Data framing, FEC generation, HEC generation, CRC generation, key generation, data encryption, and data whitening in the transmitter.

BLUETOOTH 2.1 AND 3.0 FEATURES

The BBC supports the following Bluetooth 2.1 features:

- Extended Inquiry Response (EIR) Shortens the time to retrieve device name, specific profile and mode.
 - Encryption Pause Resume (EPR) Enables the use of Bluetooth technology in a much more secure environment.
- Sniff Subrating (SSR)
 Optimizes power consumption for low duty cycle asymmetrical data flow, which subsequently extends battery life.
- Simple Pairing (SP)
 Reduces the number of steps with minimal or no user interaction when connecting two devices.
- Link Supervision Timeout (LST)

In addition, the BBC is compliant with the Bluetooth Core specification 3.0 + HS when combined with Bluetooth 3.0 + HS qualified host software—including Alternate MAC/PHY, read encryption key size, enhanced power control, and unicast connectionless data.

FREQUENCY HOPPING GENERATOR

The frequency hopping sequence generator selects the correct hopping channel number depending on the link controller state, Bluetooth clock, and the device address.

LINK CONTROL LAYER

The link control layer is part of the Bluetooth link control functions that are implemented in dedicated logic in the Link Control Unit (LCU). This layer consists of the command controller that takes commands from the software and other controllers that are either activated or configured by the command controller to perform the link control tasks.

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Each task performs a different state function in the Bluetooth link controller.

- Major states
 - Standby
 - Connection
 - Substates
 - Page
 - Page Scan
 - Inquiry
 - Inquiry Scan
 - Park
 - Sniff
 - Hold

TEST MODE SUPPORT

The BCM4325 fully supports Bluetooth Test mode as described in Part 1 of the *Specification of the Bluetooth System Version 2.1.* This includes the transmitter tests, normal and delayed loopback tests, and reduced hopping sequence.

In addition to the standard Bluetooth Test Mode, the BCM4325 also supports enhanced testing features to simplify RF debugging and qualification and type approval testing. These features include:

- Fixed frequency carrier wave (unmodulated) transmission
 - Simplifies some type approval measurements (Japan)
 - Aids in transmitter performance analysis
 - Fixed frequency constant receiver mode
 - Receiver output directed to I/O pin
 - Allows for direct BER measurements using standard RF test equipment
 - Facilitates spurious emissions testing for receive mode
- Fixed frequency constant transmission
 - 8-bit fixed pattern or PRBS-9
 - Enables modulated signal measurements with standard RF test equipment

BLUETOOTH POWER MANAGEMENT UNIT

The Bluetooth Power Management Unit (PMU) provides power management features that can be invoked by either software through power management registers, or packet handling in the baseband core.

The power management functions provided by the BCM4325 are:

- RF Power Management
- Host Controller Power Management
- BBC Power Management
- FM Power Management

RF POWER MANAGEMENT

The BBC generates power-down control signals for the transmit path, receive path, PLL, and power amplifier to the 2.4 GHz transceiver. The transceiver then processes the power-down functions accordingly.

HOST CONTROLLER POWER MANAGEMENT

When running in UART mode, the BCM4325 may be configured so that dedicated signals are used for power management hand shaking between the BCM4325 and the host. The basic power saving functions supported by those handshaking signals include the standard Bluetooth defined power savings modes and standby modes of operation.

An alternative to using the BT_WAKE and HOST_WAKE signalling uses the CTS and RTS as a combination of UART handshake signals during normal operation and as BT_WAKE and HOST_WAKE when the device is in a power saving mode.

Table 4 describes the power control handshake signals used with the UART interface.

| Signal | Mapped to Pin | Туре | Description |
|-----------|------------------|------|---|
| BT_WAKE | BT_GPIO_0 | Ι | Bluetooth device wakeup. Signal from the host to the BCM4325 indicating that the host requires attention. |
| | | | Asserted: Bluetooth device must wakeup or remain awake. |
| | | | Deasserted: Bluetooth device may sleep when sleep criteria are met. |
| | | | The polarity of this signal is software configurable and can be asserted high or low. |
| HOST_WAKE | BT_GPIO_1 | 0 | Host wake up. Signal from the BCM4325 to the host indicating that the BCM4325 requires attention. |
| | | | Asserted: Host device must wakeup or remain awake. |
| | | | Deasserted: Host device may sleep when sleep criteria are met. |
| | | | The polarity of this signal is software configurable and can be asserted high or low. |

Table 4: Power Control Pin Description



Note: Successful operation of the power management handshaking signals requires coordination between the BCM4325 firmware and the host software.

BBC POWER MANAGEMENT

The following are low power operations for the BBC:

- Physical layer packet handling turns RF on and off dynamically within packet TX and RX.
- Bluetooth-specified low-power connection modes are sniff, hold, and park. While in these modes, the BCM4325 runs on the low-power oscillator and wakes up after a predefined time period.

FM POWER MANAGEMENT

The BCM4325 FM subsystem can operate independently of, or in tandem with, the Bluetooth RF and BBC subsystems. The FM subsystem power management scheme operates in conjunction with the Bluetooth RF and BBC subsystems.

ADAPTIVE FREQUENCY HOPPING

The BCM4325 gathers link quality statistics on a channel by channel basis to facilitate channel assessment and channel map selection. The link quality is determined using both RF and baseband signal processing to provide a more accurate frequency-hop map.

ADVANCED BLUETOOTH/WLAN COEXISTENCE

The BCM4325 includes advanced coexistence technologies that are only possible with a Bluetooth/WLAN integrated die solution. These coexistence technologies are targeted at small form factor platforms such as cell phones and media players, including applications such as VoWLAN + SCO and Video-over-WLAN + High-Fidelity BT stereo. Support is provided for platforms that share a single antenna between Bluetooth and 802.11g. Dual antenna applications are also supported. The BCM4325 radio architecture allows for lossless simultaneous Bluetooth and WLAN reception for shared antenna applications. This is possible only via an integrated solution (shared LNA and joint AGC algorithm). It has superior performance versus implementations that need to arbitrate between Bluetooth and WLAN reception.

The BCM4325 integrated solution enables MAC-layer signaling (firmware) and a greater degree of sharing via an enhanced coexistence interface. The Packet Traffic Scheduler (PTS) can suitably schedule future packet transmissions (versus merely supporting arbitration on a packet-by-packet basis as employed in discrete Bluetooth/WLAN solutions) and can factor in beacon arrival times, duration of upcoming packet transmissions, etc. Information is exchanged between the Bluetooth and WLAN cores without host processor involvement.

The BCM4325 also supports Transmit Power Control (TPC) on the STA together with standard Bluetooth TPC to limit mutual interference and receiver desensitization. Preemption mechanisms are utilized to prevent AP transmissions from colliding with Bluetooth frames. Improved channel classification techniques have been implemented in Bluetooth for faster and more accurate detection and elimination of interferers (including non-WLAN 2.4 GHz interference).

FAST CONNECTION (INTERLACED PAGE AND INQUIRY SCANS)

The BCM4325 supports page scan and inquiry scan modes that significantly reduce the average inquiry response and connection times. These scanning modes are compatible with the Bluetooth version 2.1 page and inquiry procedures.



Section 6: Microprocessor and Memory Unit for Bluetooth

The Bluetooth microprocessor core is based on ARM7TDMIS[®] 32 bit RISC processor with embedded ICE-RT debug and JTAG interface units. It runs software from the link control layer, up to the Host Controller Interface (HCI).

The ARM core is paired with a memory unit that contains 256 KB of ROM memory for program storage and boot ROM, 48 KB of RAM for data scratchpad and patch RAM code. The internal boot ROM allows for flexibility during power-on reset to enable the same device to be used in various configurations. At power-up, the lower layer protocol stack is executed from the internal ROM memory.

External patches may be applied to the ROM-based firmware to provide flexibility for bug fixes or features additions. These patches may be downloaded from the host to the BCM4325 through the UART transports. The mechanism for downloading via UART is identical to the proven interface of the BCM2045 device.

RAM, ROM, AND PATCH MEMORY

The BCM4325 Bluetooth core has 48 KB of internal RAM which is mapped between general purpose scratch pad memory and patch memory and 256 KB of ROM used for the lower layer protocol stack, test mode software, and boot ROM. The patch memory capability enables the addition of code changes for purposes of feature additions and bug fixes to the ROM memory.



Section 7: Bluetooth Peripheral Transport Unit

PCM INTERFACE FOR BLUETOOTH AND SCO AUDIO

The PCM Interface on the BCM4325 can connect to linear PCM Codec devices in master or slave mode. In master mode, the BCM4325 generates the BT_PCM_CLK and BT_PCM_SYNC signals, and in slave mode, these signals are provided by another master on the PCM interface and are inputs to the BCM4325.

The BCM4325 supports up to three SCO or eSCO channels through the PCM Interface and each channel can be independently mapped to any of the available slots in a frame.

The configuration of the PCM interface may be adjusted by the host through the use of Vendor Specific HCI Commands.

Figure 8 shows three options for connecting a BCM4325 to a PCM codec device as either a master or slave connection.



Figure 8: PCM Interface with Linear PCM Codec
SLOT MAPPING

The BCM4325 supports up to three simultaneous full-duplex SCO or eSCO channels. These three channels are time multiplexed onto the single PCM interface by using a time slotting scheme where the 8-kHz audio sample interval is divided into up to 16 slots. The number of slots is dependant on the selected interface rate of 128 kHz, 256 kHz, 512 kHz, 1024 kHz, or 2048 kHz. The corresponding number of slots for these interface rates is one, two, four, eight and 16, respectively. Transmit and receive PCM data from an SCO channel is always mapped to the same slot. The PCM data output driver tristates its output on unused slots to allow other devices to share the same PCM interface signals. The data output driver tristates its output after the falling edge of the PCM clock during the last bit of the slot.

FRAME SYNC

The BCM4325 supports both short and long frame sync types in both master and slave configurations. In the short frame sync mode, the frame sync signal is an active-high pulse at the 8 kHz audio frame rate that is a single-bit period in width and synchronized to the rising edge of the bit clock. The PCM slave looks for a high on the falling edge of the bit clock and expects the first bit of the first slot to start at the next rising edge of the clock. In the long frame sync mode, the frame sync signal is again an active-high pulse at the 8 kHz audio frame rate; however, the duration is three bit periods and the pulse starts coincident with the first bit of the first slot.

DATA FORMATTING

The BCM4325 may be configured to generate and accept several different data formats. The BCM4325 uses 13 of the 16 bits in each PCM frame. The location and order of these 13 bits is configurable to support various data formats on the PCM interface. The remaining three bits are ignored on the input, and may be filled with 0s, 1s, sign bit, or a programmed value on the output. The default format is 13-bit, 2's complement data, left-justified, and clocked MSB first.

PCM INTERFACE FOR FM AUDIO

The BCM4325 also supports a mode where the FM stereo audio is output over the PCM Interface in master or slave mode. A BT_PCM_SYNC sample rate of 48 kHz is supported with associated BT_PCM_CLK rate of 1.536 MHz. The BT_PCM_SYNC signal follows the short frame sync format. In this FM audio mode, the BT_PCM_IN signal is ignored and FM audio is output on the BT_PCM_OUT signal. The FM stereo audio is presented MSB first onto the BT_PCM_OUT signal with the 16 bits of left-channel data first followed by the 16 bits of right-channel data.

BLUETOOTH UART INTERFACE

The Bluetooth UART physical interface is a standard, 4-wire interface (RX, TX, RTS, CTS) with adjustable baud rates from 9600 bps to 4.0 Mbps. The interface features an automatic baud rate detection capability that returns a baud rate selection. Alternatively, the baud rate may be selected via a vendor specific UART HCI command. The BCM4325 has a 480-byte receive FIFO and a 480-byte transmit FIFO to support EDR. The interface supports the Bluetooth 3.0 UART HCI specification.

The BCM4325 has the added capability to perform wake-on-activity, where it can be asleep and have activity on the RX or CTS inputs to wake up the chip.

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In order to support both high and low baud rates efficiently, the UART clock can be selected as either 24 or 48 MHz. Generally, the higher speed clock is needed for baud rates over 3 Mbaud, however a lower speed clock may be used to achieve a more accurate baud rate under 3 Mbaud. The baud rate of the BCM4325 UART is controlled by two values. The first is a UART clock divisor (also called the DLBR register) that divides the UART clock by an integer multiple of 16. The second is a baud rate adjustment (also called the DHBR register) that is used to specify a number of UART clock cycles to stuff in the first or second half of each bit time. Up to eight UART cycles can be inserted into the first half of each bit time, and up to eight UART clock cycles can be inserted into the end of each bit time.

When setting the baud rate manually, the UART clock divisor is an 8-bit value that is stored as a 256 desired divisor. For example, a desired divisor of 13 is stored as 256 - 13 = 243 = 0xF3.

The baud rate adjustment is also an 8-bit value, of which the four MSBs are the number of additional clock cycles to insert in the first half of each bit time, and the four LSBs are the number of clock cycles to insert in the second half of each bit time. If either of these two values is over eight, it is rounded to eight.

To program the baud rate for high-rate mode (greater than 1.5 Mbaud), divide UART clock by the desired rate to compute the number of UART clock cycles per bit. This number must be from eight to 15 for the high-rate mode, and is programmed into the DLBR as 256 minus the number of clocks. For three Mbaud, the calculation would be as follows:

24,000,000/3,000,000 = 8 and 256 - 8 = 248 = 0xF8.

To compute normal 2048 baud rate mode (<1.5 Mbaud), the calculation is expressed as:

24 MHz/((16xUART clock divisor) + total inserted 24 MHz clock cycles)

Table 5 contains example values to generate common baud rates.

| Desired Baud | UART Clock | Baud Rate | Adjustment | Actual Baud Rate | F (0()) |
|--------------|----------------------|-------------|------------|------------------|----------------|
| Rate (bps) | Divisor ^a | High Nibble | Low Nibble | (bps) | Error (%) |
| 4000000 | 0xF4 | 0x00 | 0x00 | 4000000 | 0.00 |
| 3692000 | 0xF3 | 0x00 | 0x00 | 3692308 | 0.01 |
| 3000000 | 0xF8 | 0x00 | 0x00 | 3000000 | 0.00 |
| 2000000 | 0xF4 | 0x00 | 0x00 | 2000000 | 0.00 |
| 1500000 | 0xFF | 0x00 | 0x00 | 1500000 | 0.00 |
| 144444 | 0xFE | 0x00 | 0x01 | 1454544 | 0.70 |
| 921600 | 0xFF | 0x05 | 0x05 | 923077 | 0.16 |
| 460800 | 0xFD | 0x02 | 0x02 | 461538 | 0.16 |
| 230400 | 0xFA | 0x04 | 0x04 | 230796 | 0.17 |
| 115200 | 0xF3 | 0x00 | 0x00 | 115385 | 0.16 |
| 57600 | 0xE6 | 0x00 | 0x00 | 57692 | 0.16 |
| 38400 | 0xD9 | 0x01 | 0x00 | 38400 | 0.00 |
| 28800 | 0xCC | 0x00 | 0x00 | 28846 | 0.16 |
| 19200 | 0xB2 | 0x01 | 0x01 | 19200 | 0.00 |
| 14400 | 0x98 | 0x00 | 0x00 | 14423 | 0.16 |
| 9600 | 0x64 | 0x02 | 0x02 | 9600 | 0.00 |

Table 5: Common Baud Rate Examples

a. The value in this column is 256 minus the desired divisor.

Normally, the UART baud rate is set by a configuration record downloaded after reset or automatic baud rate detection and the host does not need to adjust the baud rate. Support for changing the baud rate during normal HCI UART operation is provided through a vendor-specific command that allows the host to adjust the contents of the baud rate registers. The BCM4325 UART operates correctly with the host UART, if the combined baud rate error of the two devices is within ±5%.

AUTO-BAUDRATE DETECTION

The BCM4325 may be put into a state where it attempts to automatically detect the baud rate. This is done by holding the BT_UART_CTS_N signal low during reset or power up. An auto-baud character A (0x41) or the HCI_RESET command {0x01, 0x03, 0x0C, 0x00} can be sent from the host to train the BCM4325 UART when this feature is used.

The corresponding successful returns from BCM4325 auto-baud response are:

{0x41, 0x30, 0x34, 0x31} for the autobaud character

{0x04, 0x0E, 0x04, 0x01, 0x03, 0x0C, 0x00, 0x34, 0x31} for the HCI_RESET command

The run-time configuration download through the vendor specified commands is required to further configure the BCM4325 for normal operations. The BCM4325 can automatically detect baud rates up to the external crystal frequency divided by 16.

I²S INTERFACE

The 3-wire I²S interface for FM audio supports both master and slave modes. Input reference clock frequencies of 13 MHz, 19.2 MHz, 26 MHz, and 38.4 MHz are supported.

The three I²S signals are:

| I ² S Clock: | I2S_SCK |
|-------------------------------|---------|
| I ² S Word Select: | I2S_WS |
| I ² S Data Out: | I2S_SDO |

I2S_SCK and I2S_WS become outputs in Master mode and inputs in Slave mode, while I2S_SDO always stays as an output. I²S data input is not supported. The channel word length is 16 bits and the data is justified so that the MSB of the left channel data is aligned with the MSB of the I²S bus, per the I²S specification. The MSB of each data word is transmitted one bit clock cycle after the I2S_WS transition, synchronous with the falling edge of bit clock. Left channel data is transmitted when I2S_WS is low, and right channel data is transmitted when I2S_WS is high. Data bits sent by the BCM4325 are synchronized with the falling edge of I2S_SCK and should be sampled by the receiver on the rising edge of I2S_SCK.

The clock rate in master mode is either of the following:

48 kHz x 32 bits per frame = 1.536 MHz

48 kHz x 50 bits per frame = 2.400 MHz

The master clock is generated from the input reference clock using a N/M clock divider. In Slave mode, any clock rate is supported to a maximum of 3.072 MHz.

The I2S_SCK interface is available as multiplexed signals onto:

- PCM interface
- Class 1 control signals

Section 8: FM Receiver Subsystem

The BCM4325 includes a completely integrated FM radio receiver with RDS/RBDS, covering all FM bands from 76 MHz to 108 MHz. The receiver is controlled through commands on the BSC bus or the HCI. FM audio is available as stereo analog output or in digital form through I²S or PCM. The FM subsystem can operate independently or in tandem with the Bluetooth subsystem and can be powered up or down separately.

SENSITIVITY

The internal LNA has a noise figure (NF) of 6 dB, which helps achieve excellent sensitivity of -107 dBm, or 1 μ V in 50 Ω .

PLL TUNING

Clocks are locked to a reference clock or a 32.768 kHz external LPO, and no factory alignment is required.

DIGITAL FM OUTPUT

The FM radio audio is available digitally through the shared PCM and I²S pins and the sampling rate is nominally at 48 kHz. The PCM interface runs off either the FM or the Bluetooth clock. The BCM4325 supports 3-wire I²S audio interface in either master or slave configuration. The master or slave configuration is selected via HCI commands. In addition, multiple sampling rates are supported, derived from either the FM or Bluetooth clocks.

ANALOG FM OUTPUT

The demodulated FM audio signal is available as line-level analog stereo output, generated by twin internal 16-bit DACs.

BROADCOM SERIAL CONTROL (BSC) BUS

The BCM4325 implements an I²C-compatible BSC slave bus interface to control the FM subsystem. The BSC bus interface depends on the reference clock input being active. The interface supports a clock rate up to 400 kHz. The BSC slave address is programmable using the UART HCI interface and requires a configuration download. The interface supports 7-bit addressing mode and may require external pull-ups. Initial BSC communication has to be conducted at 100 kHz.

RDS/RBDS

The BCM4325 integrates a RDS/RBDS demodulator and decoder with programmable filtering and buffering functions. The RDS/RBDS data can be read out through either the HCI or BSC interfaces.

In addition, the RDS/RBDS functionality supports the following:

- Block decoding, error correction and synchronization
- Storage capability up to 126 blocks of RDS data
- Full or partial block B match detect and interrupt to host
- Audio pause detection with programmable parameters
- Program Identification (PI) code detection and interrupt to host
- Automatic frequency jump
- Block E filtering
- Soft mute
- Signal dependant mono/stereo blend
- Programmable de-emphasis

OTHER FEATURES

- Single-ended or differential FM RF input
- Auto search and tuning
- Digital-level indicator (RSSI, IF Frequency)
- Low current consumption



Section 9: Wireless LAN Functional Description

INTRODUCTION TO IEEE STD 802.11

IEEE Std 802.11 defines two different ways to configure a wireless network: ad hoc mode and infrastructure mode. In ad hoc mode, nodes are brought together to form a network on the fly, whereas infrastructure mode uses fixed access points through which mobile nodes can communicate. These network access points are sometimes connected to wired networks through bridging or routing functions.

The medium access control (MAC) layer is a contention-resolution protocol that is responsible for maintaining order in the use of a shared wireless medium. IEEE 802.11 specifies both contention-based and contention-free channel access mechanisms. The contention-based scheme is also called the distributed coordination function and the contention-free scheme is also called the point coordination function.

The distributed coordination function employs a carrier sense multiple access with collision avoidance (CSMA/CA) protocol. In this protocol, when the MAC receives a packet to be transmitted from its higher layer, the MAC first listens to ensure that no other node is transmitting. If the channel is clear, it then transmits the packet. Otherwise, it chooses a random backoff factor that determines the amount of time the node must wait until it is allowed to transmit its packet. During periods in which the channel is clear, the MAC waiting to transmit decrements its backoff counter, and when the channel is busy, it does not decrement its backoff counter. When the backoff counter reaches zero, the MAC transmits the packet. Because the probability that two nodes will choose the same backoff factor is low, collisions between packets are minimized. Collision detection, as employed in Ethernet, cannot be used for the radio frequency transmissions of devices following IEEE 802.11. The IEEE 802.11 nodes are half-duplex—when a node is transmitting, it cannot hear any other node in the system that is transmitting because its own signal drowns out any others arriving at the node.

Optionally, when a packet is to be transmitted, the transmitting node can first send out a short request to send (RTS) packet containing information on the length of the packet. If the receiving node hears the RTS, it responds with a short clear to send (CTS) packet. After this exchange, the transmitting node sends its packet. When the packet is received successfully, as determined by a cyclic redundancy check (CRC), the receiving node transmits an acknowledgment (ACK) packet. This back and forth exchange is necessary to avoid the hidden node problem. Hidden node is a situation where node A can communicate with node C, but node A cannot communicate with node C. For instance, although node A can sense that the channel is clear, node C can be transmitting to node B. This protocol alerts node A that node B is busy, and that it must wait before transmitting its packet.

IEEE 802.11A/G MAC FEATURES

The IEEE 802.11a/g MAC features include:

- Programmable independent basic service set (IBSS), or infrastructure mode
- Passive scanning
- Network allocation vector (NAV), inter-frame space (IFS), and timing synchronization function (TSF) functionality
- Backoff
- RTS/CTS procedure
- Transmission of response frames (ACK/CTS)
- · Address filtering of RX frames as specified by IBSS rules

- Multirate support
- Frame-bursting and afterburner
- Programmable target beacon transmission time (TBTT), beacon transmission/cancellation and programmable announcement traffic indication message (ATIM) window
- CF conformance: setting NAV for neighborhood point coordination function operation
- Privacy through a variety of Wired Equivalent Privacy (WEP) encryption schemes and dynamically programmable WEP keys
- Power management
- Statistics counters for MIB support

IEEE 802.11A/G MAC DESCRIPTION

The MAC core provides the support required for the transmission and reception of sequences of packets, together with related timing, without any packet-by-packet driver interaction. Time critical tasks requiring response times of only a few milliseconds are handled in the MAC core. This achieves the required timing on the medium while keeping the host driver easier to write and maintain. Also, incoming packets are buffered in the MAC core, which allows the MAC driver to process them in bursts as and when it gets access to the buffers.

The MAC driver interacts with the MAC core to prepare queues of packets to transmit and to analyze and forward received packets. The internal blocks of the MAC core are connected to a Programmable State Machine (PSM) through an internal bus. See Figure 9.



Figure 9: IEEE 802.11a/g MAC Block Diagram

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There are registers for controlling and monitoring the status of the MAC core and interfacing with the TX/RX FIFOs. There are four transmit FIFOs: asynchronous, priority, Broadcast/Multicast (BC/MC) and ATIM. Each transmit FIFO is 3 KB deep. In addition to the transmit FIFOs, there is a 1-KB template area for response frames. Whenever the CPU has a frame to transmit, the CPU queues the frame into one of the transmit FIFOs with a TX descriptor containing TX control information. The PSM schedules the transmission on the medium depending on the frame type, transmission rules in IEEE 802.11 protocol, and the current medium occupancy scenario. After the transmission is completed and an ACK is received, a TX status is returned to the host confirming the same in the TX status FIFO.

The MAC contains a single 4.5 KB RX FIFO. Whenever a frame is received, the frame is sent to the ARM processor along with an RX descriptor that contains additional information about the frame reception conditions.

The Power Management block maintains the information regarding the power management state of the core to help in dynamic decisions by the core regarding frame transmission.

The WEP block performs the required WEP operation on the TX/RX frames. The WEP block supports separate transmit and receive keys with four shared keys and 50 link-specific keys. The link-specific keys are used to establish a secure link between any two STAs, with the required key being shared between only those two STAs and hence excluding all the other STAs in the same network from deciphering the communication between those two STAs. The WEP block supports the following encryption schemes that can be selected on a per destination basis:

- None: The WEP block acts as a passthrough
- WEP: 40-bit secure key and 24-bit IV as defined in IEEE Std 802.11-1999
- WEP128: 104-bit secure key and 24-bit IV
- WEP2: 128-bit secure key and 128-bit IV
- TKIP: 802.11i
- AES: 802.11i

The transmit engine is responsible for the byte flow from the TX FIFO to the PHY interface through the WEP block and the addition of an FCS (CRC-32) as required by IEEE 802.11. Similarly, the receive engine is responsible for byte flow from the PHY interface to the RX FIFO through the WEP block and for detection of errors in the RX frame.

The timing block performs the TSF, NAV, and IFS functionality as described in IEEE 802.11-1999.

The Programmable State Machine (PSM) coordinates the operation of different hardware blocks required for both transmission and reception. The PSM also maintains the statistics counters required for MIB support.

IEEE 802.11A/G PHY FEATURES

The integrated IEEE 802.11a/g physical layer device (PHY) features include:

- Data rates of 1, 2, 5.5, 6, 9, 11, 12, 18, 24, 36, 48, and 54 Mbit/s
- Programmable antenna selection
- Automatic gain control (AGC)
- · Available per packet channel quality and signal strength measurements
- Dual antenna support with single weight combiner

BCM4325

IEEE 802.11A/G PHY DESCRIPTION

The Wireless Local Area Network (WLAN) PHY integrated in this IC provides baseband processing at data rates of 1, 2, 5.5, 6, 9, and 11, 12, 18, 24, 36, 48, and 54 Mbit/s, as specified in the direct sequence spread spectrum (DSSS) and orthogonal frequency division multiplexing (OFDM) portions of IEEE 802.11a/g. This core acts as an intermediary between the MAC on the one hand, and the integrated 2.4 GHz/5 GHz radio integrated circuit on the other, converting back and forth between packets and baseband waveforms.

An overview of the operations carried out by the PHY is shown on Figure 10. Upon transmission, physical layer framing is first added to a packet received from the MAC. The resulting bits are then scrambled, modulated, filtered, and finally sent to the radio through a pair of 80 MHz, 9-bit Digital-to-Analog Converters (DACs). Modulation is selected per packet as either differential binary phase shift keying (DBPSK), differential quadrature phase shift keying (DQPSK), complementary code keying (CCK), or OFDM. The first two types of modulation provide data rates of 1 Mbps and 2 Mbps, respectively, and require spreading the modulated symbols with a length 11 Barker code. CCK modulation is used for data rates of 5.5 Mbps and 11 Mbps and inherently includes the spreading. OFDM modulation is used for data rates of 6, 9, 12, 18, 24, 36, 48, and 54 Mbps. A high data rate is achieved by using multiple carriers that are modulated using binary or quadrature phase shift keying (BPSK or QPSK) or using 16- or 64-quadrature amplitude modulation (16 QAM or 64 QAM).



Figure 10: IEEE 802.11a/g PHY Block Diagram

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On reception, the reverse operations are performed. The inphase (I) and quadrature (Q) baseband waveforms coming from a pair of 40 MHz, 9-bit ADCs are demodulated into bits and then descrambled and deframed. To improve the likelihood of correct reception, however, the waveforms are subjected to timing and frequency offset corrections (adapted throughout packet reception) prior to demodulation.

Additionally, the receiver must perform synchronization at the start of packet reception, which includes automatic gain control (AGC), antenna selection, and frequency offset and timing estimation. A state machine coordinates all of these activities (using information from the PHY framing) to decide how to handle the packet body.

A register interface accessible from both the MAC and the host allows programming of the PHY parameters, although information generally needed per packet is passed as part of the packet itself. For example, this is true of preamble type and data rate on transmission, as well as the channel metrics signal quality (SQ) and signal strength on reception. The internal radio registers are accessed indirectly through the PHY registers.

Section 10: WLAN 802.11 Radio Subsystem

The BCM4325 includes an integrated dual-band WLAN RF transceiver that has been optimized for use in 2.4 GHz or 5 GHz Wireless LAN systems. It is designed to provide low-power, low-cost, and robust communications for applications operating in the globally available 2.4 GHz unlicensed ISM or 5 GHz U-NII bands. With an external transmit power amplifier, it develops full output power per the IEEE 802.11a/g Specification. The transmit and receive sections include all on-chip filtering, mixing, and gain control functions.



Note: Sharing a single 2.4 GHz antenna between the Bluetooth and WLAN sections is supported when an appropriate SP3T switch is used in the external RF signal path.



Figure 11: Radio Functional Block Diagram



RECEIVER PATH

The BCM4325 has a wide dynamic range, direct conversion receiver. It employs high order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band or the entire 5 GHz U-NII band. The excellent noise figure of the receiver makes an external LNA unnecessary.

TRANSMITTER PATH

A linear, on-chip power amplifier is included. This power amplifier is capable of delivering 20 dBm of nominal output power and adheres to IEEE 802.11a and 802.11g specifications. The Tx gain has a 32 dB range with a resolution of 0.25 dB. Baseband data is modulated and upconverted to the 2.4 GHz ISM or 5 GHz U-NII bands, respectively.

CALIBRATION

The BCM4325 features dynamic on-chip calibration, eliminating process variation across components. This enables the BCM4325 to be used in high volume applications, because calibration routines are not required during manufacturing testing. These calibration routines are performed periodically in the course of normal radio operation. An example of this is automatic calibration of the baseband filters for optimum transmit and receive performance.

Section 11: WLAN Power Management

The BCM4325 has been designed with the stringent power consumption requirements of mobile devices in mind. All areas of the chip design are optimized to minimize power consumption. Silicon processes and cell libraries were chosen to reduce leakage current and supply voltages. Additionally, the BCM4325 integrated RAM is a high Vt memory with dynamic clock control. The dominant supply current consumed by the RAM is leakage current only.

Additionally, the BCM4325 includes an advanced WLAN power management unit (PMU). The PMU provides significant power savings by putting the BCM4325 into various power management states appropriate to the current environment and activities that are being performed. The power management unit enables and disables internal regulators, switches, and other blocks based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them. Power up sequences are fully programmable. Configurable, free running counters (running at 32 kHz LPO clock) in the PMU are used to turn on/turn off individual regulators and power switches. Clock speeds are dynamically changed (or gated altogether) for the current mode. Slower clock speeds are used wherever possible.

The BCM4325 WLAN power states are described as follows:

- Power-down mode The BCM4325 is effectively powered off by shutting down all internal regulators. The chip is brought out of this mode by external logic reenabling the internal regulators.
- Active mode All BCM4325 WLAN functions are powered up and fully functional with active carrier sensing and frame transmission and receiving. All required regulators are enabled and put in the most efficient mode (PWM or Burst) based on the load current. Clock speeds are dynamically adjusted by the PMU.
- Sleep mode
 The WLAN radio, AFE, PLLs, and the ROMs are powered down. The rest of the BCM4325 remains powered up in an IDLE state. All main clocks are shut down. The 32 kHz LPO clock is available only for the PMU. This condition is necessary to allow the PMU to wake up the chip and transition to active mode. In Sleep mode, the primary power consumed is due to leakage current. The external switcher and internal baseband switcher are put into Burst mode (for better efficiency at low load currents).



Section 12: WLAN System Interfaces

SDIO V1.2

The BCM4325 WLAN section supports SDIO version 1.2 for both the 1-bit (25 Mbps), 4-bit (100 Mbps) modes, and high speed 4-bit (50 MHz clocks – 200 Mbps). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This out-of-band interrupt signal notifies the host when the WLAN device needs to turn on the SDIO interface.

The ability to force control of the gated clocks from within the WLAN chip is also provided.

Three SDIO functions are supported:

- Function 0—Standard SDIO function (Max BlockSize/ByteCount = 32B)
- Function 1—Backplane Function to access the internal System On Chip (SOC) address space (Max BlockSize/ ByteCount = 64B)
- Function 2—WLAN Function for efficient WLAN packet transfer through DMA (Max BlockSize/ByteCount = 512B)

Detailed SDIO pin description and signal connection block diagrams are provided in Section 14: "Pinout and Signal Descriptions" on page 37.

GPIO INTERFACE

There are five General Purpose I/O (GPIO) pins available on the FBGA package and 15 on the WLCSP package, which can be used to connect to various external devices. Upon power up and reset, these pins become tri-stated. Subsequently, they can be programmed to be either input or output pins via the GPIO control register. An internal pull-up resistor is included on each GPIO. If a GPIO output enable is not asserted, and the corresponding GPIO signal is not being driven externally, the GPIO is read as high.

ONE-TIME-PROGRAMMABLE (OTP) MEMORY

Various hardware configuration parameters may be stored in an internal 2k-bit OTP memory, which is read by system software after device reset. In addition, customer-specific parameters, including the System Vendor ID and the MAC address can be stored, depending on the specific board design.

The initial state of all bits in an unprogrammed OTP device is 0. Once any bits are programmed to a 1, they can never be reprogrammed back to 0. The entire OTP array can be programmed in a single write cycle using a utility provided with Broadcom's WLAN manufacturing test tools. Alternatively multiple write cycles can be used to selectively program specific bytes, but only bits which are still in the 0 state can be altered during each programming cycle.

Prior to OTP programming, all values should be verified using the appropriate editable nvram.txt file, which is provided with the reference board design package. Documentation on the OTP development process is available at Broadcom's Customer Support Portal (CSP) at http://www.broadcom.com/support.

As an alternative to using the internal OTP, an external 4-wire SPROM interface can be enabled.



EXTERNAL COEXISTENCE INTERFACE

An external handshake interface is provided to enable signaling between the device and an external co-located wireless device, such as GPS, WiMax or UWB, to manage wireless medium sharing for optimum performance. The provided signals are:

- ERCX_STATUS
- ERCX_RF_ACTIVE
- ERCX_TX_FREQ
- ERCX_TX_PRISEL (WLCSP package only)
- ERCX_TXCONF (WLCSP package only)

JTAG INTERFACE

The BCM4325 supports the IEEE 1149.1 JTAG boundary scan standard for performing device package and PCB assembly testing during manufacturing. In addition, the JTAG interface allows Broadcom to assist customers by using proprietary debug and characterization test tools during board bringup. Therefore, it is highly recommended to provide access to the JTAG pins by means of test points or a header on all PCB designs.

WLAN UART DEBUG INTERFACE

Two universal asynchronous receiver/transmitter (UART) interfaces are provided for the 339-pin WLCSP package (one UART interface for the 196-ball FBGA package) that can be attached to RS-232 data termination equipment (DTE) for exchanging and managing data with other serial devices. These UART interfaces are primarily used for debugging during development. Each interface is compatible with the industry standard 16550 UART. One UART provides TX and RX signals only. The other UART provides a full set of control signals. Hardware assisted flow control is provided. FIFO size is 64 × 8.



Section 13:Software Architecture

HOST SOFTWARE ARCHITECTURE

The host driver provides a transparent connection between the host operating system and the BCM4325 media (for example, WLAN) by presenting a network driver interface to the host operating system and communicating with the BCM4325 over an interface-specific bus (SPI, SDIO, and so on) to:

- Forward transmit and receive frames between the host network stack and the BCM4325 device, and
- Pass control requests from the host to the BCM4325 device, returning the BCM4325 device responses

The driver communicates with the BCM4325 over the bus using a control channel and a data channel to pass control messages and data messages. The actual message format is based on the BDC protocol.

DEVICE SOFTWARE ARCHITECTURE

The wireless device, protocol, and bus drivers are run on the embedded ARM[®] processor and a Broadcom-defined operating system called HNDRTE that enables the transfer of 1500-byte Ethernet frames and control frames (using BDC message sets) over the SDIO interface between the host and the device.

This transfer requires a message-oriented (framed) interconnect between the host and device. The SDIO bus is an addressed bus—each host-initiated bus operation contains an explicit device target address—and does not natively support a higher level data frame concept. Broadcom has implemented a hardware/software message encapsulation scheme that ignores the bus operation code address and prefixes each frame with a 4-byte length tag for framing. The device presents a packet level interface over which data, control and asynchronous event (from the device) packets are supported.

The data and control packets received from the bus are initially processed by the bus driver and then passed on to the protocol driver. If the packets are data packets, they are transferred to the wireless device driver (and out through its medium), and a data packet received from the device medium follows the same path in the reverse direction. If the packets are control packets, the protocol header is decoded by the protocol driver. If the packets are wireless IOCTL packets, the IOCTL API of the wireless driver is called to configure the wireless device. The microcode running in the D11 core processes all time critical tasks.

REMOTE DOWNLOADER

The remote downloader is used to download the BCM4325 firmware image into the device from the host. When the BCM4325 device powers up, it is ready to receive the firmware image from the host system.





WIRELESS CONFIGURATION UTILITY

The device driver that supports the Broadcom IEEE 802.11 family of wireless solutions provides an input/output control (IOCTL) interface for making advanced configuration settings. The IOCTL interface makes it possible to make settings that are normally not possible when using just the native operating system-specific IEEE 802.11 configuration mechanisms. The utility uses IOCTLs to query or set a number of different driver/chip operating properties.



Section 14: Pinout and Signal Descriptions

SIGNAL ASSIGNMENTS

196-BALL FBGA PINOUT

Table 6: 196-Ball FBGA Signal Assignments by Ball Number

| Ball | Signal | Ball | Signal | Ball | Signal | Ball | Signal |
|----------|---------------------|------|--------------------|------|-------------------|------|------------------|
| A1 | SR VFB1 | C9 | WRF_AFE_TEST_ONI | F3 | ERCX_STATUS | H11 | WRF_GPIO_OUT2 |
| A2 | SR VBAT1B | C10 | WRF_AFE_TSSI_A | F4 | VDDIO | H12 | WRF_VDDVCO_1P2 |
| A3 | SR VLX1 | C11 | AVSS | F5 | ТСК | H13 | WRF_VDDPFDCP_1P2 |
| A4 | WL RST N | C12 | AVSS | F6 | AMODE_RX_PU | H14 | AVSS |
| A5 | RF SW CTRL N 3 | C13 | AVSS | F7 | GMODE_RX_PU | J1 | VDDIO_SD |
| A6 | AMODE TX PU | C14 | AVSS | F8 | VSS | J2 | WL_GPIO_2 |
| A7 | RF SW CTRL N 0 | D1 | SR_VFBBB | F9 | VDDIO_RF | J3 | SDIO_DATA_2 |
| A8 | WRF DISABLE N | D2 | WL_REG_ON | F10 | VDDIO_RF | J4 | WL_UART_TX0 |
| A9 | WRF_EXTCOUPLE_AIN | D3 | SR_AVSS | F11 | WRF_AFE_TEST_QN | J5 | WL_GPIO_7 |
| A10 | WRF_EXTCOUPLE_GIN | D4 | TMS | F12 | AVSS | J6 | SPROM_CS |
| A11 | WRF_VDDPAG_3P3 | D5 | LV_TESTMODE | F13 | WRF_PA_100UA | J7 | BT_PCM_CLK |
| A12 | WRF_RFOUTP_G | D6 | GMODE_EXT_LNA_GAIN | F14 | WRF_RFINP_G1 | J8 | BT_TM6 |
| A13 | AVSS | D7 | WRF_AFE_AVDD_TXDAC | G1 | SR_VOUTBB | J9 | BT_GPIO_0 |
| A14 | WRF_RFOUTP_A | D8 | WRF_AFE_TEST_ONQ | G2 | WL_GPIO_6 | J10 | BT_VSSC_0 |
| B1 | SR AVDD2P5 | D9 | WRF_AFE_TEST_OPQ | G3 | WL_GPIO_1 | J11 | BT_VDDC |
| B2 | SR_PLDO | D10 | WRF_AFE_AVDD_AUX | G4 | ERCX_RF_ACTIVE | J12 | WRF_VDDD_1P2 |
| B3 | SR_VBAT1A | D11 | WRF_AFE_TEST_IP | G5 | WL_GPIO_0 | J13 | WRF_VDDCAB_1P2 |
| B4 | JTAG_TRST_N | D12 | WRF_VDDTX_1P2 | G6 | VDDIO | J14 | BT_RFION |
| B5 | RF_SW_CTRL_P_3 | D13 | AVSS | G7 | VSS | K1 | SDIO_CLK |
| B6 | RF_SW_CTRL_N_1 | D14 | WRF_RFINP_A1 | G8 | BT_VDDO | K2 | XTAL_PU |
| B7 | RF_SW_CTRL_P_0 | E1 | SR_VLX1BB | G9 | VDDC | К3 | SPROM_CLK |
| B8 | GMODE_TX_PU | E2 | SR_VBATBB | G10 | AVSS | K4 | SDIO_CMD |
| B9 | WRF_AFE_AVDD_RXAD | E3 | BT_REG_ON | G11 | WRF_GPIO_OUT1 | K5 | BT_PCM_IN |
| | | E4 | VSS | G12 | WRF_VDDLO_1P2 | K6 | BT_GPIO_4 |
| B10 | WRF_AFE_TEST_IN | E5 | TDI | G13 | AVSS | K7 | BT_GPIO_5 |
| B11 | AVSS | E6 | TAP_SEL | G14 | WRF_RFINN_G1_XFMR | K8 | BT_GPIO_7 |
| B12 | AVSS | E7 | RF_SW_CTRL_P_1 | H1 | SPROM_DOUT | K9 | BT_TM1 |
| B13 | WRF_VDDPAA_3P3 | E8 | VSS | H2 | SDIO_DATA_1 | K10 | BT_GPIO_2 |
| B14 | AVSS | E9 | WRF_AFE_TSSI_G | H3 | WL_UART_RX0 | K11 | WRF_VDDA_1P2 |
| C1 | SR_VNLDO | E10 | WRF_BBPLL_VDD_1P2 | H4 | VDDC | K12 | BT_VDDRF |
| C2 | SR_TESTSWG | E11 | WRF_AFE_TEST_QP | H5 | OTP_VDD25 | K13 | BTFM_VSS |
| C3 | SR_PVSS | E12 | WRF_AFE_IQADC_VREF | H6 | VDDIO | K14 | BT_RFIOP |
| C4 | TDO | E13 | WRF_VDDRX_1P2 | H7 | ERCX_TX_FREQ | L1 | VOUT_CLDO |
| C5 | TEST_SE | E14 | WRF_RFINN_A1_XFMR | H8 | SPROM_DIN | L2 | SDIO_DATA_0 |
| C6 | VDDIO_RF | F1 | SR_VLX2BB | H9 | BT_GPIO_1 | L3 | VDDIO_SD |
| C7 C8 | WRF_AFE_DIGIT_TEST1 | F2 | SR_PVSSB | H10 | VDDC | L4 | BT_SDA |



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| Ball | Signal |
|------|---------------|
| L5 | BT_PCM_OUT |
| L6 | BT_GPIO_6 |
| L7 | BT_UART_RXD |
| L8 | BT_TM2 |
| L9 | FM_ADVSS |
| L10 | VDD_XTAL |
| L11 | WRF_RES_EXT |
| L12 | WRF_EXTREFIN |
| L13 | BT_VDDIFIFP |
| L14 | BT_VDDTF |
| M1 | VOUT_LNLDO1 |
| M2 | VIN_CLDO |
| M3 | VIN_LNLDO1 |
| M4 | BT_VSSC_0 |
| M5 | BT_PCM_SYNC |
| M6 | BT_GPIO_3 |
| M7 | FM_AUDIO_OUT1 |
| M8 | FM_ADVDD |
| M9 | FM_AUDIO_OUT2 |
| M10 | FM_VDDVCO |
| M11 | FM_CVAR |
| M12 | BTFM_VSS |
| M13 | BT_VDDVCO |
| M14 | BTFM_VSS |
| N1 | VIN_LNLDO2 |
| N2 | BT_VDDO |
| N3 | AVDD2P5_LDO |
| N4 | BT_VDDC |
| N5 | BT_SCL |
| N6 | BT_UART_RTS_N |
| N7 | BT_COEX_OUT0 |
| N8 | BT_TM0 |
| N9 | BT_RST_N |
| N10 | FM_VDDPLL |
| N11 | BTFM_VSS |
| N12 | N/C |
| N13 | N/C |
| N14 | BTFM_VSS |
| P1 | VREF_LDO |
| P2 | AVSS1_LDO |
| P3 | VOUT_LNLDO2 |
| P4 | BT_UART_TXD |
| P5 | BT_UART_CTS_N |
| P6 | SDIO_DATA_3 |
| P7 | BT_COEX_OUT1 |
| P8 | OSCIN |
| P9 | OSCOUT |

| Ball | Signal |
|------|-----------|
| P10 | FM_VDDRF |
| P11 | FM_RXP |
| P12 | FM_RXN |
| P13 | FM_VDDIF |
| P14 | BT_VDDPLL |
| | |
| | |



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339-PIN WLCSP PINOUT

Note: The X- and Y-coordinate orientation is looking at the silicon face (i.e., looking up at the bottom of the die at the bumps, as opposed to top down). Refer to Figure 36 on page 116 for X- and Y-coordinate origin information.

Note: The WLCSP package was optimized and eight pins were removed (originally 347-pin WLCSP package). However, the CSP package pin out was not renumbered. The following pins were removed: Pin 1 WRF_PA_BYPGND_3P3, Pin 154 VOUT_LNLDO3, Pin 157 VIN_LNLDO3, Pin 258 usb20d_ulpi_stp, Pin 282 usb20d_ulpi_data_6, Pin 283 usb20d_ulpi_data_5, Pin 295 usb20d_ulpi_data_7, and Pin 307 usb20d_ulpi_nxt

Table 7: 339-Pin WLCSP Signal Assignments by Pin Number and X- and Y-Coordinates

| Pin # | # Signal Name | X-Coord | Y-Coord | Pin # | # Signal Name | X-Coord | Y-Coord |
|-------|--------------------|----------|----------|-------|-------------------|----------|----------|
| 2 | WRF_RFOUTN_A | 184.63 | 5538.005 | 36 | WRF_RFINP_A1 | 211.8 | 4063.055 |
| 3 | WRF_VDDPAA_3P3 | 684.63 | 5538.005 | 37 | WRF_EXTCOUPLE_GIN | 2676.285 | 4051.17 |
| 4 | WRF_VDDPAA_3P3 | 434.63 | 5538.005 | 38 | WRF_BBPLL_GND_1P2 | 2926.285 | 4036.35 |
| 5 | WRF_RFOUTP_A | 934.63 | 5538.005 | 39 | WRF_GNDLO_1P2 | 1544.575 | 3877.305 |
| 6 | WRF_RFOUTN_G | 1184.63 | 5538.005 | 40 | WRF_RFINN_A1_XFMR | 211.8 | 3784.06 |
| 7 | WRF_VDDPAG_3P3 | 1684.63 | 5538.005 | 41 | WRF_VDDRX_1P2 | 461.8 | 3784.06 |
| 8 | WRF_VDDPAG_3P3 | 1434.63 | 5538.005 | 42 | WRF_GNDRX_1P2 | 711.8 | 3605.83 |
| 9 | WRF_RFOUTP_G | 1934.63 | 5538.005 | 43 | WRF_VDDLO_1P2 | 1544.575 | 3627.305 |
| 10 | WRF_AFE_pad_AVSS_ | 2186.84 | 5254.51 | 44 | WRF_GPIO_OUT1 | 1794.575 | 3627.305 |
| | RXADC | | | 45 | WRF_GPIO_OUT2 | 2044.575 | 3627.305 |
| 11 | WRF_AFE_AVDD_RXADC | 2523.96 | 5254.245 | 46 | WRF_RFINN_G2_XFMR | 211.8 | 3534.045 |
| 12 | WRF_AFE_pad_AVSS_ | 2773.96 | 5254.245 | 47 | WRF_PA_100UA | 461.8 | 3534.045 |
| | TXDAC | | | 48 | WRF_RFINP_G2 | 211.8 | 3244.045 |
| 13 | WRF_AFE_AVDD_TXDAC | 3073.81 | 5254.245 | 49 | WRF_RFINP_G1 | 211.8 | 2956.455 |
| 14 | WRF_GNDPAA_3P3 | 184.63 | 4933.17 | 50 | WRF_VDDVCO_1P2 | 1305.455 | 2993.545 |
| 15 | WRF_GNDTX_1P2 | 419.98 | 4822.4 | 51 | WRF_GNDVCO_1P2 | 1555.455 | 2993.545 |
| 16 | WRF_GNDPAA_3P3 | 934.63 | 4933.17 | 52 | WRF_RFINN_G1_XFMR | 211.8 | 2666.455 |
| 17 | WRF_GNDPAG_3P3 | 1184.63 | 4902.645 | 53 | WRF_GNDD_1P2 | 711.8 | 2655 |
| 18 | WRF_GNDPAG_3P3 | 1934.63 | 4902.645 | 54 | WRF_VDDD_1P2 | 961.8 | 2655 |
| 19 | WRF_AFE_test_In | 2182.26 | 4954.545 | 55 | WRF_GNDPFDCP_1P2 | 211.8 | 2405 |
| 20 | WRF_AFE_test_opl | 2823.81 | 5004.235 | 56 | WRF_VDDPFDCP_1P2 | 461.8 | 2405 |
| 21 | WRF_AFE_test_onQ | 3073.81 | 5004.235 | 57 | WRF_GNDA_1P2 | 711.8 | 2405 |
| 22 | WRF_AFE_test_lp | 2182.26 | 4704.5 | 58 | WRF_VDDA_1P2 | 961.8 | 2405 |
| 23 | WRF_AFE_TSSI_A | 2573.81 | 4779.235 | 59 | WRF_VDDCAB_1P2 | 211.8 | 2155 |
| 24 | WRF_AFE_test_onI | 2823.81 | 4754.235 | 60 | WRF_GNDCAB_1P2 | 461.8 | 2155 |
| 25 | WRF_AFE_test_opQ | 3073.81 | 4754.235 | 61 | WRF_EXTREFIN | 1818.185 | 2155 |
| 26 | WRF_RFINN_A2_XFMR | 211.8 | 4663.165 | 62 | WRF_RES_EXT | 2068.185 | 2155 |
| 27 | WRF_VDDTX_1P2 | 1551.915 | 4506.545 | 63 | BT_RFION | 202 | 1875 |
| 28 | WRF_AFE_iqadc_VREF | 2182.26 | 4453.92 | 64 | BT_VDDRF | 452 | 1875 |
| 29 | WRF_AFE_AVDD_AUX | 2573.81 | 4529.235 | 65 | BT_VSSRF | 893 | 1847 |
| 30 | WRF_AFE_TSSI_G | 3073.81 | 4504.235 | 66 | BT_RFIOP | 202 | 1625 |
| 31 | WRF_RFINP_A2 | 211.8 | 4384.17 | 67 | BT_VSSPA | 452 | 1625 |
| 32 | WRF_EXTCOUPLE_AIN | 2676.285 | 4301.17 | 68 | BT VDDTF | 202 | 1375 |
| 33 | WRF_BBPLL_VDD_1P2 | 2926.285 | 4301.17 | 69 | BT VSSIF | 452 | 1375 |
| 34 | WRF_AFE_test_Qp | 2196.31 | 4202.195 | 70 | BT VDDIF | 202 | 1125 |
| 35 | WRF_AFE_test_Qn | 2446.31 | 4202.195 | | | _•- | |

X-Coord

4872.985

5122.985

5622.985

6122.985

5498

5748

5998

6248

5372.985

5622.985

5872.985

6122.985

5498

5748

5998

6248

5372.985

5622.985

5872.985

6122.985

5498

5748

5998

6248

5372.985

5622.985

5872.985

6122.985

5497.96

5747.96

6247.97

5497.96

5747.96

6247.97

5497.96

5997.965

6247.97

5997.965

6247.97

5747.96

6247.97

3325

3575

5997.965

5997.965

5997.965

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Y-Coord

4895.4

4895.4

4895.4

4895.4

4676

4676

4676

4676

4459.4

4459.4

4459.4

4459.4

4240

4240

4240

4240

4023.4

4023.4

4023.4

4023.4

3804

3804

3804

3804

3587.4

3587.4

3587.4

3587.4

1118.285

1118.285

1118.285

1118.285

868.285

868.285

868.285

868.285

618.285

618.285

618.285

368.285

368.285

118.285

118.285

118.285

5400

5400

| 71 FM_ADVSS 2468 935 72 FM_ADVDD 2839 935 73 BT_VDDVCO 202 748 74 FM_VSSVCO 1492 744 75 FM_AUDIO_OUT2 2468 685 76 FM_AUDIO_OUT1 2839 685 77 BT_VDDPLL 150 435 78 BT_VSSVCO 400 435 79 BT_VSSVCO 400 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 NC Connect (NC) 1150 435 84 FM_VSSRL 1400 435 85 VSS_XTAL 2150 435 84 FM_VSSIE 400 185 87 DUMMY_BUMP 150 185 86 FM_VSSIF 400 185 91 FM_RXN 900 185 91 FM_RXN 900 | Pin # | # Signal Name | X-Coord | Y-Coord | Pin # Signal Name |
|---|-------|-----------------|----------|---------|---------------------|
| 72 FM_ADVDD 2839 935 73 BT_VDDVCO 202 748 74 FM_VSSVCO 1492 744 75 FM_AUDIO_OUT2 2468 685 76 FM_AUDIO_OUT1 2839 685 77 BT_VSSVCO 400 435 78 BT_VSSVCO 400 435 78 BT_VSSVCO 400 435 78 BT_VSSVCO 400 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_VSSIF 400 435 84 FM_VSSIF 400 185 85 VS_XTAL 2150 435 87 DUMMY_BUMP 150 185 88 FM_VDDIF 650 185 90 FM_RNN 900 | 71 | FM_ADVSS | 2468 | 935 | 117 SR_AVSS |
| 73 BT_VDDVCO 202 748 74 FM_VSSVCO 1492 744 75 FM_AUDIO_OUT1 2488 685 76 FM_AUDIO_OUT1 2839 685 77 BT_VSSVCO 400 435 78 BT_VSSVCO 400 435 78 BT_VSSVCO 400 435 78 BT_VSSVLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_CVAR 1650 435 84 FM_VSSFL 1900 435 85 VSS_XTAL 2150 435 86 VDXTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VDDIF 650 185 91 FM_RXN 900 185 93 FM_VDDPLL 1900 185 94 FM_VDDPLX 1400 185 | 72 | FM_ADVDD | 2839 | 935 | 118 SR_VBAT1A |
| 74 FM_VSSVCO 1492 744 75 FM_AUDIO_OUT2 2468 685 76 FM_AUDIO_OUT1 2839 685 78 TVDPLL 150 435 122 SR_VBATBB 78 BT_VSSVCO 400 435 123 SR_VBATBB 78 BT_VSSVCO 400 435 124 SR_VFABB 79 BT_VSSPLL 650 435 124 SR_VFABB 81 No Connect (NC) 1150 435 127 SR_VBATBB 82 FM_VSSRX 1400 435 130 SR_VLX1BB 84 FM_VSSRL 1900 435 131 SR_VLX1BB 85 VSS_XTAL 2150 435 132 SR_VLX1BB 86 VDD_XTAL 2400 435 133 SR_PVSSB 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VDDRX 1400 185 133 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB | 73 | BT_VDDVCO | 202 | 748 | 119 SR_AVSS |
| 75 FM_AUDIO_OUT2 2468 685 76 FM_AUDIO_OUT1 2839 685 77 BT_VSDPLL 150 435 78 BT_VSSVCO 400 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_VSSRX 1400 435 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VSIF 400 185 89 FM_VDDIF 650 185 91 FM_NDDNZ 1400 185 92 FM_VDDVCO 1650 185 93 FM_VDDPLL 1900 185 94 FM_VDDPLL 1900 185 95 oscin 2150 185 | 74 | FM_VSSVCO | 1492 | 744 | 120 SR_VDDNLDO |
| 76 FM_AUDIO_OUT1 2839 685 77 BT_VDDPLL 150 435 78 BT_VSSVCO 400 435 78 BT_VSSVLD 650 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_CVAR 1650 435 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VSIF 400 185 89 FM_VDDIF 650 185 91 FM_RXP 1150 185 92 FM_VDDRX 1400 185 93 FM_VDDPLL 1900 185 94 FM_VDDPLL 1900 185 95 oscoin 2150 185 9 | 75 | FM_AUDIO_OUT2 | 2468 | 685 | 121 BT_REG_ON |
| 77 BT_VDPLL 150 435 78 BT_VSSVCO 400 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSPL 1400 435 83 FM_CVAR 1650 435 84 FM_VSSPL 1900 435 85 VSS_XTAL 2150 435 86 VD_XTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VSIF 400 185 89 FM_VDDIF 650 185 90 FM_RXN 900 185 91 FM_VDDRX 1400 185 92 FM_VDDRX 1400 185 93 FM_VDDVCO 1650 185 94 FM_VDDPLL 1900 185 95 oscin 2150 185 96 oscout 2400 185 97 | 76 | FM_AUDIO_OUT1 | 2839 | 685 | 122 SR_VBATBB |
| 78 BT_VSSVCO 400 435 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_CVAR 1650 435 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMMY BUMP 150 185 88 FM_VSSIF 400 185 90 FM_RXN 900 185 91 FM_RXN 900 185 92 FM_VDDIF 650 185 93 FM_VDDRX 1400 185 93 FM_VDDPLL 1900 185 94 FM_VDDPLL 1900 185 95 oscoit 2150 185 94 FM_VDDPLL 1900 185 95 oscoit 2150 185 94 | 77 | BT_VDDPLL | 150 | 435 | 123 SR_VBATBB |
| 79 BT_VSSPLL 650 435 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_CVAR 1650 435 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VSSIF 400 185 89 FM_RXN 900 185 91 FM_RXP 1150 185 92 FM_VDDRX 1400 185 93 FM_VDDRX 1400 185 94 FM_VDDRX 1400 185 95 oscin 2150 185 94 FM_VDDLL 1900 185 95 SR_VLX1 5498 5548 100 SR_VEX1 5498 548 99< | 78 | BT_VSSVCO | 400 | 435 | 124 SR_VFBBB |
| 80 No Connect (NC) 900 435 81 No Connect (NC) 1150 435 82 FM_VSSRX 1400 435 83 FM_CVAR 1650 435 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMWY_BUMP 150 185 88 FM_VSSIF 400 185 89 FM_VDDIF 650 185 91 FM_RXN 900 185 92 FM_VDDRX 1400 185 93 FM_VDDRX 1400 185 94 FM_VDDRX 1400 185 95 oscin 2150 185 94 FM_VDDPLL 1900 185 97 BT_RST_N 2650 150 143 SR_VOUTBB 144 SR_VOUTBB 98 SR_VFB2 4748 <t< td=""><td>79</td><td>BT_VSSPLL</td><td>650</td><td>435</td><td>125 WL_REG_ON</td></t<> | 79 | BT_VSSPLL | 650 | 435 | 125 WL_REG_ON |
| 81 No Connect (NC) 1150 435 127 SR_VBATBB 82 FM_VSSRX 1400 435 128 SR_VBATBB 83 FM_CVAR 1650 435 129 SR_VLX1BB 84 FM_VSSPLL 1900 435 130 SR_VLX1BB 85 VSS_XTAL 2150 435 131 SR_VLX1BB 86 VD_XTAL 2400 435 133 SR_VLX1BB 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VDDIF 650 185 135 SR_PVSSB 90 FM_NDDNX 1400 185 136 SR_PVSSB 91 FM_VDDPX 1400 185 138 SR_VLX2BB 93 FM_VDDPX 1400 185 139 SR_VLX2BB 93 FM_VDDPX 1650 185 140 SR_VLX2BB 94 FM_VDDPLL 1900 185 141 SR_VLX2BB | 80 | No Connect (NC) | 900 | 435 | 126 SR_VBATBB |
| 82 FM_VSSRX 1400 435 128 SR_VBATBB 83 FM_CVAR 1650 435 129 SR_VLX1BB 84 FM_VSSPLL 1900 435 130 SR_VLX1BB 85 VSS_XTAL 2150 435 131 SR_VLX1BB 86 VDD_XTAL 2400 435 132 SR_VLX1BB 87 DUMMY_BUMP 150 185 133 SR_VLX1BB 88 FM_VSSIF 400 185 134 SR_PVSSB 90 FM_RXN 900 185 135 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VL2BB 92 FM_VDDRX 1400 185 138 SR_VLX2BB 93 FM_VDDVCO 1650 185 134 SR_VLX2BB 94 FM_VDDPLL 1900 185 144 SR_VCX2BB 95 oscint 2150 185 144 SR_VOUTBB 96< | 81 | No Connect (NC) | 1150 | 435 | 127 SR_VBATBB |
| 83 FM_CVAR 1650 435 129 SR_VLX1BB 84 FM_VSSPLL 1900 435 130 SR_VLX1BB 85 VSS_XTAL 2150 435 131 SR_VLX1BB 86 VDD_XTAL 2400 435 132 SR_VLX1BB 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VSSIF 400 185 134 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VLX2BB 92 FM_VDDRX 1400 185 138 SR_VLX2BB 93 FM_VDDVCO 1650 185 140 SR_VLX2BB 94 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 osciut 2400 185 141 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 145 VIN_LODO 101 | 82 | FM_VSSRX | 1400 | 435 | 128 SR_VBATBB |
| 84 FM_VSSPLL 1900 435 85 VSS_XTAL 2150 435 86 VDD_XTAL 2400 435 87 DUMMY_BUMP 150 185 88 FM_VSSIF 400 185 89 FM_VDDIF 650 185 90 FM_RXN 900 185 91 FM_VDDRX 1400 185 92 FM_VDDRX 1400 185 93 FM_VDDVCO 1650 185 94 FM_VDDPLL 1900 185 95 oscin 2150 185 94 FM_VDDPLL 1900 185 95 oscin 2150 185 96 oscout 2400 185 97 BT_RST_N 2650 150 100 SR_VEB2 4748 5548 141 SR_VOUTBB 144 SR_VOUTBB 98 SR_VLX2 4998 5548 101 SR_VLX1 5498 5448 144 | 83 | FM_CVAR | 1650 | 435 | 129 SR_VLX1BB |
| 85 VSS_XTAL 2150 435 131 SR_VLX1BB 86 VDD_XTAL 2400 435 132 SR_VLX1BB 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VSSIF 400 185 134 SR_PVSSB 90 FM_RXN 900 185 134 SR_PVSSB 91 FM_RXP 1150 185 136 SR_PVSSB 92 FM_VDDRX 1400 185 137 SR_VLX2BB 92 FM_VDDPLL 1900 185 139 SR_VLX2BB 93 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscin 2150 185 141 SR_VLX2BB 96 oscout 2400 185 144 SR_VOUTBB 98 SR_VLX2 4998 5548 144 SR_VOUTBB 99 SR_VLX1 5498 5548 144 VOUT_CLDO 100 <td>84</td> <td>FM_VSSPLL</td> <td>1900</td> <td>435</td> <td>130 SR_VLX1BB</td> | 84 | FM_VSSPLL | 1900 | 435 | 130 SR_VLX1BB |
| 66 VDD_XTAL 2400 435 132 SR_VLX1BB 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VDDIF 650 185 134 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VL2BB 92 FM_VDDRX 1400 185 138 SR_VL2BB 93 FM_VDDVCO 1650 185 139 SR_VL2BB 94 FM_VDDPLL 1900 185 141 SR_VC2BB 95 oscout 2400 185 141 SR_VC0UTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX1 5498 5548 144 SR_VOUTBB 100 SR_VFB1 5998 5548 144 VIN_CLDO 101 SR_VLX1 5498 5548 144 VIN_LINDO1 105< | 85 | VSS_XTAL | 2150 | 435 | 131 SR_VLX1BB |
| 87 DUMMY_BUMP 150 185 133 SR_PVSSB 88 FM_VSSIF 400 185 134 SR_PVSSB 89 FM_VDDIF 650 185 135 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VLX2BB 92 FM_VDDRX 1400 185 138 SR_VLX2BB 93 FM_VDDVCO 1650 185 139 SR_VLX2BB 94 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscoin 2150 185 141 SR_VLX2BB 96 oscout 2400 185 142 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX1 5498 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 144 VIN_CLDO 101 SR_VLX1 5498 5548 144 VIN_LNLDO1 105 <td>86</td> <td>VDD_XTAL</td> <td>2400</td> <td>435</td> <td>132 SR_VLX1BB</td> | 86 | VDD_XTAL | 2400 | 435 | 132 SR_VLX1BB |
| 88 FM_VSSIF 400 185 134 SR_PVSSB 89 FM_VDDIF 650 185 135 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VL2BB 92 FM_VDDXX 1400 185 138 SR_VL2BB 93 FM_VDDVCO 1650 185 139 SR_VL2BB 95 oscin 2150 185 140 SR_VL2BB 95 oscin 2150 185 141 SR_VC2BB 96 oscout 2400 185 141 SR_VC0TBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX1 5498 144 VIN_CLDO 100 SR_VEAT 5748 5548 144 VIN_CLDO 101 SR_VEAT 598 5548 149 VIN_LNLDO1 105 SR_PVSS1 | 87 | DUMMY_BUMP | 150 | 185 | 133 SR_PVSSB |
| 89 FM_VDDIF 650 185 135 SR_PVSSB 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VLX2BB 92 FM_VDDRX 1400 185 139 SR_VLX2BB 93 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscin 2150 185 141 SR_VLX2BB 96 oscout 2400 185 142 SR_VOUTBB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 VIN_CLDO 100 SR_VBAT1A 5248 5548 144 VIN_CLDO 101 SR_VEB1 5998 5548 144 VIN_LNLO1 102 SR_VBAT1B 6248 5548 144 VIN_LNLO1 105 SR_VLX1 5032.985 5331.4 155 VIN_LNLDO1 <t< td=""><td>88</td><td>FM_VSSIF</td><td>400</td><td>185</td><td>134 SR_PVSSB</td></t<> | 88 | FM_VSSIF | 400 | 185 | 134 SR_PVSSB |
| 90 FM_RXN 900 185 136 SR_PVSSB 91 FM_RXP 1150 185 137 SR_VL2BB 92 FM_VDDVCO 1650 185 139 SR_VL2BB 93 FM_VDDPLL 1900 185 139 SR_VL2BB 94 FM_VDDPLL 1900 185 140 SR_VL2BB 95 oscin 2150 185 140 SR_VL2BB 96 oscout 2400 185 141 SR_VL2BB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 144 VIN_CLDO 101 SR_VLX1 5498 5548 144 VIN_CLDO 102 SR_PVSS1 5748 5548 144 VIN_LNLDO1 104 SR_VBAT1B 62248 5531.4 150 VIN_LNLDO1 < | 89 | FM_VDDIF | 650 | 185 | 135 SR_PVSSB |
| 91 FM_RXP 1150 185 137 SR_VL2BB 92 FM_VDDRX 1400 185 138 SR_VL2BB 93 FM_VDDVCO 1650 185 139 SR_VL2BB 94 FM_VDDPLL 1900 185 140 SR_VL2BB 95 oscin 2150 185 141 SR_VL2BB 96 oscout 2400 185 141 SR_VL2BB 97 BT_RST_N 2650 150 141 SR_VOITBB 98 SR_VFB2 4748 5548 144 SR_VOITBB 99 SR_VLX2 4998 5548 144 SR_VOITBB 100 SR_VBAT1A 5248 5548 144 VIN_CLDO 101 SR_VVS1 5748 5548 144 VIN_CLDO 102 SR_PVSS2 4872.985 5331.4 150 VIN_LNLDO1 105 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO1 106 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 | 90 | FM_RXN | 900 | 185 | 136 SR_PVSSB |
| 92 FM_VDDRX 1400 185 138 SR_VLX2BB 93 FM_VDDVCO 1650 185 139 SR_VLX2BB 94 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscin 2150 185 141 SR_VLX2BB 96 oscout 2400 185 142 SR_VUX2BB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 144 SR_VOUTGO 101 SR_VLX1 5498 5548 147 VOUT_CLDO 102 SR_PVSS1 5748 5548 149 VIN_LNLDO1 105 SR_PVSS2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX1 5622.985 5331.4 152 VOUT_LNLDO1 | 91 | FM_RXP | 1150 | 185 | 137 SR_VLX2BB |
| 93 FM_VDDVCO 1650 185 139 SR_VLX2BB 94 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscoin 2150 185 141 SR_VLX2BB 96 oscout 2400 185 141 SR_VLX2BB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 144 SR_VOUTBB 101 SR_VLX1 5498 5548 146 VIN_CLDO 102 SR_PVSS1 5748 5548 147 VOUT_CLDO 103 SR_VFB1 5998 5548 148 VOUT_CLDO 104 SR_VS2 5122.985 5331.4 150 VIN_LNLDO1 105 SR_VLX1 5622.985 5331.4 152 VOUT_LNLDO1 106 SR_VLX1 5248 5112 156 VOUT_LNLDO2 < | 92 | FM_VDDRX | 1400 | 185 | 138 SR_VLX2BB |
| 94 FM_VDDPLL 1900 185 140 SR_VLX2BB 95 oscoin 2150 185 141 SR_VUX2BB 96 oscout 2400 185 141 SR_VOUTBB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBATIA 5248 5548 144 SR_VOUTBB 101 SR_VLX1 5498 5548 144 VOUT_CLDO 102 SR_PVSS1 5748 5548 144 VOUT_CLDO 103 SR_VFB1 5998 5548 144 VOUT_CLDO 104 SR_VBAT1B 6248 5548 149 VIN_LNLDO1 105 SR_PVSS2 4872.985 5331.4 150 VIN_LNLDO1 106 SR_VLX1 5622.985 5331.4 152 VOUT_LNLDO2 109 SR_PVSS1 5872.985 5331.4 155 VIN_LNLDO | 93 | FM_VDDVCO | 1650 | 185 | 139 SR_VLX2BB |
| 95 oscin 2150 185 141 SR_VOUTBB 96 oscout 2400 185 142 SR_VOUTBB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 145 VIN_CLDO 101 SR_VLX1 5498 5548 144 VOUT_CLDO 102 SR_PVSS1 5748 5548 144 VOUT_CLDO 103 SR_VFB1 5998 5548 144 VOUT_CLDO 104 SR_VVS2 4872.985 5331.4 150 VIN_LNLDO1 105 SR_VLX1 5622.985 5331.4 152 VOUT_LNLDO1 106 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_VSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 110 SR_VSPLTA 5248 5112 160 AVD | 94 | FM_VDDPLL | 1900 | 185 | 140 SR_VLX2BB |
| 96 oscout 2400 185 142 SR_VOUTBB 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 145 VIN_CLDO 101 SR_VLX1 5498 5548 146 VIN_CLDO 102 SR_PVSS1 5748 5548 147 VOUT_CLDO 103 SR_VFB1 5998 5548 148 VOUT_CLDO 104 SR_VBAT1B 6248 5548 149 VIN_LNLDO1 105 SR_PVSS2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX1 5622.985 5331.4 152 VOUT_LNLDO1 107 SR_VBAT1A 5372.985 5331.4 156 VOUT_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VBAT1A 5248 5112 160 | 95 | oscin | 2150 | 185 | 141 SR_VOUTBB |
| 97 BT_RST_N 2650 150 143 SR_VOUTBB 98 SR_VFB2 4748 5548 144 SR_VOUTBB 99 SR_VLX2 4998 5548 144 SR_VOUTBB 100 SR_VBAT1A 5248 5548 145 VIN_CLDO 101 SR_VLX1 5498 5548 146 VIN_CLDO 102 SR_PVSS1 5748 5548 147 VOUT_CLDO 103 SR_VFB1 5998 5548 149 VIN_LNLDO1 104 SR_VBAT1B 6248 5548 150 VIN_LNLDO1 105 SR_PVSS2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX2 5122.985 5331.4 152 VOUT_LNLDO1 108 SR_VLX1 5622.985 5331.4 155 VIN_LNDO2 109 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 158 VIN_LNLDO4 111 SR_PVSS1 5748 5112 1 | 96 | oscout | 2400 | 185 | 142 SR_VOUTBB |
| 98 SR_VFB2 4748 5548 99 SR_VLX2 4998 5548 100 SR_VBAT1A 5248 5548 101 SR_VLX1 5498 5548 102 SR_VVSS1 5748 5548 103 SR_VFB1 5998 5548 104 SR_VBAT1B 6248 5548 105 SR_PVSS2 4872.985 5331.4 106 SR_VLX2 5122.985 5331.4 107 SR_VBAT1A 5372.985 5331.4 108 SR_VLX1 5622.985 5331.4 109 SR_VSSPLDO 6122.985 5331.4 111 SR_VSSPLDO 6122.985 5331.4 112 SR_VBAT1A 5248 5112 110 SR_VSSPLDO 6122.985 5331.4 112 SR_VBAT1A 5248 5112 110 SR_VSSPLDO 6122.985 5331.4 111 SR_VSSPLDO 6122.985 5112 113 SR_VLX1 5498 5112 114 | 97 | BT_RST_N | 2650 | 150 | 143 SR_VOUTBB |
| 99 SR_VLX2 4998 5548 145 VIN_CLDO 100 SR_VBAT1A 5248 5548 146 VIN_CLDO 101 SR_VLX1 5498 5548 147 VOUT_CLDO 102 SR_PVSS1 5748 5548 147 VOUT_CLDO 103 SR_VFB1 5998 5548 148 VOUT_CLDO 104 SR_VBAT1B 6248 5548 150 VIN_LNLDO1 105 SR_VBX2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX2 5122.985 5331.4 152 VOUT_LNLDO1 107 SR_VBAT1A 5372.985 5331.4 153 AVSS1_LDO 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 158 VIN_LNLO4 111 SR_PVSS1 5748 5112 </td <td>98</td> <td>SR_VFB2</td> <td>4748</td> <td>5548</td> <td>144 SR_VOUTBB</td> | 98 | SR_VFB2 | 4748 | 5548 | 144 SR_VOUTBB |
| 100SR_VBAT1A52485548101SR_VLX154985548102SR_PVSS157485548103SR_VFB159985548104SR_VBAT1B62485548105SR_PVSS24872.9855331.4106SR_VLX25122.9855331.4107SR_VBAT1A5372.9855331.4108SR_VLX15622.9855331.4109SR_PVSS15872.9855331.4109SR_PVSS15872.9855331.4110SR_VSSPLDO6122.9855331.4111SR_VSSPLDO6122.9855331.4112SR_VBAT1A52485112113SR_VLX154985112114SR_PVSS157485112115SR_TESTSWG59985112116SR_AVDD2P562485112116SR_AVDD2P562485112 | 99 | SR_VLX2 | 4998 | 5548 | 145 VIN_CLDO |
| 101SR_VLX154985548147VOUT_CLDO102SR_PVSS157485548148VOUT_CLDO103SR_VFB159985548149VIN_LNLDO1104SR_VBAT1B62485548150VIN_LNLDO1105SR_PVSS24872.9855331.4151VOUT_LNLDO1106SR_VLX25122.9855331.4152VOUT_LNLDO1107SR_VBAT1A5372.9855331.4153AVSS1_LDO108SR_VLX15622.9855331.4155VIN_LNLDO2109SR_PVSS15872.9855331.4156VOUT_LNLDO2110SR_VSSPLDO6122.9855331.4156VOUT_LNLDO2111SR_PVSS249985112160AVD2P5_LDO112SR_VBAT1A52485112161AVSS2_LDO113SR_VLX154985112161AVSS2_LDO114SR_PVSS157485112163packageoption_0116SR_AVDD2P562485112164rf_sw_ctrl_n_0 | 100 | SR_VBAT1A | 5248 | 5548 | 146 VIN_CLDO |
| 102SR_PVSS157485548148VOUT_CLDO103SR_VFB159985548149VIN_LNLDO1104SR_VBAT1B62485548150VIN_LNLDO1105SR_PVSS24872.9855331.4151VOUT_LNLDO1106SR_VLX25122.9855331.4152VOUT_LNLDO1107SR_VBAT1A5372.9855331.4153AVSS1_LDO108SR_VLX15622.9855331.4155VIN_LNLDO2109SR_PVSS15872.9855331.4156VOUT_LNLDO2110SR_VSSPLDO6122.9855331.4156VOUT_LNLDO2111SR_PVSS249985112159VOUT_LNLDO4112SR_VBAT1A52485112160AVD2P5_LDO113SR_VLX154985112161AVSS2_LDO114SR_PVSS157485112162VREF_LDO115SR_TESTSWG59985112163packageoption_0116SR_AVDD2P562485112164rf_sw_ctrl_n_0 | 101 | SR_VLX1 | 5498 | 5548 | 147 VOUT_CLDO |
| 103SR_VFB159985548149VIN_LNLDO1104SR_VBAT1B62485548150VIN_LNLDO1105SR_PVSS24872.9855331.4151VOUT_LNLDO1106SR_VLX25122.9855331.4152VOUT_LNLDO1107SR_VBAT1A5372.9855331.4153AVSS1_LDO108SR_VLX15622.9855331.4155VIN_LNLDO2109SR_PVSS15872.9855331.4156VOUT_LNLDO2110SR_VSSPLDO6122.9855331.4156VOUT_LNLDO2111SR_PVSS249985112158VIN_LNLDO4112SR_VBAT1A52485112160AVDD2P5_LDO113SR_VLX154985112161AVSS2_LDO114SR_PVSS157485112162VREF_LDO115SR_TESTSWG59985112163packageoption_0116SR_AVDD2P562485112164rf_sw_ctrl_n_0 | 102 | SR_PVSS1 | 5748 | 5548 | 148 VOUT_CLDO |
| 104 SR_VBAT1B 6248 5548 150 VIN_LNLDO1 105 SR_PVSS2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX2 5122.985 5331.4 152 VOUT_LNLDO1 107 SR_VBAT1A 5372.985 5331.4 153 AVSS1_LDO 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 111 SR_PVSS2 4998 5112 159 VOUT_LNLDO4 111 SR_VBAT1A 5248 5112 160 AVSS2_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 113 SR_VSS1 5748 5112 161 AVSS2_LDO 114 SR_AVDD2P5 6248 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 <td>103</td> <td>SR_VFB1</td> <td>5998</td> <td>5548</td> <td>149 VIN_LNLDO1</td> | 103 | SR_VFB1 | 5998 | 5548 | 149 VIN_LNLDO1 |
| 105 SR_PVSS2 4872.985 5331.4 151 VOUT_LNLDO1 106 SR_VLX2 5122.985 5331.4 152 VOUT_LNLDO1 107 SR_VBAT1A 5372.985 5331.4 153 AVSS1_LDO 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 111 SR_PVSS2 4998 5112 160 AVD2P5_LDO 112 SR_VBAT1A 5248 5112 160 AVD2P5_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_AVDD2P5 6248 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 104 | SR_VBAT1B | 6248 | 5548 | 150 VIN_LNLDO1 |
| 106 SR_VLX2 5122.985 5331.4 152 VOUT_LNLDO1 107 SR_VBAT1A 5372.985 5331.4 153 AVSS1_LDO 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 111 SR_PVSS2 4998 5112 158 VIN_LNLDO4 111 SR_VBAT1A 5248 5112 160 AVD2P5_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 105 | SR_PVSS2 | 4872.985 | 5331.4 | 151 VOUT_LNLDO1 |
| 107 SR_VBAT1A 5372.985 5331.4 153 AVSS1_LDO 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 111 SR_PVSS2 4998 5112 159 VOUT_LNLDO4 112 SR_VBAT1A 5248 5112 160 AVSS2_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 106 | SR_VLX2 | 5122.985 | 5331.4 | 152 VOUT_LNLDO1 |
| 108 SR_VLX1 5622.985 5331.4 155 VIN_LNLDO2 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 156 VOUT_LNLDO2 111 SR_PVSS2 4998 5112 158 VIN_LNLDO4 112 SR_VBAT1A 5248 5112 160 AVDD2P5_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 107 | SR_VBAT1A | 5372.985 | 5331.4 | 153 AVSS1_LDO |
| 109 SR_PVSS1 5872.985 5331.4 156 VOUT_LNLDO2 110 SR_VSSPLDO 6122.985 5331.4 158 VIN_LNLDO4 111 SR_PVSS2 4998 5112 159 VOUT_LNLDO4 112 SR_VBAT1A 5248 5112 160 AVD2P5_LDO 113 SR_VLX1 5498 5112 161 AVS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 108 | SH_VLX1 | 5622.985 | 5331.4 | 155 VIN_LNLDO2 |
| 110 SR_VSSPLDO 6122.985 5331.4 158 VIN_LNLDO4 111 SR_PVSS2 4998 5112 159 VOUT_LNLDO4 112 SR_VBAT1A 5248 5112 160 AVDD2P5_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 109 | SR_PVSS1 | 5872.985 | 5331.4 | 156 VOUT_LNLDO2 |
| 111 SR_PVSS2 4998 5112 159 VOUT_LNLD04 112 SR_VBAT1A 5248 5112 160 AVDD2P5_LD0 113 SR_VLX1 5498 5112 161 AVSS2_LD0 114 SR_PVSS1 5748 5112 162 VREF_LD0 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 110 | SH_VSSPLDO | 6122.985 | 5331.4 | 158 VIN_LNLDO4 |
| 112 SR_VBAT1A 5248 5112 160 AVDD2P5_LDO 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 111 | SR_PVSS2 | 4998 | 5112 | 159 VOUT_LNLDO4 |
| 113 SR_VLX1 5498 5112 161 AVSS2_LDO 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 112 | SR_VBAF1A | 5248 | 5112 | 160 AVDD2P5_LDO |
| 114 SR_PVSS1 5748 5112 162 VREF_LDO 115 SR_TESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 113 | SH_VLX1 | 5498 | 5112 | 161 AVSS2_LDO |
| 115 SR_IESTSWG 5998 5112 163 packageoption_0 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 114 | SR_PVSS1 | 5748 | 5112 | 162 VREF_LDO |
| 116 SR_AVDD2P5 6248 5112 164 rf_sw_ctrl_n_0 | 115 | SR_TESTSWG | 5998 | 5112 | 163 packageoption_0 |
| | 116 | SR_AVDD2P5 | 6248 | 5112 | 164 rf_sw_ctrl_n_0 |



Preliminary Data Sheet

6/30/09

| Pin # | # Signal Name | X-Coord | Y-Coord | Pin | # Signal Name | X-Coord | Y-Coord |
|-------|---------------------|---------|---------|-----|----------------|---------|---------|
| 165 | VDDIO_RF | 4075 | 5400 | 211 | VDD | 4025 | 3650 |
| 166 | test_se | 4325 | 5400 | 212 | VSS | 4275 | 3650 |
| 167 | packageoption_1 | 3325 | 5150 | 213 | WL_GPIO_0 | 4525 | 3650 |
| 168 | rf_sw_ctrl_p_0 | 3575 | 5150 | 214 | sflash_d | 4775 | 3650 |
| 169 | wrf_afe_digit_test1 | 3825 | 5150 | 215 | ercx_rf_active | 5025 | 3650 |
| 170 | rf_sw_ctrl_p_2 | 4075 | 5150 | 216 | VDDIO | 3775 | 3400 |
| 171 | tdo | 4325 | 5150 | 217 | VDD | 4025 | 3400 |
| 172 | jtag_trst_n | 4575 | 5150 | 218 | VSS | 4275 | 3400 |
| 173 | packageoption_2 | 3325 | 4900 | 219 | ercx_tx_freq | 4525 | 3400 |
| 174 | rf_sw_ctrl_n_1 | 3575 | 4900 | 220 | VDD | 4775 | 3400 |
| 175 | gmode_ext_Ina_gain | 3825 | 4900 | 221 | VDD | 5025 | 3400 |
| 176 | rf_sw_ctrl_n_2 | 4075 | 4900 | 222 | VSS | 4025 | 3150 |
| 177 | tap_sel | 4325 | 4900 | 223 | VDDIO | 4275 | 3150 |
| 178 | WL_RST_N | 4575 | 4900 | 224 | WL_GPIO_13 | 4525 | 3150 |
| 179 | packageoption_3 | 3325 | 4650 | 225 | WL_GPIO_7 | 4775 | 3150 |
| 180 | wrf_disable_n | 3575 | 4650 | 226 | VDDIO | 5025 | 3150 |
| 181 | rf_sw_ctrl_p_1 | 3825 | 4650 | 227 | VDDIO | 5275 | 3150 |
| 182 | amode_tx_pu | 4075 | 4650 | 228 | sflash_c | 5525 | 3150 |
| 183 | lv_testmode | 4325 | 4650 | 229 | sflash_s | 5775 | 3150 |
| 184 | tck | 4575 | 4650 | 230 | ercx_txconf | 6025 | 3150 |
| 185 | VDDIO_RF | 3275 | 4150 | 231 | BT_VDDO | 3025 | 2900 |
| 186 | gmode_rx_pu | 3525 | 4400 | 232 | VDD | 3775 | 2900 |
| 187 | gmode_tx_pu | 3775 | 4400 | 233 | sprom_din | 4275 | 2900 |
| 188 | amode_ext_Ina_gain | 4025 | 4400 | 234 | otp_vdd25 | 4525 | 2900 |
| 189 | rf_sw_ctrl_n_3 | 4275 | 4400 | 235 | WL_GPIO_14 | 4775 | 2900 |
| 190 | tdi | 4525 | 4400 | 236 | WL_GPIO_9 | 5025 | 2900 |
| 191 | tms | 4775 | 4400 | 237 | WL_GPIO_5 | 5275 | 2900 |
| 192 | VSS | 5025 | 4400 | 238 | WL_GPIO_4 | 5525 | 2900 |
| 193 | VDDIO_RF | 3525 | 4150 | 239 | WL_GPIO_2 | 5775 | 2900 |
| 194 | VDDIO_RF | 3775 | 4150 | 240 | WL_GPIO_1 | 6025 | 2900 |
| 195 | wrf_afe_digit_test2 | 4025 | 4150 | 241 | BT_VSSC_0 | 3025 | 2650 |
| 196 | amode_rx_pu | 4275 | 4150 | 242 | BT_VDDO | 3275 | 2650 |
| 197 | rf_sw_ctrl_p_3 | 4525 | 4150 | 243 | BT_VDDO | 3525 | 2650 |
| 198 | VDDIO_RF | 4775 | 4150 | 244 | VDD | 3775 | 2650 |
| 199 | ercx_prisel | 5025 | 4150 | 245 | VSS | 4025 | 2650 |
| 200 | VDD | 3275 | 3900 | 246 | sprom_cs | 4275 | 2650 |
| 201 | VDD | 3525 | 3900 | 247 | wl_uart_rx0 | 5025 | 2650 |
| 202 | VDD | 3775 | 3900 | 248 | WL_GPIO_12 | 5275 | 2650 |
| 203 | VDD | 4025 | 3900 | 249 | WL_GPIO_10 | 5525 | 2650 |
| 204 | VSS | 4275 | 3900 | 250 | WL_GPIO_8 | 5775 | 2650 |
| 205 | VDDIO_RF | 4525 | 3900 | 251 | WL_GPIO_6 | 6025 | 2650 |
| 206 | sflash_q | 4775 | 3900 | 252 | BT_GPIO_1 | 3025 | 2400 |
| 207 | ercx_status | 5025 | 3900 | 253 | BT_VSSC_0 | 3275 | 2400 |
| 208 | VSS | 3275 | 3650 | 254 | BT_VSSC_0 | 3525 | 2400 |
| 209 | VSS | 3525 | 3650 | 255 | BT_VSSC_0 | 3775 | 2400 |
| 210 | VDDIO | 3775 | 3650 | 256 | VSS | 4025 | 2400 |

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| Pin # | Signal Name | X-Coord | Y-Coord |
|-------|---------------------|---------|---------|
| 257 | VDDIO SD | 4525 | 2400 |
| 259 | wl uart tx0 | 5275 | 2400 |
| 260 | wl uart tx1 | 5525 | 2400 |
| 261 | WI GPIO 15 | 5775 | 2400 |
| 262 | WL_GPI0_11 | 6025 | 2400 |
| 263 | BT XA 18 | 2525 | 2150 |
| 264 | | 2775 | 2150 |
| 265 | BT_XA 17 | 3025 | 2150 |
| 266 | | 3275 | 2150 |
| 267 | | 3525 | 2150 |
| 268 | | 3775 | 2150 |
| 260 | | 4025 | 2150 |
| 203 | | 4025 | 2150 |
| 271 | | 4525 | 2150 |
| 270 | | 4775 | 2150 |
| 212 | WRE AFE DIGIT TEETO | 5025 | 2150 |
| 273 | vtal pu | 5775 | 2150 |
| 275 | will upt rv1 | 6025 | 2150 |
| 275 | | 2075 | 1000 |
| 270 | | 3273 | 1900 |
| 277 | | 2775 | 1900 |
| 2/0 | | 3775 | 1900 |
| 279 | | 4025 | 1900 |
| 280 | | 4275 | 1900 |
| 281 | | 4525 | 1900 |
| 284 | SDIO_DATA_0 | 5275 | 1900 |
| 285 | SDIU_ULK | 5525 | 1900 |
| 286 | sprom_cik | 5//5 | 1900 |
| 287 | sprom_dout | 6025 | 1900 |
| 288 | BI_IM1 | 3275 | 1650 |
| 289 | BI_XA_3 | 3525 | 1650 |
| 290 | BI_XA_8 | 3775 | 1650 |
| 291 | BI_UARI_RIS_N | 4025 | 1650 |
| 292 | BT_XD_2 | 4275 | 1650 |
| 293 | BT_XD_4 | 4525 | 1650 |
| 294 | BT_XD_9 | 4775 | 1650 |
| 296 | VDDIO_SD | 5275 | 1650 |
| 297 | VDDIO_SD | 5525 | 1650 |
| 298 | BT_GPIO_2 | 3275 | 1400 |
| 299 | BT_XA_1 | 3525 | 1400 |
| 300 | BT_COEX_OUT1 | 3775 | 1400 |
| 301 | BT_XA_12 | 4025 | 1400 |
| 302 | BT_PCM_OUT | 4275 | 1400 |
| 303 | BT_SDA | 4525 | 1400 |
| 304 | BT_XD_8 | 4775 | 1400 |
| 305 | BT_XD_10 | 5025 | 1400 |
| 306 | VDD | 6000 | 1400 |

| Pin # | Signal Name | X-Coord | Y-Coord |
|-------|---------------|---------|---------|
| 308 | BT XCS N | 3255 | 1150 |
| 309 | BT_TM0 | 3505 | 1150 |
| 310 | BT_XA_5 | 3755 | 1150 |
| 311 | BT_XA_9 | 4005 | 1150 |
| 312 | BT_XA_13 | 4255 | 1150 |
| 313 | BT_XD_1 | 4505 | 1150 |
| 314 | BT_XD_7 | 4755 | 1150 |
| 315 | BT_XD_13 | 5005 | 1150 |
| 316 | BT_TM2 | 3255 | 900 |
| 317 | BT_XA_2 | 3505 | 900 |
| 318 | BT_GPIO_6 | 3755 | 900 |
| 319 | BT_GPIO_3 | 4005 | 900 |
| 320 | BT_VDDC | 4255 | 900 |
| 321 | BT_UART_TXD | 4505 | 900 |
| 322 | BT_VSSC_0 | 4755 | 900 |
| 323 | BT_VSSC_0 | 5005 | 900 |
| 324 | BT_XWE_N | 3255 | 650 |
| 325 | BT_TM6 | 3505 | 650 |
| 326 | BT_XA_6 | 3755 | 650 |
| 327 | BT_XA_10 | 4005 | 650 |
| 328 | BT_PCM_SYNC | 4255 | 650 |
| 329 | BT_XA_16 | 4505 | 650 |
| 330 | BT_VDDC | 4755 | 650 |
| 331 | BT_XD_12 | 5005 | 650 |
| 332 | BT_XA_4 | 3525 | 400 |
| 333 | BT_GPIO_5 | 3775 | 400 |
| 334 | BT_XA_11 | 4025 | 400 |
| 335 | BT_XA_14 | 4275 | 400 |
| 336 | BT_SCL | 4525 | 400 |
| 337 | BT_XD_6 | 4775 | 400 |
| 338 | BT_VDDO | 5025 | 400 |
| 339 | BT_GPIO_7 | 3525 | 150 |
| 340 | BT_GPIO_4 | 3775 | 150 |
| 341 | BT_PCM_IN | 4025 | 150 |
| 342 | BT_UART_CTS_N | 4275 | 150 |
| 343 | BT_XD_0 | 4525 | 150 |
| 344 | BT_XD_5 | 4775 | 150 |
| 345 | BT_XD_11 | 5025 | 150 |
| 346 | BT_XD_14 | 5275 | 150 |
| 347 | BT_XD_15 | 5525 | 240 |

Section 15: Signal Descriptions

196-BALL FBGA PACKAGE

| Ball Number | Signal Name | Туре | Description |
|----------------|-------------------|------|--|
| WLAN R | F | | |
| A12 | WRF_RFOUTP_G | 0 | WLAN 802.11g Internal Power Amplifier output (50Ω) |
| A14 | WRF_RFOUTP_A | 0 | WLAN 802.11a Internal Power Amplifier output (50Ω) |
| F14 | WRF_RFINP_G1 | I | WLAN 802.11g Internal LNA RX input (50Ω) |
| D14 | WRF_RFINP_A1 | I | WLAN 802.11a Internal LNA RX Positive input (100Ω) |
| G14 | WRF_RFINN_G1_XFMR | 0 | WLAN 802.11g RX transformer ground |
| E14 | WRF_RFINN_A1_XFMR | I | WLAN 802.11a Internal LNA RX Negative input (100Ω) |
| L11 | WRF_RES_EXT | I | Connect to external 15 k Ω resistor to ground |
| L12 | WRF_EXTREFIN | I | 32.768 kHz LPO clock input. Used for low-power mode timing |
| A10 | WRF_EXTCOUPLE_GIN | I | WLAN directional coupler input for 802.11g (50 Ω) |
| A9 | WRF_EXTCOUPLE_AIN | I | WLAN directional coupler input for 802.11a (50Ω) |
| E9 | WRF_AFE_TSSI_G | Ι | Transmit signal strength indicator for external 802.11g Power Amplifier |
| C10 | WRF_AFE_TSSI_A | I | Transmit signal strength indicator for external 802.11a Power Amplifier |
| A8 | WRF_DISABLE_N | I | Disables WLAN radio when low. |
| Integrate | ed LDOs | | |
| P1 | VREF_LDO | 0 | Vref bypass. Connect to external capacitor. |
| M1 | VOUT_LNLDO1 | 0 | 1.25V output for LNLDO1, 130 mA |
| P3 | VOUT_LNLDO2 | 0 | 1.25V output for LNLDO2, 80 mA. It can be programmed to output 2.5V after reset (LNLDO2 is OFF by default. Software can program it to 1.25V or 2.5V before enabling it). |
| MЗ | VIN_LNLDO1 | I | 1.5V input for LNLDO1, 130 mA. |
| | | | Note: If LNLDO1 is not used, this pin must be connected to ground. |
| N1 | VIN_LNLDO2 | I | 3.3V or 1.5V input (which could be the output of CBUCK), 80 mA current. |
| | | | <i>Note:</i> If LNLDO2 is not used, this pin must be connected to ground. |
| L1 | VOUT_CLDO | 0 | 1.25V output for CLDO, 200 mA |
| M2 | VIN_CLDO | Ι | 1.5V input for CLDO, 200 mA. |
| | | | Note: If CLDO is not used, this pin must be connected to ground. |

Table 8: 196-Ball FBGA Signal Descriptions

| Table 8: | 196-Ball FBGA | Signal Descriptions | (Cont.) |
|----------|---------------|---------------------|---------|
| | | | (|

| Ball Number | Signal Name | Туре | Description | |
|---------------------------------|-------------|------|---|--|
| Integrated Switching Regulators | | | | |
| G1 | SR_VOUTBB | 0 | Buck Boost Regulator. 3.3V output | |
| C1 | SR_VNLDO | 0 | NLDO Output. 220 nF external compensating capacitor | |
| F1 | SR_VLX2BB | 0 | Buck Boost Regulator. Inductor -ve terminal | |
| E1 | SR_VLX1BB | 0 | Buck Boost Regulator. Inductor +ve terminal | |
| A3 | SR_VLX1 | 0 | Core Buck Regulator. Output to inductor | |
| D1 | SR_VFBBB | Ι | Buck Boost Regulator. Voltage feedback. | |
| | | | Note: If not used, this pin should be connected to ground. | |
| A1 | SR_VFB1 | Ι | Core Buck Regulator. Output voltage feedback. | |
| | | | Note: This pin should be connected to ground if CBUCK is not used. | |
| E2 | SR_VBATBB | Ι | Buck Boost Regulator. Battery voltage Input. | |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply even if the BBOOST and CBUCK regulators are not used. | |
| A2 | SR_VBAT1B | Ι | Clean VBAT supply for LDOs and Bandgap. | |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. | |
| B3 | SR_VBAT1A | Ι | Core Buck Regulator. Battery voltage input. | |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. | |
| C2 | SR_TESTSWG | I/O | Connect to 2.5V VDD (which could be SR_AVDD2P5) with or without 0Ω stuffing option. | |
| F2 | SR_PVSSB | I | Buck Boost Regulator. Power Switch Ground | |
| C3 | SR_PVSS | I | Core Buck Regulator. Power Switch Ground | |
| D3 | SR_AVSS | Ι | Analog Ground | |
| B2 | SR_PLDO | 0 | PLDO Output. 220 nF external compensating capacitor | |
| B1 | SR_AVDD2P5 | 0 | 2.5V LDO Output | |
| N3 | AVDD2P5_LDO | I | 2.5V Supply for Internal LDO. Connect to SR_AVDD2P5 | |
| SDIO Bu | s Interface | | | |
| K4 | SDIO_CMD | I/O | SDIO Command Line. | |
| | | | See Table 18 on page 73 and Table 19 on page 74 for additional details. | |
| L2 | SDIO_DATA_0 | I/O | SDIO Data Line 0. | |
| | | | See Table 18 on page 73 and Table 19 on page 74 for additional details. | |
| H2 | SDIO_DATA_1 | I/O | SDIO Data Line 1. | |
| | | | See Table 18 on page 73 and Table 19 on page 74 for additional details. | |
| J3 | SDIO_DATA_2 | I/O | SDIO Data Line 2. | |
| | | | See Table 18 on page 73 and Table 19 on page 74 for additional details. | |
| P6 | SDIO_DATA_3 | I/O | SDIO Data Line 3. | |
| | | | See Table 18 on page 73 and Table 19 on page 74 for additional details. | |
| K1 | SDIO_CLK | Ι | SDIO Clock. | |
| | | | This is an input pin driven by the SDIO clock signal. It remains high impedance when WL_RST_N is low. See Table 18 on page 73 and Table 19 on page 74 for additional details. | |

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| | Table 8: 196-Ball FBGA Signal Descriptions (Cont.) | | | |
|----------------|--|------|---|--|
| Ball Number | Signal Name | Туре | Description | |
| WLAN U | ART | | | |
| J4 | WL_UART_TX0 | I/O | Serial output for WLAN UART. | |
| | | | Connect to RS-232 DTE for exchanging data with other serial devices. If not used, it may be left unconnected. | |
| H3 | WL_UART_RX0 | I/O | Serial Input for WLAN UART. | |
| | | | Connect to RS-232 DTE for exchanging data with other serial devices. If not used, it may be left unconnected. | |
| JTAG Int | terface (test only) | | | |
| D4 | TMS | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left unconnected (NC) as it has an internal pull-up resistor. | |
| C4 | TDO | 0 | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left NC. | |
| E5 | TDI | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left NC, as it has an internal pull-up resistor. | |
| F5 | ТСК | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left NC, as it has an internal pull-up resistor. | |
| E6 | TAP_SEL | I | WLAN JTAG Tap Select. | |
| | | | Drive low to connect the JTAG interface with the main tap controller; drive high to connect with the ARM tap controller. This pin has an internal pull-down. For normal operation, the pin can be left as a NC. | |
| B4 | JTAG_TRST_N | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left NC, as it has an internal pull-up resistor. | |
| SPROM | | | | |
| H1 | SPROM_DOUT | I/O | SPROM Data Out. | |
| | | | Must be connected to DIN signal of the SPROM. | |
| H8 | SPROM_DIN | I/O | SPROM Data In. | |
| | | | Must be connected to DOUT signal of the SPROM. | |
| J6 | SPROM_CS | I/O | SPROM Chip Select. | |
| | | | Must be connected to the chip select input of the SPROM (typically called CS). This pin has an internal pull-down. | |
| K3 | SPROM_CLK | I/O | SPROM Data Clock. | |
| | | | Must be connected to the serial clock input of the SPROM (typically called SK). | |



| Ball Number | Signal Name | Туре | Description |
|----------------|---------------------|------|---|
| RF Cont | rol Lines | | |
| A7 | RF_SW_CTRL_N_0 | I/O | RF Switch Control Line. |
| | | | Connect to the BT TX port of the front-end switch. |
| B6 | RF_SW_CTRL_N_1 | I/O | RF Switch Control Line. |
| | | | Connect to the WLAN TX port of the front-end switch. |
| A5 | RF_SW_CTRL_N_3 | I/O | Programmable RF switch control line |
| B7 | RF_SW_CTRL_P_0 | I/O | RF Switch Control Line. |
| | | | Connect to the RX port (for both WLAN and BT) of the front-end switch. |
| E7 | RF_SW_CTRL_P_1 | I/O | Programmable RF switch control line |
| B5 | RF_SW_CTRL_P_3 | I/O | Programmable RF switch control line |
| A6 | AMODE_TX_PU | I/O | 802.11a external PA control |
| F6 | AMODE_RX_PU | I/O | 802.11a external LNA power supply control |
| B8 | GMODE_TX_PU | I/O | 802.11g external PA control |
| C7 | WRF_AFE_DIGIT_TEST1 | I/O | BT/WLAN external LNA power up control |
| D6 | GMODE_EXT_LNA_GAIN | I/O | BT/WLAN external LNA gain control |
| WLAN G | PIO | | |
| G5 | WL_GPIO_0 | I/O | WLAN general purpose interface pins. |
| G3 | WL_GPIO_1 | _ | These pins ae high impedance on power up and reset. Subsequently, they |
| J2 | WL_GPIO_2 | _ | become an input or output under software control. These pins have a |
| G2 | WL_GPIO_6 | - | page 74 for additional details. |
| J5 | WL_GPIO_7 | _ | |
| FM Rece | eiver | | |
| P11 | FM_RXP | I | FM radio RF antenna port |
| P12 | FM_RXN | Ι | FM radio RF antenna port |
| M11 | FM_CVAR | Ι | Bypass node for FM VCO |
| M9 | FM_AUDIO_OUT2 | 0 | FM analog audio output channel 2 |
| M7 | FM_AUDIO_OUT1 | 0 | FM analog audio output channel 1 |
| External | Coexistence | | |
| H7 | ERCX_TX_FREQ | I | Transmit frequency overlap signal from the external radio. |
| | | | Used to indicate that the external radio is about to transmit on a restricted channel defined by the coexistence mechanism. |
| F3 | ERCX_STATUS | Ι | Coexistence Status from external radio. |
| | | | Used to signal external radio priority status and receive/transmit direction. |
| G4 | ERCX_RF_ACTIVE | Ι | Indicates external radio is active. This pin is asserted prior to an external radio transaction and remains active for the duration of the transaction. |

Table 8: 196-Ball FBGA Signal Descriptions (Cont.)

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| | Table 8: 196-Ball FBGA Signal Descriptions (Cont.) | | | | |
|----------------|--|------|--|--|--|
| Ball Number | Signal Name | Туре | Description | | |
| Bluetoo | th UART | | | | |
| P4 | BT_UART_TXD | 0 | Bluetooth UART Serial Output. Serial data output for the HCI UART Interface. | | |
| L7 | BT_UART_RXD | I | Bluetooth UART Series Input. Serial data input for the HCI UART Interface. | | |
| N6 | BT_UART_RTS_N | 0 | Bluetooth UART Request to Send. Active-low request to send signal for the HCI UART interface. | | |
| P5 | BT_UART_CTS_N | I | Bluetooth UART Clear to Send. Active-low clear to send signal for the HCI UART interface. | | |
| Bluetoo | th Test Mode | | | | |
| N8 | BT_TM0 | I | TM0 and TM1 are used for XTAL_PU polarity. | | |
| K9 | BT_TM1 | I | Valid settings are TM[1:0] = 00 for high assertion and 01 for low assertion. | | |
| | | | See XTAL_PU signal description for more details. | | |
| L8 | BT_TM2 | I | Bluetooth test mode pin | | |
| J8 | BT_TM6 | I | TM6 is pulled low for the 52-MHz Xtal or TCXO clock and pulled high for all other frequencies. | | |
| Bluetoo | th | | | | |
| L4 | BT_SDA | I/O | Bluetooth BSC data | | |
| N5 | BT_SCL | I/O | Bluetooth BSC clock | | |
| N9 | BT_RST_N | I | Low asserting reset for Bluetooth core. This pin must be driven high or low (not left floating). | | |
| | | | This pin needs 100 ms delay from BT_REG_ON or WL_REG_ON while the BCM4325 is powered up. See Section 22: "Power-Up Sequence and Timing" for more details. | | |
| K14 | BT_RFIOP | 0 | RF I/O Tuning Port. | | |
| | | | For Class 2 operation, connect directly to ground. Trace lengths from the ball to ground must be kept short (parasitic inductance < 0.5 nH). If trace lengths need to be longer due to board constraints, add 1.8 pF capacitor to GND. For Class 1 operation, connect to external PA input. | | |
| J14 | BT_RFION | 0 | RF I/O Antenna Port. | | |
| | | | For Class 2 operation, connect to antenna or BPF. For Class 1 operation, connect to T/R switch Receive pin. | | |
| E3 | BT_REG_ON | I | Used by PMU (along with WL_REG_ON) to decide whether or not to power down internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. BT_REG_ON needs about 70 μ s delay (approx. two 32 kHz clock cycles) after VBAT and VDDIO is up. See Section 22: "Power-Up Sequence and Timing" for details. | | |
| Bluetoo | th PCM | | | | |
| M5 | BT_PCM_SYNC | I/O | PCM sync signal, can be master (output) or slave (input) | | |
| L5 | BT_PCM_OUT | I/O | PCM data output | | |
| K5 | BT_PCM_IN | I/O | PCM data input | | |
| J7 | BT PCM CLK | I/O | PCM clock, can be master (output) or slave (input) | | |

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| Ball Number | Signal Name | Туре | Description | |
|----------------|-------------|------|---|---|
| Bluetoot | h GPIO | | | |
| J9 | BT_GPIO_0 | I/O | Bluetooth general purpose interface p | ins. |
| H9 | BT_GPIO_1 | - | These pins are high-impedance on pow | wer up and reset. Subsequently, they |
| K10 | BT_GPIO_2 | - | become an input or output through so | ftware control. See Table 15 on |
| M6 | BT_GPIO_3 | - | page of and Table 17 of page 71 for | more mornation. |
| K6 | BT_GPIO_4 | - | | |
| K7 | BT_GPIO_5 | - | | |
| L6 | BT_GPIO_6 | - | | |
| K8 | BT_GPIO_7 | - | | |
| Miscella | neous | | | |
| D2 | WL_REG_ON | Ι | This signal is used by PMU (along with not to power down the internal BCM4 WL_REG_ON are low, the regulators WL_RST_N is low (regardless of BT_I powered off. WL_REG_ON needs ab clock cycles) after VBAT and VDDIO i Sequence and Timing" for more detai | h BT_REG_ON) to decide whether or 325 regulators. If BT_REG_ON and will be disabled. Also note that if RST_N state), the WLAN core will be out 70 µs delay (approx. two 32 kHz is up. See Section 22: "Power-Up Is. |
| A4 | WL_RST_N | Ι | Low Asserting Reset for WLAN Core. (not left floating). See Section 22: "Po more details. | This pin must be driven high or low over-Up Sequence and Timing" for |
| P8 | OSCIN | Ι | XTAL oscillator input | |
| P9 | OSCOUT | 0 | XTAL oscillator output | |
| K2 | XTAL_PU | 0 | The BCM4325 asserts this signal whe crystal circuit/reference clock (e.g., TC | en it wants the host to turn on the CXO). |
| | | | The XTAL_PU assertion polarity is pro BT_TM1. If BT_TM0 and BT_TM1 co asserting (i.e., the BCM4325 drives X turned on). If TM0 connects to VDDIC XTAL_PU is low asserting. | ogrammable based on BT_TM0 and nnect to ground, XTAL_PU is high TAL_PU high when it wants the clock and BT_TM1 connects to ground, |
| Bluetoot | h Supplies | | | |
| M13 | BT_VDDVCO | I | 1.25V Bluetooth VCO power supply | |
| L14 | BT_VDDTF | I | Bluetooth internal PA power supply. | |
| | | | For Class3 Pout < 0 dBm: C | Connect it to 1.25V. |
| | | | For Class2 0 dBm < Pout<3 dBm: C | Connect it to 1.5V. |
| | | | For Class1 Pout > 3 dBm: C | Connect it to 2.5V. |
| K12 | BT_VDDRF | I | 1.25V Bluetooth RF power supply | |
| P14 | BT_VDDPLL | I | 1.25V Bluetooth PLL power supply | |
| G8 | BT_VDDO | Ι | Bluetooth digital I/O supply (1.8V to 3 | .3V) |
| N2 | | | | |
| L13 | BT_VDDIFIFP | Ι | 1.25V Bluetooth IF and IF PLL power | supply |
| J11 N4 | BT_VDDC | Ι | 1.25V Bluetooth baseband core suppl | ly |

Table 8: 196-Ball FBGA Signal Descriptions (Cont.)

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| | Table 8: 196-Ball FBGA Signal Descriptions (Cont.) | | | | |
|----------------|--|------|---|--|--|
| Ball Number | Signal Name | Туре | Description | | |
| WLAN S | upplies | | | | |
| H12 | WRF_VDDVCO_1P2 | I | 1.25V supply for WLAN PLL | | |
| D12 | WRF_VDDTX_1P2 | Ι | 1.25V supply for WLAN transmitters | | |
| E13 | WRF_VDDRX_1P2 | I | 1.25V supply tor WLAN receivers | | |
| H13 | WRF_VDDPFDCP_1P2 | Ι | 1.25V supply for WLAN PLL | | |
| A11 | WRF_VDDPAG_3P3 | I | 3.3V for the internal power amplifiers | | |
| B13 | WRF_VDDPAA_3P3 | I | 3.3V for the internal power amplifiers | | |
| G12 | WRF_VDDLO_1P2 | I | 1.25V supply for WLAN LO generator | | |
| J12 | WRF_VDDD_1P2 | I | 1.25V supply for WLAN PLL | | |
| J13 | WRF_VDDCAB_1P2 | I | 1.25V supply for WLAN CAB | | |
| K11 | WRF_VDDA_1P2 | I | 1.25V supply for WLAN PLL | | |
| E10 | WRF_BBPLL_VDD_1P2 | I | 1.25V supply for WLAN Baseband PLL | | |
| D7 | WRF_AFE_AVDD_TXDAC | I | 1.25V supply for DAC | | |
| B9 | WRF_AFE_AVDD_RXADC | I | 1.25V supply for ADC | | |
| D10 | WRF_AFE_AVDD_AUX | I | 1.25V supply for AUX ADC | | |
| Miscella | neous Supplies | | | | |
| J1 | VDDIO_SD | I | SDIO I/O supply (1.8V to 3.3V) | | |
| L3 | | | | | |
| C6 | VDDIO_RF | I | RF I/O supply (1.8V to 3.3V) | | |
| F10 | | | | | |
| F9 | VDDIO_RF | Ι | RF I/O supply (1.8V to 3.3V) | | |
| H6 | VDDIO | Ι | Digital I/O supply (1.8V to 3.3V) | | |
| F4 | | | | | |
| G6 | | | | | |
| G9 | VDDC | Ι | 1.25V digital supply for core | | |
| H10 | | | | | |
| H4 | | | | | |
| L10 | VDD_XTAL | | 1.25V XTAL Power Supply | | |
| H5 | OTP_VDD25 | I | 2.5V OTP Power Supply | | |
| FM Rece | eiver Supplies | | | | |
| M8 | FM_ADVDD | I | 1.25V FM supply | | |
| M10 | FM_VDDVCO | Ι | 1.25V FM receiver VCO power supply | | |
| P10 | FM_VDDRF | Ι | 1.25V FM receiver RF power supply | | |
| N10 | FM_VDDPLL | Ι | 1.25V FM receiver PLL power supply | | |
| P13 | FM_VDDIF | I | 1.25V FM receiver IF block power supply | | |



| Ball Number | Signal Name | Туре | Description |
|----------------|-------------|------|--------------------------------------|
| Ground | | | |
| E4 | VSS | Ι | Ground |
| E8 | | | |
| F8 | | | |
| G7 | | | |
| L9 | FM_ADVSS | I | Ground |
| K13 | BTFM_VSS | I | Ground |
| M12 | | | |
| M14 | | | |
| N11 | | | |
| N14 | | | |
| J10 | BT_VSSC_0 | I | Ground |
| M4 | | | |
| P2 | AVSS1_LDO | I | Ground |
| A13 | AVSS | I | Ground |
| B11 | | | |
| B12 | | | |
| B14 | | | |
| C11 | | | |
| C12 | | | |
| C13 | | | |
| C14 | | | |
| D13 | | | |
| F12 | | | |
| G13 | | | |
| H14 | | | |
| G10 | | | |
| D5 | LV_TESTMODE | Ι | Connect to Ground |
| C5 | TEST_SE | I | Scan enable input. Connect to Ground |

Table 8: 196-Ball FBGA Signal Descriptions (Cont.)

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| Table 8: 196-Ball FBGA Signal Descriptions (Cont.) | | | | |
|--|--------------------|------|-------------|--|
| Ball Number | Signal Name | Туре | Description | |
| No Conn | ect | | | |
| H11 | WRF_GPIO_OUT2 | 0 | No Connect | |
| G11 | WRF_GPIO_OUT1 | 0 | No Connect | |
| F13 | WRF_PA_100UA | 0 | No Connect | |
| E11 | WRF_AFE_TEST_QP | I | No Connect | |
| F11 | WRF_AFE_TEST_QN | Ι | No Connect | |
| D9 | WRF_AFE_TEST_OPQ | 0 | No Connect | |
| C8 | WRF_AFE_TEST_OPI | 0 | No Connect | |
| D8 | WRF_AFE_TEST_ONQ | 0 | No Connect | |
| C9 | WRF_AFE_TEST_ONI | 0 | No Connect | |
| D11 | WRF_AFE_TEST_IP | Ι | No Connect | |
| B10 | WRF_AFE_TEST_IN | Ι | No Connect | |
| E12 | WRF_AFE_IQADC_VREF | 0 | No Connect | |
| F7 | GMODE_RX_PU | I/O | No connect | |
| P7 | BT_COEX_OUT1 | I/O | No Connect | |
| N7 | BT_COEX_OUT0 | I/O | No Connect | |
| N12 | N/C | 0 | No Connect | |
| N13 | N/C | 0 | No Connect | |

Not Recommended for New Designs

339-PIN WLCSP PACKAGE

Table 9: 339-Pin WLCSP Signal Descriptions

| Pin # | Signal Name | Туре | Description | | |
|-------|------------------------|------|--|--|--|
| WLAI | WLAN RF | | | | |
| 14 | WRF_GNDPAA_3P3 | I | Internal power amplifier ground | | |
| 16 | WRF_GNDPAA_3P3 | I | Internal power amplifier ground | | |
| 17 | WRF_GNDPAG_3P3 | Ι | Internal power amplifier ground | | |
| 18 | WRF_GNDPAG_3P3 | Ι | Internal power amplifier ground | | |
| 15 | WRF_GNDTX_1P2 | I | Radio transmitter ground | | |
| 2 | WRF_RFOUTN_A | 0 | A-band PA transformer primary side ground (need short and solid ground). | | |
| 5 | WRF_RFOUTP_A | 0 | WLAN 802.11a Internal Power Amplifier output (50Ω) | | |
| 6 | WRF_RFOUTN_G | 0 | G-band PA transformer primary side ground (need short and solid ground). | | |
| 9 | WRF_RFOUTP_G | 0 | WLAN 802.11g Internal Power Amplifier output (50Ω) | | |
| 10 | WRF_AFE_PAD_AVSS_RXADC | Ι | ADC Ground | | |
| 12 | WRF_AFE_PAD_AVSS_TXDAC | Ι | DAC Ground | | |
| 23 | WRF_AFE_TSSI_A | Ι | Transmit signal strength indicator for external 802.11a Power Amplifier | | |
| 26 | WRF_RFINN_A2_XFMR | 0 | Ground of the primary side of the A-band RX transformer #2. Need short and solid ground | | |
| 30 | WRF_AFE_TSSI_G | Ι | Transmit signal strength indicator for external 802.11g Power Amplifier | | |
| 31 | WRF_RFINP_A2 | I | WLAN 802.11a Internal LNA #2 RX input (50Ω) | | |
| 32 | WRF_EXTCOUPLE_AIN | I | WLAN directional coupler input for 802.11a (50Ω) | | |
| 36 | WRF_RFINP_A1 | I | WLAN 802.11a Internal LNA RX Positive input (100Ω) | | |
| 37 | WRF_EXTCOUPLE_GIN | I | WLAN directional coupler input for 802.11g (50Ω) | | |
| 38 | WRF_BBPLL_GND_1P2 | I | WLAN Baseband PLL Ground | | |
| 39 | WRF_GNDLO_1P2 | I | WLAN LO Generator Ground | | |
| 40 | WRF_RFINN_A1_XFMR | Ι | WLAN 802.11a Internal LNA RX Negative input (100 Ω) | | |
| 42 | WRF_GNDRX_1P2 | Ι | WLAN RX Ground | | |
| 46 | WRF_RFINN_G2_XFMR | 0 | Ground of the primary side of the G-band RX transformer #2. Need short and solid ground | | |
| 48 | WRF_RFINP_G2 | Ι | WLAN 802.11g Internal LNA #2 RX input (50 Ω) | | |
| 49 | WRF_RFINP_G1 | Ι | WLAN 802.11g and BT Shared LNA RX input (50 Ω) | | |
| 51 | WRF_GNDVCO_1P2 | Ι | WLAN PLL Ground | | |
| 52 | WRF_RFINN_G1_XFMR | 0 | Ground of the primary side of the Shared RX transformer. Need short and solid ground | | |
| 53 | WRF_GNDD_1P2 | I | WLAN PLL Ground | | |
| 55 | WRF_GNDPFDCP_1P2 | Ι | WLAN PLL Ground | | |
| 57 | WRF_GNDA_1P2 | Ι | WLAN PLL Ground | | |
| 60 | WRF_GNDCAB_1P2 | Ι | WLAN CAB Ground | | |
| 61 | WRF_EXTREFIN | Ι | 32.768 kHz LPO clock input. Used for low-power mode timing. This pin needs be driven high or low (not left floating). | | |
| 62 | WRF_RES_EXT | Ι | Connect to external 15 k Ω (1% tolerance) resistor to ground. | | |
| 180 | WRF_DISABLE_N | Ι | Disables WLAN radio when low | | |
| 178 | WL_RST_N | Ι | Low asserting reset for WLAN core. This pin must be driven high or low (not left floating). See Section 22: "Power-Up Sequence and Timing". | | |



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| | · · · · · · · · · · · · · · · · · · · | | | | |
|--------|---------------------------------------|------|--|--|--|
| Pin # | Signal Name | Туре | Description | | |
| Integr | rated LDOs | | | | |
| 145 | VIN_CLDO | I | 1.5V input for CLDO, 200 mA | | |
| 146 | | | Note: If CLDO is not used, these pins must be connected to ground. | | |
| 147 | VOUT_CLDO | 0 | 1.25V output for CLDO, 200 mA | | |
| 148 | | | | | |
| 149 | VIN_LNLDO1 | I | 1.5V input for LNLDO1, 130 mA | | |
| 150 | | | <i>Note:</i> If LNLDO1 is not used, these pins must be connected to ground. | | |
| 155 | VIN_LNLDO2 | I | 3.3V or 1.5V input (which could be the output of CBUCK), 80 mA current. | | |
| | | | <i>Note:</i> If LNLDO2 is not used, this pin must be connected to ground. | | |
| 158 | VIN_LNLDO4 | I | 1.5V/3.3V Programmable input for LNLDO4 | | |
| | | | <i>Note:</i> If LNLDO4 is not used, this pin must be connected to ground. | | |
| 151 | VOUT_LNLDO1 | 0 | 1.25V output for LNLDO1, 130 mA | | |
| 152 | | | | | |
| 156 | VOUT_LNLDO2 | 0 | 1.25V output for LNLDO2, 80 mA. It can be programmed to output 2.5V after reset (LNLDO2 is off by default. Software can program it to 1.25V or | | |
| | | | 2.5V before enabling it). | | |
| 159 | VOUT_LNLDO4 | 0 | 1.25V/2.5V programmable output for LNLDO4, 80 mA | | |
| 160 | AVDD2P5_LDO | | 2.5V supply for internal LDO. Connect to SR_AVDD2P5 | | |
| 162 | VREF_LDO | 0 | Vref bypass. Connect to external capacitor. | | |
| 153 | AVSS1_LDO | | Ground | | |
| 161 | AVSS2_LDO | I | Ground for band-gap reference | | |
| Integr | ated Switching Regulators | | | | |
| 101 | SR_VLX1 | 0 | Core buck regulator: Output to inductor | | |
| 108 | | | | | |
| 113 | SR_VLX1 | 0 | Core buck regulator: Output to inductor | | |
| 100 | SR_VBAT1A | Ι | Core buck regulator: Shared battery voltage input | | |
| 107 | | | <i>Note:</i> These pins must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. | | |
| 102 | SR_PVSS1 | I | Core buck regulator: Power switch ground | | |
| 103 | SR_VFB1 | I | Core buck regulator: Output voltage feedback | | |
| | | | Note: This pin should be connected to ground if CBUCK is not used. | | |
| 104 | SR_VBAT1B | I | Clean VBAT supply for LDOs and Bandgap | | |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. | | |
| 109 | SR_PVSS1 | | Core buck regulator: Power switch ground | | |
| 110 | SR_VSSPLDO | I | Tracks battery voltage: Connect to 220 nF external capacitor to battery | | |
| 112 | SR_VBAT1A | I | Core buck regulator: Shared battery voltage input | | |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. | | |
| 114 | SR_PVSS1 | I | Core buck regulator: Power switch ground | | |
| 115 | SR_TESTSWG | I/O | Connect to 2.5V VDD (which could be SR_AVDD2P5) with or without 0Ω stuffing option. | | |
| 116 | SR_AVDD2P5 | 0 | 2.5V LDO output | | |
| 117 | SR_AVSS | Ι | Analog Ground | | |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)

| Pin # | Signal Name | Туре | Description |
|------------|---------------|------|---|
| 118 | SR_VBAT1A | I | Core buck regulator: Shared battery voltage input |
| | | | <i>Note:</i> This pin must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. |
| 119 | SR_AVSS | Ι | Analog Ground |
| 120 | SR_VDDNLDO | 0 | NLDO output: Connect to 220 nF external to capacitor to ground |
| 122 | SR_VBATBB | I | Buck boost regulator: Battery voltage Input |
| 123 | | | <i>Note:</i> These pins must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. |
| 124 | SR_VFBBB | I | Buck boost regulator: Voltage feedback |
| | | | Note: This pin should be connected to ground if BBOOST is not used. |
| 126 | SR_VBATBB | I | Buck boost regulator: Battery voltage input |
| 127 128 | | | <i>Note:</i> These pins must be connected to VBAT (or an external 3.3V supply) even if the BBOOST and CBUCK regulators are not used. |
| 129 | SR_VLX1BB | 0 | Buck boost regulator: Inductor +ve terminal |
| 130 | | | · |
| 131 | | | |
| 132 | | | |
| 133 | SR_PVSSB | I | Buck boost regulator: Power switch ground |
| 134 | | | |
| 135 | | | |
| 136 | | | |
| 137 | SR_VLX2BB | 0 | Buck boost regulator: Inductor -ve terminal |
| 138 | | | |
| 139 | | | |
| 140 | | | |
| 141 | SR_VOUTBB | 0 | Buck boost regulator: 3.3V output |
| 142 | | | |
| 143 | | | |
| 144 | | | |
| SDIO | Bus Interface | | |
| 284 | SDIO_DATA_0 | I/O | SDIO Data Line 0. See Table 18 on page 73 and Table 19 on page 74 for more information. |
| 272 | SDIO_DATA_1 | I/O | SDIO Data Line 1. See Table 18 on page 73 and Table 19 on page 74 for more information. |
| 271 | SDIO_DATA_2 | I/O | SDIO Data Line 2. See Table 18 on page 73 and Table 19 on page 74 for more information. |
| 270 | SDIO_DATA_3 | I/O | SDIO Data Line 3. See Table 18 on page 73 and Table 19 on page 74 for more information. |
| 281 | SDIO_CMD | I/O | SDIO Command Line. See Table 18 on page 73 and Table 19 on page 74 for more information. |
| 285 | SDIO_CLK | Ι | SDIO Clock. See Table 18 on page 73 and Table 19 on page 74 for more information. |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)

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| | | Table 9: 339 | -Pin WLCSP Signal Descriptions (Cont.) |
|-------|-----------------------|--------------|--|
| Pin # | Signal Name | Туре | Description |
| WLAN | IUART | | |
| 247 | WL_UART_RX0 | I | Serial Input for WLAN UART. Connect to RS-232 DTE for exchanging data with other serial devices. If not used it may be left unconnected. |
| 259 | WL_UART_TX0 | I/O | Serial Output for WLAN UART. Connect to RS-232 DTE for exchanging data with other serial devices. If not used it may be left unconnected. |
| 260 | WL_UART_TX1 | I/O | Serial Output for second WLAN UART. Connect to RS-232 DTE for exchanging data with other serial devices. If not used it may be left unconnected. |
| 275 | WL_UART_RX1 | I | Serial Input for second WLAN UART. Connect to RS-232 DTE for exchanging data with other serial devices. If not used it may be left unconnected. |
| JTAG | Interface (test only) | | |
| 190 | TDI | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, these pins can be left unconnected (NC) as they have internal pull-up resistors. |
| 171 | TDO | 0 | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, this pin can be left NC. |
| 191 | TMS | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, these pins can be left NC as they have internal pull-up resistors. |
| 184 | ТСК | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, these pins can be left NC as they have internal pull-up resistors. |
| 172 | JTAG_TRST_N | I | For normal operation, connect as described in the JTAG specification (IEEE Std 1149.1). Otherwise, if JTAG is not used, these pins can be left NC as they have internal pull-up resistors. |
| 177 | TAP_SEL | I | WLAN JTAG tap select: Drive low to connect the JTAG interface with the main tap controller; drive high to connect with the ARM tap controller. This pin has an internal pull-down. For normal operation the pin can be left as NC. |
| SPRO | М | | |
| 233 | SPROM_DIN | I | SPROM Data In. Must be connected to DOUT signal of the SPROM. |
| 246 | SPROM_CS | I/O | SPROM Chip Select. Must be connected to the chip select input of the SPROM (typically called CS). This pin has an internal pull-down. |
| 286 | SPROM_CLK | I/O | SPROM Data Clock. Must be connected to the serial clock input of the SPROM (typically called SK). |
| 287 | SPROM_DOUT | I/O | SPROM Data Out. Must be connected to DIN signal of the SPROM. |
| SFLA | SH | | |
| 206 | SFLASH_Q | | Data input from serial flash (active low) |
| 214 | SFLASH_D | 0 | Output data to serial flash |
| 228 | SFLASH_C | 0 | Serial flash clock |
| 229 | SFLASH_S | 0 | Serial flash chip select (active low) |
| Pin # | Signal Name | Type | Description |
|-------|---------------------|------|--|
| RF Co | ontrol Lines | | |
| 168 | RF_SW_CTRL_P_0 | 0 | RF Switch Control Line. Connect to the RX port (for both WLAN and BT) of the front-end switch. |
| 181 | RF_SW_CTRL_P_1 | 0 | Programmable RF switch control line |
| 170 | RF_SW_CTRL_P_2 | 0 | Programmable RF switch control line |
| 197 | RF_SW_CTRL_P_3 | 0 | Programmable RF switch control line |
| 164 | RF_SW_CTRL_N_0 | 0 | RF switch control line. Connect to the BT TX port of the front-end switch. |
| 174 | RF_SW_CTRL_N_1 | 0 | RF switch control line. Connect to the WLAN TX port of the front-end switch. |
| 176 | RF_SW_CTRL_N_2 | 0 | Programmable RF switch control line |
| 189 | RF_SW_CTRL_N_3 | 0 | Programmable RF switch control line |
| 169 | WRF_AFE_DIGIT_TEST1 | I/O | BT/WLAN external LNA power up control |
| 182 | AMODE_TX_PU | 0 | 802.11a external PA control |
| 196 | AMODE_RX_PU | 0 | 802.11a external LNA power supply control |
| 188 | AMODE_EXT_LNA_GAIN | 0 | 802.11a external LNA gain control |
| 187 | GMODE_TX_PU | 0 | 802.11g external PA control |
| 175 | GMODE_EXT_LNA_GAIN | 0 | BT/WLAN external LNA gain control |
| WLAN | I GPIO | | |
| 213 | WL_GPIO_0 | I/O | WLAN general purpose interface pins. |
| 240 | WL_GPIO_1 | _ | These pins are high impedance on power up and reset. Subsequently, they |
| 239 | WL_GPIO_2 | | become an input or output under software control. Each pin has a |
| 238 | WL_GPIO_4 | | page 73 for more information. |
| 237 | WL_GPIO_5 | | |
| 251 | WL_GPIO_6 | | |
| 225 | WL_GPIO_7 | | |
| 250 | WL_GPIO_8 | | |
| 236 | WL_GPIO_9 | | |
| 249 | WL_GPIO_10 | | |
| 262 | WL_GPIO_11 | | |
| 248 | WL_GPIO_12 | | |
| 224 | WL_GPIO_13 | _ | |
| 235 | WL_GPIO_14 | | |
| 261 | WL_GPIO_15 | | |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)

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| Table 9. | 339-Pin | WI CSP | Signal Descri | ntions (Cont) |
|----------|---------|--------|---------------|----------------|
| 10010 01 | 0001.00 | 112001 | orginal booon | |

| PIN # | Signal Name | Туре | Description | |
|--------|-----------------|------|---|--|
| FM Re | eceiver | | | |
| 76 | FM_AUDIO_OUT1 | 0 | FM analog audio output channel 1 | |
| 75 | FM_AUDIO_OUT2 | 0 | FM analog audio output channel 2 | |
| 83 | FM_CVAR | Ι | Bypass node for FM VCO | |
| 90 | FM_RXN | I | FM radio RF antenna port | |
| 91 | FM_RXP | Ι | FM radio RF antenna port | |
| Exteri | nal Coexistence | | | |
| 199 | ERCX_PRISEL | 0 | External Radio Coexistence. Priority Select. | |
| 207 | ERCX_STATUS | Ι | Coexistence status from external radio. Used to signal external radio priority status and receive/transmit direction. | |
| 215 | ERCX_RF_ACTIVE | Ι | Indicates external radio is active. This pin is asserted prior to an external radio transaction and remains active for the duration of the transaction. | |
| 219 | ERCX_TX_FREQ | I | Transmit frequency overlap signal from the external radio. Used to indicate that the external radio is about to transmit on a restricted channel defined by the coexistence mechanism. | |
| 230 | ERCX_TXCONF | 0 | External Radio Coexistence. Transmit Confirmation. | |
| Blueto | ooth UART | | | |
| 269 | BT_UART_RXD | Ι | Bluetooth UART Serial Input. Serial data input for the HCI UART Interface. | |
| 321 | BT_UART_TXD | 0 | Bluetooth UART Serial Output. Serial data output for the HCI UART Interface. | |
| 342 | BT_UART_CTS_N | Ι | Bluetooth UART Clear to Send. Active-low clear to send signal for the HCI UART interface. | |
| 291 | BT_UART_RTS_N | 0 | Bluetooth UART Request to Send. Active-low request to send signal for the HCI UART interface. | |
| Bluete | ooth Test Mode | | | |
| 309 | BT_TM0 | I | M0 and TM1 are used for XTAL_PU polarity. Valid settings are TM[1:0] = | |
| 288 | BT_TM1 | Ι | O0 for high assertion; and 01 for low assertion. See XTAL_PU signal description for more details. | |
| 316 | BT_TM2 | I | Bluetooth test mode pin | |
| 325 | BT_TM6 | Ι | TM6 is pulled low for the 52 MHz Xtal or TCXO clock and pulled high for all other frequencies. | |
| Blueto | ooth | | | |
| 63 | BT_RFION | 0 | RF I/O antenna port. For Class 2 operation, connect to antenna or BPF. | |
| 66 | BT_RFIOP | 0 | RF I/O tuning port. For Class 2 operation, connect directly to ground. Trace lengths from the ball to ground must be kept short (parasitic inductance < 0.5 nH). If trace lengths need to be longer due to board constraints, add a 0.9pF capacitor to GND. | |
| 97 | BT_RST_N | Ι | Low asserting reset for Bluetooth core. This pin needs be driven high or low (not left floating). | |
| | | | This pin needs 100 ms delay from BT_REG_ON or WL_REG_ON while BCM4325 is powered up. See Section 22: "Power-Up Sequence and Timing" for more details. | |
| 336 | BT_SCL | I/O | Bluetooth BSC Clock | |
| 303 | BT_SDA | I/O | Bluetooth BSC Data | |
| 308 | BT_XCS_N | 0 | Active low chip select for external code space in Flash memory | |

| Pin # | Signal Name | Туре | Description |
|-------|-------------|------|--|
| 276 | BT_XOE_N | 0 | Active low output enable output for dataspace |
| 324 | BT_XWE_N | 0 | Active low write enable output for dataspace |
| 299 | BT_XA_1 | 0 | Address bit 1 for Bluetooth Flash ROM/External SRAM |
| 317 | BT_XA_2 | 0 | Address bit 2 for Bluetooth Flash ROM/External SRAM |
| 289 | BT_XA_3 | 0 | Address bit 3 for Bluetooth Flash ROM/External SRAM |
| 332 | BT_XA_4 | 0 | Address bit 4 for Bluetooth Flash ROM/External SRAM |
| 310 | BT_XA_5 | 0 | Address bit 5 for Bluetooth Flash ROM/External SRAM |
| 326 | BT_XA_6 | 0 | Address bit 6 for Bluetooth Flash ROM/External SRAM |
| 278 | BT_XA_7 | 0 | Address bit 7 for Bluetooth Flash ROM/External SRAM |
| 290 | BT_XA_8 | 0 | Address bit 8 for Bluetooth Flash ROM/External SRAM |
| 311 | BT_XA_9 | 0 | Address bit 9 for Bluetooth Flash ROM/External SRAM |
| 327 | BT_XA_10 | 0 | Address bit 10 for Bluetooth Flash ROM/External SRAM |
| 334 | BT_XA_11 | 0 | Address bit 11 for Bluetooth Flash ROM/External SRAM |
| 301 | BT_XA_12 | 0 | Address bit 12 for Bluetooth Flash ROM/External SRAM |
| 312 | BT_XA_13 | 0 | Address bit 13 for Bluetooth Flash ROM/External SRAM |
| 335 | BT_XA_14 | 0 | Address bit 14 for Bluetooth Flash ROM/External SRAM |
| 279 | BT_XA_15 | 0 | Address bit 15 for Bluetooth Flash ROM/External SRAM |
| 329 | BT_XA_16 | 0 | Address bit 16 for Bluetooth Flash ROM/External SRAM |
| 265 | BT_XA_17 | 0 | Address bit 17 for Bluetooth Flash ROM/External SRAM |
| 263 | BT_XA_18 | 0 | Address bit 18 for Bluetooth Flash ROM/External SRAM |
| 343 | BT_XD_0 | I/O | Bidirectional data bus bit 0 for Flash ROM |
| 313 | BT_XD_1 | I/O | Bidirectional data bus bit 1 for Flash ROM |
| 292 | BT_XD_2 | I/O | Bidirectional data bus bit 2 for Flash ROM |
| 280 | BT_XD_3 | I/O | Bidirectional data bus bit 3 for Flash ROM |
| 293 | BT_XD_4 | I/O | Bidirectional data bus bit 4 for Flash ROM |
| 344 | BT_XD_5 | I/O | Bidirectional data bus bit 5 for Flash ROM |
| 337 | BT_XD_6 | I/O | Bidirectional data bus bit 6 for Flash ROM |
| 314 | BT_XD_7 | I/O | Bidirectional data bus bit 7 for Flash ROM |
| 304 | BT_XD_8 | I/O | Bidirectional data bus bit 8 for Flash ROM |
| 294 | BT_XD_9 | I/O | Bidirectional data bus bit 9 for Flash ROM |
| 305 | BT_XD_10 | I/O | Bidirectional data bus bit 10 for Flash ROM |
| 345 | BT_XD_11 | I/O | Bidirectional data bus bit 11 for Flash ROM |
| 331 | BT_XD_12 | I/O | Bidirectional data bus bit 12 for Flash ROM |
| 315 | BT_XD_13 | I/O | Bidirectional data bus bit 13 for Flash ROM |
| 346 | BT_XD_14 | I/O | Bidirectional data bus bit 14 for Flash ROM |
| 347 | BT_XD_15 | I/O | Bidirectional data bus bit 15 for Flash ROM |
| 322 | BT_VSSC_0 | I | Ground |
| 323 | | | |



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| Pin # | Signal Name | Туре | Description |
|-------|-------------|------|---|
| Bluet | ooth PCM | | |
| 268 | BT_PCM_CLK | I/O | PCM clock, can be master (output) or slave (input). |
| 302 | BT_PCM_OUT | I/O | PCM data output |
| 341 | BT_PCM_IN | I/O | PCM data input |
| 328 | BT_PCM_SYNC | I/O | PCM sync signal, can be master (output) or slave (input). |
| Bluet | ooth GPIO | | |
| 264 | BT_GPIO_0 | I/O | Bluetooth general purpose interface pin. |
| 252 | BT_GPIO_1 | I/O | These pins are high-impedance on power up and reset. Subsequently, they |
| 298 | BT_GPIO_2 | I/O | become an input or output through software control. See Table 15 on |
| 319 | BT_GPIO_3 | I/O | -page 68 and Table 17 on page 71 for more information. |
| 340 | BT_GPIO_4 | I/O | - |
| 333 | BT_GPIO_5 | I/O | - |
| 318 | BT_GPIO_6 | I/O | - |
| 339 | BT_GPIO_7 | I/O | - |
| Misce | ellaneous | | |
| 95 | OSCIN | I | XTAL oscillator input |
| 96 | OSCOUT | 0 | XTAL oscillator output |
| 274 | XTAL_PU | 0 | The BCM4325 asserts this signal when it wants the host to turn on the crystal circuit/ reference clock like TCXO. Note that the XTAL_PU assertion polarity is programmable based on BT_TM0 and BT_TM1. If BT_TM0 and BT_TM1 connect to ground, XTAL_PU is high asserting (i.e., the BCM4325 drives XTAL_PU high when it wants the clock turned on). If TM0 connects to VDDIO and BT_TM1 connects to ground, XTAL_PU is low asserting. |
| 121 | WL_REG_ON | I | Used by PMU (along with BT_REG_ON) to decide whether or not to power down internal BCM4325 regulators. If both BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. Also note that if WL_RST_N is low (regardless of BT_RST_N state) the WLAN core will be powered off. WL_REG_ON needs about 70 μ s delay (approx. two 32-kHz clock cycles) after VBAT and VDDIO is up. See Section 22: "Power-Up Sequence and Timing". |
| 123 | BT_REG_ON | I | Used by PMU (along with WL_REG_ON) to decide whether or not to power down internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. BT_REG_ON needs about 70 µs delay (approx. two 32-kHz clock cycles) after VBAT and VDDIO is up. See Section 22: "Power-Up Sequence and Timing" for more details. |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)

| Pin # | Signal Name | Туре | Description |
|------------|--------------------|------|--|
| Bluet | ooth Supplies | | |
| 64 | BT_VDDRF | I | 1.25V Bluetooth RF power supply |
| 68 | BT_VDDTF | Ι | Bluetooth Internal PA power supply. |
| | | | For Class3 Pout < 0 dBm: Connect to 1.25V |
| | | | For Class2 0 dBm < Pout < 3 dBm: Connect to 1.5V |
| | | | For Class1 Pout > 3 dBm: Connect to 2.5V |
| 70 | BT_VDDIF | I | 1.25V Bluetooth IF block power supply |
| 73 | BT_VDDVCO | I | 1.25V Bluetooth VCO power supply |
| 77 | BT_VDDPLL | I | 1.25V Bluetooth PLL power supply |
| 231 | BT_VDDO | I | Bluetooth Digital I/O supply (from 1.8V to 3.3V) |
| 242 243 | BT_VDDO | Ι | Bluetooth Digital I/O supply (1.8V to 3.3V) |
| 266 | BT_VDDC | I | 1.25V Bluetooth baseband core supply |
| 267 | | | |
| 320 | | | |
| 338 | BT_VDDO | Ι | Bluetooth Digital I/O supply (1.8V to 3.3V) |
| 330 | BT_VDDC | I | 1.25V Bluetooth baseband core supply |
| WLAI | N Supplies | | |
| 3 | WRF_VDDPAA_3P3 | I | 3.3V for the internal power amplifiers |
| 4 | | | |
| 7 | WRF_VDDPAG_3P3 | Ι | 3.3V for the internal power amplifiers |
| 8 | | | |
| 11 | WRF_AFE_AVDD_RXADC | I | 1.25V supply for ADC |
| 13 | WRF_AFE_AVDD_TXDAC | I | 1.25V supply for DAC |
| 27 | WRF_VDDTX_1P2 | I | 1.25V supply for WLAN transmitters |
| 29 | WRF_AFE_AVDD_AUX | I | 1.25V supply for AUX ADC |
| 33 | WRF_BBPLL_VDD_1P2 | I | 1.25V supply for WLAN baseband PLL |
| 41 | WRF_VDDRX_1P2 | I | 1.25V supply tor WLAN receivers |
| 43 | WRF_VDDLO_1P2 | | 1.25V supply for WLAN LO generator |
| 50 | WRF_VDDVCO_1P2 | I | 1.25V supply for WLAN PLL |
| 54 | WRF_VDDD_1P2 | I | 1.25V supply for WLAN PLL |
| 56 | WRF_VDDPFDCP_1P2 | I | 1.25V supply for WLAN PLL |
| 58 | WRF_VDDA_1P2 | I | 1.25V supply for WLAN PLL |
| 59 | WRF_VDDCAB_1P2 | I | 1.25V supply for WLAN CAB |
| FM Re | eceiver Supplies | | |
| 72 | FM_ADVDD | I | 1.25V FM supply |
| 89 | FM_VDDIF | Ι | 1.25V FM receiver IF block power supply |
| 92 | FM_VDDRX | Ι | FM receiver power supply |
| 93 | FM_VDDVCO | Ι | 1.25V FM receiver VCO power supply |
| 94 | FM_VDDPLL | Ι | 1.25V FM receiver PLL power supply |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)



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| Pin # | Signal Name | Туре | Description |
|-------|-------------------|------|------------------------------------|
| Misce | llaneous Supplies | | |
| 86 | VDD_XTAL | I | 1.25V XTAL power supply |
| 200 | VDD | I | 1.25V digital supply |
| 201 | | | |
| 202 | | | |
| 203 | | | |
| 217 | | | |
| 220 | | | |
| 221 | | | |
| 232 | | | |
| 211 | | | |
| 244 | | | |
| 306 | | | |
| 210 | VDDIO | I | Digital I/O supply (1.8V to 3.3V) |
| 216 | | | |
| 223 | | | |
| 226 | | | |
| 227 | | | |
| 257 | VDDIO_SD | I | SDIO I/O supply (1.8V to 3.3V) |
| 296 | | | |
| 297 | | | |
| 185 | VDDIO_RF | I | RF I/O supply (1.8V to 3.3V) |
| 165 | | | |
| 193 | | | |
| 194 | | | |
| 205 | | | |
| 198 | | | |
| 234 | | 1 | |
| 167 | PAUKAGEUPTIUN_1 | ļ | Connect to VDDIO_RF (1.8V to 3.3V) |

| Table 9: | 339-Pin | WLCSP | Signal | Descriptions | (Cont.) |
|----------|---------|-------|--------|--------------|---------|
|----------|---------|-------|--------|--------------|---------|

| Pin # | Signal Name | Туре | Description |
|--------|-----------------|------|---------------------------------------|
| Ground | | | |
| 65 | BT_VSSRF | I | Bluetooth RF ground |
| 67 | BT_VSSPA | Ι | Bluetooth internal PA ground |
| 69 | BT_VSSIF | Ι | Bluetooth IF block ground |
| 71 | FM_ADVSS | I | Ground |
| 74 | FM_VSSVCO | Ι | FM receiver VCO ground |
| 78 | BT_VSSVCO | Ι | Bluetooth VCO ground |
| 79 | BT_VSSPLL | Ι | Bluetooth PLL ground |
| 82 | FM_VSSRX | Ι | FM receiver ground |
| 84 | FM_VSSPLL | Ι | FM receiver PLL ground |
| 85 | VSS_XTAL | Ι | XTAL ground |
| 88 | FM_VSSIF | Ι | FM IF block ground |
| 98 | SR_VFB2 | I | Connect to ground |
| 282 | Ground | I | Connect to ground |
| 204 | VSS | I | Ground |
| 245 | | | |
| 192 | | | |
| 179 | PACKAGEOPTION_3 | Ι | Connect to ground |
| 173 | PACKAGEOPTION_2 | Ι | Connect to ground |
| 208 | VSS | Ι | Ground |
| 209 | | | |
| 212 | | | |
| 218 | | | |
| 222 | | | |
| 253 | BT_VSSC_0 | I | Ground |
| 254 | | | |
| 255 | | | |
| 256 | VSS | Ι | Ground |
| 241 | BT_VSSC_0 | I | Ground |
| 163 | PACKAGEOPTION_0 | I | Connect to ground |
| 183 | LV_TESTMODE | I | Connect to ground |
| 166 | TEST_SE | Ι | Scan Enable Input. Connect to ground. |

Table 9: 339-Pin WLCSP Signal Descriptions (Cont.)

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| Pin # | Signal Name | Туре | Description |
|-------|---------------------|------|-------------|
| No Co | onnect | | |
| 19 | WRF_AFE_TEST_IN | I | No Connect |
| 20 | WRF_AFE_TEST_OPI | 0 | No Connect |
| 21 | WRF_AFE_TEST_ONQ | 0 | No Connect |
| 22 | WRF_AFE_TEST_IP | I | No Connect |
| 24 | WRF_AFE_TEST_ONI | 0 | No Connect |
| 25 | WRF_AFE_TEST_OPQ | 0 | No Connect |
| 28 | WRF_AFE_IQADC_VREF | 0 | No Connect |
| 34 | WRF_AFE_TEST_QP | I | No Connect |
| 35 | WRF_AFE_TEST_QN | I | No Connect |
| 44 | WRF_GPIO_OUT1 | 0 | No Connect |
| 45 | WRF_GPIO_OUT2 | 0 | No Connect |
| 47 | WRF_PA_100UA | 0 | No Connect |
| 80 | NO CONNECT (NC) | 0 | No Connect |
| 81 | | | |
| 87 | DUMMY_BUMP | N/A | No Connect |
| 99 | SR_VLX2 | 0 | No Connect |
| 106 | SR_VLX2 | 0 | No Connect |
| 186 | GMODE_RX_PU | 0 | No connect |
| 273 | WRF_AFE_DIGIT_TEST0 | I/O | No Connect |
| 195 | WRF_AFE_DIGIT_TEST2 | I/O | No Connect |
| 300 | BT_COEX_OUT1 | I/O | No Connect |
| 277 | BT_COEX_OUT0 | I/O | No Connect |

PIN VOLTAGE DOMAINS

| Signal | FBGA Pin# | WLCSP Pin # | Туре |
|---------------|-----------|-------------|------|
| BT_REG_ON | E3 | 121 | I |
| BT_GPIO_1 | H9 | 252 | I/O |
| BT_PCM_CLK | J7 | 268 | I/O |
| BT_TM6 | J8 | 325 | 1 |
| BT_GPIO_0 | J9 | 264 | I/O |
| BT_GPIO_2 | K10 | 298 | I/O |
| BT_PCM_IN | K5 | 341 | I/O |
| BT_GPIO_4 | K6 | 340 | I/O |
| BT_GPIO_5 | K7 | 333 | I/O |
| BT_GPIO_7 | K8 | 339 | I/O |
| BT_TM1 | K9 | 288 | 1 |
| BT_SDA | L4 | 303 | I/O |
| BT_PCM_OUT | L5 | 302 | I/O |
| BT_GPIO_6 | L6 | 318 | I/O |
| BT_TM0 | N8 | 309 | I |
| BT_TM2 | L8 | 316 | I |
| BT_PCM_SYNC | M5 | 328 | I/O |
| BT_GPIO_3 | M6 | 319 | I/O |
| BT_SCL | N5 | 336 | I/O |
| BT_UART_RTS_N | N6 | 291 | I/O |
| BT_COEX_OUT0 | N7 | 277 | I/O |
| BT_UART_RXD | L7 | 269 | I/O |
| BT_RST_N | N9 | 97 | I |
| BT_UART_TXD | P4 | 321 | I/O |
| BT_UART_CTS_N | P5 | 342 | I/O |
| BT_COEX_OUT1 | P7 | 300 | I/O |
| BT_XCS_N | _ | 308 | 0 |
| BT_XOE_N | _ | 276 | 0 |
| BT_XWE_N | _ | 324 | 0 |
| BT_XA[18:1] | _ | Note | 0 |
| BT_XD[15:0] | - | Note | I/O |



Note: For FBGA pin numbers see Table 8: "196-Ball FBGA Signal Descriptions," on page 43. Note: For WLCSP pin numbers, see Table 9: "339-Pin WLCSP Signal Descriptions," on page 52.

Table 11: VDDIO Domain (1.8V to 3.3V)

| Signal | FBGA Pin# | WLCSP Pin# | Туре |
|----------------|-----------|------------|------|
| WL_RST_N | A4 | 178 | l |
| WL_REG_ON | D2 | 125 | l |
| ERCX_STATUS | F3 | 207 | I/O |
| WL_GPIO_6 | G2 | 251 | I/O |
| WL_GPIO_1 | G3 | 240 | I/O |
| ERCX_RF_ACTIVE | G4 | 215 | I/O |
| WL_GPIO_0 | G5 | 213 | I/O |
| SPROM_DOUT | H1 | 287 | I/O |
| WL_UART_RX0 | H3 | 247 | I/O |
| ERCX_TX_FREQ | H7 | 219 | I/O |
| SPROM_DIN | H8 | 233 | I/O |
| WL_GPIO_2 | J2 | 239 | I/O |
| WL_UART_TX0 | J4 | 259 | I/O |
| WL_GPIO_7 | J5 | 225 | I/O |
| SPROM_CS | J6 | 246 | I/O |
| SPROM_CLK | K3 | 286 | I/O |
| WRF_EXTREFIN | K12 | 61 | I |
| XTAL_PU | K2 | 274 | 0 |
| WL_UART_TX1 | - | 260 | I/O |
| WL_UART_RX1 | - | 275 | I |
| SFLASH_Q | _ | 206 | I |
| SFLASH_D | - | 214 | 0 |
| SFLASH_C | - | 228 | 0 |
| SFLASH_S | _ | 229 | 0 |
| WL_GPIO_4 | - | 238 | I/O |
| WL_GPIO_5 | - | 237 | I/O |
| WL_GPIO_8 | - | 250 | I/O |
| WL_GPIO_9 | - | 236 | I/O |
| WL_GPIO_10 | - | 249 | I/O |
| WL_GPIO_11 | - | 262 | I/O |
| WL_GPIO_12 | - | 248 | I/O |
| WL_GPIO_13 | - | 224 | I/O |
| WL_GPIO_14 | _ | 235 | I/O |
| WL_GPIO_15 | - | 261 | I/O |
| ERCX_PRISEL | _ | 199 | 0 |
| ERCX_TXCONF | _ | 230 | 0 |

| Table 12: | VDDIO_ | RF Domain | (1.8V | to 3.3V) |
|-----------|--------|-----------|-------|----------|
|-----------|--------|-----------|-------|----------|

| Signal | FBGA Pin# | WLCSP Pin# | Туре |
|---------------------|-----------|------------|------|
| RF_SW_CTRL_N_3 | A5 | 189 | I/O |
| AMODE_TX_PU | A6 | 182 | I/O |
| RF_SW_CTRL_N_0 | A7 | 164 | I/O |
| WRF_DISABLE_N | A8 | 180 | I/O |
| JTAG_TRST_N | B4 | 172 | 1 |
| RF_SW_CTRL_P_3 | B5 | 197 | I/O |
| RF_SW_CTRL_N_1 | B6 | 174 | I/O |
| RF_SW_CTRL_P_0 | B7 | 168 | I/O |
| GMODE_TX_PU | B8 | 187 | I/O |
| TDO | C4 | 171 | I/O |
| TEST_SE | C5 | 166 | 1 |
| WRF_AFE_DIGIT_TEST1 | C7 | 169 | I/O |
| TMS | D4 | 191 | 1 |
| LV_TESTMODE | D5 | 183 | 1 |
| GMODE_EXT_LNA_GAIN | D6 | 175 | I/O |
| TDI | E5 | 190 | 1 |
| TAP_SEL | E6 | 177 | 1 |
| RF_SW_CTRL_P_1 | E7 | 181 | I/O |
| ТСК | F5 | 184 | 1 |
| AMODE_RX_PU | F6 | 196 | I/O |
| GMODE_RX_PU | F7 | 186 | I/O |
| RF_SW_CTRL_P_2 | - | 170 | 0 |
| RF_SW_CTRL_N_2 | _ | 176 | 0 |
| AMODE_EXT_LNA_GAIN | - | 188 | 0 |

Table 13: VDDIO_SD Domain (1.8V to 3.3V)

| | | | _ |
|---------------------|-----------|------------|------|
| Signal | FBGA Pin# | WLCSP Pin# | Туре |
| SDIO_CMD | K4 | 281 | I/O |
| SDIO_DATA_0 | L2 | 284 | I/O |
| SDIO_DATA_1 | H2 | 272 | I/O |
| SDIO_DATA_2 | J3 | 271 | I/O |
| SDIO_DATA_3 | P6 | 270 | I/O |
| SDIO_CLK | K1 | 285 | I/O |
| WRF_AFE_DIGIT_TEST0 | - | 273 | I/O |



WLAN GPIO SIGNALS AND STRAPPING OPTIONS

The pins listed in Table 14 are sampled at Power-On Reset (POR) to determine the various operating modes. Sampling occurs within a few milliseconds following an internal POR or deassertion of the external POR. After POR, each pin assumes the GPIO or alternative function specified in the signal descriptions table. Each strapping option pin has an internal pull-up (PU) or pull-down (PD) resistor that determines the default mode.

To change the mode, connect an external PU resistor to VDDIO or a PD resistor to GND, using a 10 kΩ resistor or less.



Note: Refer to the reference board schematics for more information.

| Pin Name | FBGA Pin # | WLCSP Pin # | Default | Function | Description |
|------------|---------------|---|---|-----------------------------|---|
| WL_GPIO_0 | G5 | 213 | - | GPIO | WL_GPIO[2:0] can be used to set out-of-band signals like |
| WL_GPIO_1 | G3 | 240 | - | GPIO | WL_WAKE_N, WL_HOST_WAKE_N, and WL_STANDBY. |
| WL_GPIO_2 | J2 | 239 | - | GPIO | - |
| WL_GPIO_4 | - | 238 | _ | GPIO | |
| WL_GPIO_5 | - | 237 | - | GPIO | - |
| WL_GPIO_6 | G2 | 251 | High | GPIO[7:6] ^a | [7:6] = 00: OTP powered ON, OTP source of Chip ID, CIS |
| WL_GPIO_7 | J5 | 225 | Low | - | source: Default |
| | | | | | [7:6] = 01: OTP powered ON, OTP source of Chip ID, CIS source: SROM |
| | | | | | [7:6] = 10: OTP powered ON, OTP source of Chip ID, CIS source: OTP |
| | | | | | [7:6] = 11: OTP powered OFF, default chip ID, CIS source: SROM |
| | | | | | [7:6] = ZZ: Same as 01: OTP powered, OTP source of Chip ID, CIS source SROM |
| WL_GPIO_8 | _ | 250 | High | Sets SDIO | 0: SDIO in reset, ARM held in reset. |
| | | | | and ARM | Z: Same as 1: SDIO active and ARM in reset |
| | | | | core status | 1: SDIO active and ARM in reset |
| WL_GPIO_9 | - | 236 | Low | Boot up status | [10:9] = 00: Default is set to boot from SRAM and ARM held in reset. |
| WL_GPIO_10 | _ | 249 | Low | - | [10:9] = 01: ARM running (out of reset), boot from ROM. |
| | | | | | [10:9] = 10: ARM running (out of reset), boot from flash. |
| | | | | | [10:9] = 11: invalid. |
| WL_GPIO_11 | _ | 262 | Low | Internal debug option | 0: Pin must be kept at 0 or Z |
| WL_GPIO_12 | - | 248 | Low | GPIO | - |
| WL_GPIO_13 | - | 224 | Low | Sets clock | 0: External clock |
| | | | | that can be | Z: Same as 0 |
| | | WLCSP Default Pin # 213 - GPIO 240 - GPIO 239 - GPIO 238 - GPIO 237 - GPIO 251 High GPIO[7:6] ^a 252 Low - 255 Low - (7:6] = 00: OTP powered ON, OTP source of Chip ID, 0 source: Default (7:6] = 10: OTP powered ON, OTP source of Chip ID, 0 source: SROM [7:6] = 10: OTP powered ON, OTP source of Chip ID, 0 source: OTP [7:6] = 10: OTP powered ON, OTP source of Chip ID, 0 source: OTP [7:6] = 10: OTP powered OFF, default chip ID, CIS sources SROM Sets SDIO 250 High Sets SDIO SDIO in reset, ARM held in reset. 236 Low Boot up SIO active and ARM in reset 236 Low Boot up [10:9] = 01: ARM running (out of reset), boot from RON [10:9] = 11: invalid. 249 Low - [10:9] = 01: ARM running (out of reset), boot from flash [10:9] = 11: invalid. 262 Low Internal debug option O: Pin must be kept at 0 or Z 248 L | 1: Internal 32 kHz LPO clock (this is only available in the WLCSP package) $% \left({{\left({{{\rm{T}}_{\rm{T}}} \right)}} \right)$ | | |

Table 14: WLAN GPIO Functions and Strapping Options

| Pin Name | FBGA Pin # | WLCSP Pin # | Default | Function | Description |
|------------|---------------|----------------|---------|------------------------------|---|
| WL_GPIO_14 | - | 235 | Low | Internal power up mode | [15:14] = 00: Chip powers up in the lowest power mode with all clock sources shut down except for the internal 32 kHz LPO clock that runs the PMU controller. |
| WL_GPIO_15 | _ | 261 | High | _ | [15:14] = 01: Chip powers up to ILP request. |
| | | | | | [15:14] = 10: Chip powers up with the crystal oscillator turned on (default). |
| | | | | | [15:14] = 11: Chip powers up with PLL turned on by default. |
| | | | | | [15:14] = ZZ: Same as 10 |

| Table 14: | WLAN GPIO | Functions and | Strapping | Options | (Cont.) |
|-----------|-----------|---------------|-----------|---------|---------|
|-----------|-----------|---------------|-----------|---------|---------|

b. WL_GPIO_3 does not exist.

BLUETOOTH GPIO SIGNALS

| Pin Name | FBGA Pin# | WLCSP Pin # | Туре | Description |
|--------------|-----------|-------------|------|--|
| BT_GPIO_0 | J9 | 264 | I/O | Commonly set as BT_WAKEUP |
| BT_GPIO_1 | H9 | 252 | I/O | Commonly set as HOST_WAKEUP |
| BT_GPIO_2 | K10 | 298 | I/O | GPIO |
| BT_GPIO_3 | M6 | 319 | I/O | GPIO |
| BT_GPIO_4 | K6 | 340 | I/O | GPIO |
| BT_GPIO_5 | K7 | 333 | I/O | GPIO |
| BT_GPIO_6 | L6 | 318 | I/O | GPIO |
| BT_GPIO_7 | K8 | 339 | I/O | GPIO |
| BT_PCM_IN | K5 | 314 | I | PCM data input |
| BT_PCM_OUT | L5 | 302 | 0 | PCM data output |
| BT_PCM_SYNC | M5 | 328 | I/O | PCM sync signal, can be master (output) or slave (input) |
| BT_PCM_CLK | J7 | 268 | I/O | PCM clock, can be master (output) or slave (input) |
| BT_SCL | N5 | 336 | I | BSC clock |
| BT_SDA | L4 | 303 | I/O | BSC bidirectional data |
| BT_COEX_OUT0 | N7 | 277 | 0 | BT_ACTIVITY |
| BT_COEX_OUT1 | P7 | 300 | 0 | BT_PRIORITY_AND_STATUS |

Table 15: BT GPIO Signals

| Signal Name | 196-Ball FBGA Ball # | 339-Pin WLCSP Pin # | Default Pin State | For No Connect |
|---------------------|----------------------|---------------------|-------------------|----------------|
| RF_SW_CTRL_N_3 | A5 | 189 | No Pull Control | - |
| AMODE_TX_PU | A6 | 182 | No Pull Control | _ |
| RF_SW_CTRL_N_0 | A7 | 164 | No Pull Control | _ |
| WRF_DISABLE_N | A8 | 180 | High | IPU |
| JTAG_TRST_N | B4 | 172 | High | IPU |
| RF_SW_CTRL_P_3 | B5 | 197 | No Pull Control | _ |
| RF_SW_CTRL_N_1 | B6 | 174 | No Pull Control | _ |
| RF_SW_CTRL_P_0 | B7 | 168 | No Pull Control | _ |
| GMODE_TX_PU | B8 | 187 | No Pull Control | _ |
| SR_TESTSWG | C2 | 115 | High | IPU |
| TDO | C4 | 171 | No Pull Control | _ |
| WRF_AFE_DIGIT_TEST1 | C7 | 169 | No Pull Control | _ |
| TMS | D4 | 191 | High | IPU |
| GMODE_EXT_LNA_GAIN | D6 | 175 | No Pull Control | _ |
| TDI | E5 | 190 | High | IPU |
| TAP_SEL | E6 | 177 | Low | IPD |
| RF_SW_CTRL_P_1 | E7 | 181 | No Pull Control | _ |
| ERCX_STATUS | F3 | 207 | No Pull Control | _ |
| ТСК | F5 | 184 | High | IPU |
| AMODE_RX_PU | F6 | 196 | No Pull Control | _ |
| GMODE_RX_PU | F7 | 186 | No Pull Control | _ |
| WL_GPIO_6 | G2 | 251 | High | _ |
| ERCX_RF_ACTIVE | G4 | 215 | Low | IPD |
| SPROM_DOUT | H1 | 287 | No Pull Control | _ |
| WL_UART_RX0 | H3 | 247 | High | IPU |
| ERCX_TX_FREQ | H7 | 219 | No Pull Control | _ |
| SPROM_DIN | H8 | 233 | No Pull Control | _ |
| WL_UART_TX0 | J4 | 259 | No Pull Control | _ |
| WL_GPIO_7 | J5 | 225 | Low | _ |
| SPROM_CS | J6 | 246 | Low | IPD |
| SDIO_CLK | K1 | 285 | No Pull Control | _ |
| SPROM_CLK | K3 | 286 | No Pull Control | - |
| WL_UART_TX1 | _ | 260 | No Pull Control | _ |
| WL_UART_RX1 | _ | 275 | High | IPU |
| SFLASH_Q | _ | 206 | No Pull Control | _ |
| SFLASH_C | - | 228 | No Pull Control | - |
| SFLASH_S | - | 229 | High | IPU |
| ERCX_TXCONF | - | 230 | No Pull Control | - |
| ERCX_PRISEL | _ | 199 | No Pull Control | _ |

Table 16: Pin Default Pull-Up/Pull-Down



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| | | | , | |
|------------------------------|-----------------------|---------------------|-------------------|----------------|
| Signal Name | 196-Ball FBGA Ball # | 339-Pin WLCSP Pin # | Default Pin State | For No Connect |
| RF_SW_CTRL_P_2 | _ | 170 | No Pull Control | _ |
| RF_SW_CTRL_N_2 | _ | 176 | No Pull Control | _ |
| AMODE_EXT_LNA_GAIN | - | 188 | No Pull Control | - |
| PACKAGEOPTION_0 | _ | 163 | No Pull Control | _ |
| PACKAGEOPTION_1 | - | 167 | No Pull Control | - |
| PACKAGEOPTION_2 | - | 173 | No Pull Control | - |
| PACKAGEOPTION_3 | - | 179 | No Pull Control | - |
| Note: No Connect: Internal P | ull Up/Down (IPU/IPD) | | | |



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INTERFACE I/O STATUS

| | | | | Table 1 | 7: BT/FM Interfac | e I/O Status | | | | | |
|----------------------------|--------|--------------------------------------|--|---|---|--------------|-------------------------|---------------------------------|------------------------|----------------------------------|--|
| Signal Name | 1/0 | On status | Low Power Status / Sleep (all | REG_ON Held LOW (WL and BT RST_N held | HW Default (REG_ON High, WL and PT_PST_N bigh; | Power rail | Interna Resist (0 | al Pull-Up tor Range ohm) | Interr Down Rang | nal Pull- Resistor e (ohm) | Comment |
| | | | supplies present) | LOW) ^a | no SW loaded) ^a | | 3.3V | 1.8V | 3.3V | 1.8V | |
| BT_GPIO_0, 1 3, 4, 6, 7 | 2, I/O | Programmable (In, Out, PD, PU) | Programmable (In, Out, PD, PU) | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Internal pull-up/down are programmable and can be enabled/disabled by S/W. |
| BT_GPIO_5 | I/O | Programmable (In, Out, PD, PU) | Programmable (In, Out, PD, PU) | No internal pull, disabled input | Output | BT_VDDO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Internal pull-up/down are programmable and can be enabled/disabled by S/W. |
| BT_UART_CT | S I | No internal pull | No internal pull, needs to be High Z | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | _ | - | _ | _ | - |
| BT_UART_RT | 6 0 | No internal pul | No internal pull, needs to be High Z | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Pull-up required which can be internal or external. This can be programmed |
| BT_UART_RX |) | No internal pull | No internal pull, needs to be driven low | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | _ | - | - | - | - |
| BT_UART_TXI | 0 (| No internal pul | l No internal pull, needs to be High Z | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Pull-up required which can be internal or external. This can be programmed |
| BT HOST_WA (BT_GPIO_0) | KE O | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Pull-up required which can be internal or external. This can be programmed. Note: the level on HOST WAKE should be ignored by the host during power-up. |
| BT WAKE (BT_GPIO_1) | I | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | - |
| BT_PCM_CLK | Ι | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | _ |
| BT_PCM_IN | I | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | _ |

| Signal Name | I/O | On status | Low Power Status / Sleep (all | REG_ON Held LOW (WL and BT RST N held | eld HW Default nd (REG_ON High, eld WL and | Power rail | Internal Pull-Up Resistor Range (ohm) | | Internal Pull- Down Resistor Range (ohm) | | Comment | |
|-------------|--------|--|--|---|--|-------------------|---|---------------|--|---------------|---------|--|
| | | | supplies present) | LOW) ^a | BT_RST_N high; no SW loaded) ^a | | 3.3V | 1.8V | 3.3V | 1.8V | - | |
| BT_PCM_OUT | 0 | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | - | |
| BT_PCM_SYNC | I | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | - | |
| BT_SCL | I/O | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | - | |
| BT_SDA | I/O | No internal pull | No internal pull | No internal pull, disabled input | No internal pull, disabled input | BT_VDDO | n/a | n/a | n/a | n/a | _ | |
| XTAL_PU | 0 | Programmable Default: BCM4: asserted state clock. Otherwis to the deassert set by the BT_ | 325 drives to the when it needs the se, the pin is pulled red state. Polarity is TM0 pin | High-Z | Polarity set by the BT_TM0 pin. | ΟΙΟΟ | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | - | |
| a. REG_ON H | eld LO | W = Both WL_REG | a_ON and BT_REG_O | N held low. REG_C | N is WL_REG_ON OF | 'd internal to th | ie 4325 wi | th BT_REG | _ON. | | | |

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Table 18: WLAN Interface I/O Status

| Signal Name | <i>I/O</i> | On Status | Low Power Status / Sleep (all supplies | REG_ON Held LOW (WL and BT RST N held | HW Default (REG_ON High, WL and | Power rail | Interna Resista (0 | l Pull-Up or Range hm) | Inter Down Rang | nal Pull- Resistor Je (ohm) | Comment | U C |
|------------------------------|------------|--------------------------------------|--|---|--|-------------------|--------------------------|------------------------------|-----------------------|-----------------------------------|--|--------|
| | | | present) | LOW) ^b | BI_RSI_N high; no SW loaded) ^b | | 3.3V | 1.8V | 3.3V | 1.8V | - | .5 |
| WRF_EXTREFIN | Ι | No internal pull. Must be driven. | No internal pull. Must be driven. | High-Z | No internal pull. Needs to be driven. | VDDIO | n/a | n/a | n/a | n/a | - | 0 |
| WL_REG_ON | I | No internal pull. Must be driven. | No internal pull. Must be driven. | No internal pull, must be driven Low | No internal pull. Needs to be driven. | VDDIO/ BT_VDDO | n/a | n/a | n/a | n/a | - | |
| WL_RST_N | I | No internal pull. Must be driven. | No internal pull. Must be driven. | No internal pull, must be driven Low | No internal pull. Needs to be driven. | VDDIO | n/a | n/a | n/a | n/a | - | N |
| BT_RST_N | I | No internal pull. Must be driven. | No internal pull. Must be driven. | No internal pull, must be driven Low | No internal pull. Needs to be driven. | BT_VDDO | n/a | n/a | n/a | n/a | - | for |
| BT_REG_ON | I | No internal pull. Must be driven. | No internal pull. Must be driven. | No internal pull, must be driven Low | No internal pull. Needs to be driven. | VDDIO/ BT_VDDO | n/a | n/a | n/a | n/a | _ | רס |
| WL_GPIO | I/O | Programmable (In, Out, PD, PU) | Programmable (In, Out, PD, PU) | High-Z, No pull | High-Z No pull | VDDIO | 58K to 63K | 58K to 63K | 58K to 63K | 58K to 63K | Internal pull-up/down are programmable and can be enabled/disabled by S/W. | , C |
| SDIO Data [3:0] ^a | I/O | Pull-up | Pull-up | High-Z, No pull | Pull-up | VDDIO_SD | 15K to 35K | 30K to 82K | n/a | n/a | PD not available, PU by default, can be disabled by SW. | , uu |
| SDIO CMD ^a | I/O | Pull-up | Pull-up | High-Z, No pull | Pull-up | VDDIO_SD | 15K to 35K | 30K to 82K | n/a | n/a | PD not available, PU by default, can be disabled by SW. | |
| SDIO_CLK | Ι | No internal pull. Must be driven. | No internal pull. Must be driven. | High-Z | High-Z | VDDIO_SD | n/a | n/a | n/a | n/a | - | D M |

a. Section 6 of the SDIO physical layer specification states that the SDIO host must provide a 10k to 100k ohm pull-up resistor on each CMD and DAT(3:0) signal line. To properly operate the BCM4325, this requirement must be met by either programming internal PU resistors on the host or device side or adding discrete resistors.
 b. REG_ON Held LOW = Both WL_REG_ON and BT_REG_ON held low. REG_ON is WL_REG_ON OR'd with BT_REG_ON in the BCM4325.

SDIO PIN DESCRIPTION

| SD 4-Bit Mode | | SD 1-B | it Mode | SPI Mo | de |
|---------------|--------------------------|--------|--------------|--------|-------------|
| | | | | | |
| SDIO_DATA_0 | Data line 0 | DATA | Data line | DO | Data output |
| SDIO_DATA_1 | Data line 1 or Interrupt | IRQ | Interrupt | IRQ | Interrupt |
| SDIO_DATA_2 | Data line 2 or Read Wait | RW | Read Wait | NC | Not used |
| SDIO_DATA_3 | Data line 3 | N/C | Not used | CS | Card select |
| SDIO_CLK | Clock | CLK | Clock | SCLK | Clock |
| SDIO_CMD | Command line | CMD | Command line | DI | Data input |





Figure 13: Signal Connections to SDIO Card (SD 4-Bit Mode)



Figure 14: Signal Connections to SDIO Card (SD 1-Bit Mode)



Figure 15: Signal Connections to SDIO Card (SPI Mode)

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Section 16: Operating Conditions and DC Characteristics

ABSOLUTE MAXIMUM RATINGS



Caution! These specifications indicate levels where permanent damage to the device can occur. Functional operation is not guaranteed under these conditions. Operation at absolute maximum conditions for extended periods can adversely affect long-term reliability of the device.

| Rating | Symbol | Value | Unit |
|------------------------------------|------------------|--------------|------|
| DC supply voltage for VBATT | VBATT | -0.5 to 6.5 | V |
| DC supply voltage for I/O | VDDIO | -0.5 to 4.1 | V |
| DC supply voltage for WLAN PAs | VDDPAG | -0.5 to 4.1 | V |
| | VDDPAA | | |
| DC supply voltage for BT PA | VDDTF | -0.5 to 2.9 | V |
| DC supply voltage for RF | All 1.25V analog | -0.5 to 1.32 | V |
| DC supply voltage for core | VDDC | -0.5 to 1.32 | V |
| Maximum undershoot voltage for I/O | Vundershoot | -0.5 | V |
| Maximum junction temperature | Тj | 125 | °C |

Table 20: Absolute Maximum Ratings

ELECTROSTATIC DISCHARGE SPECIFICATIONS

Use extreme caution to avoid damage due to electrostatic discharge (ESD). Proper use of wrist and heel grounding straps to discharge static electricity is required when handling microprocessor devices. When storing a device, place it in antistatic packaging.

Table 21: ESD Specifications

| Pin Type | Symbol | Condition | ESD Rating | Unit |
|---|--------------|---|--------------|------|
| ESD, Handling Reference: NQY00083, Section 3.4, Group D9, Table B | ESD_HAND_HBM | Human Body Model Contact Discharge per JEDEC EID/ JESD22-A114 | ±1500 | V |
| Either HBM or MM to be tested. | ESD_HAND_MM | Machine Model Contact | <u>+</u> 50 | V |
| CDM to be tested | ESD_HAND_CDM | Charged Device Model Contact Discharge per JEDEC EIA/ JESD22-C101 | <u>+</u> 200 | V |

ENVIRONMENTAL RATINGS

| Characteristic | Value | Units | Conditions/Comments |
|---------------------------------------|--------------|-------|---------------------|
| Ambient Temperature (T _A) | -30 to 85 | Oo | Operation |
| Storage Temperature | -40 to 125 | Oo | - |
| Relative Humidity | Less than 60 | % | Storage |
| | Less than 85 | % | Operation |

RECOMMENDED OPERATING CONDITIONS

Table 23: Recommended Operating Conditions and DC Characteristics

| Flowert | Symbol | | llait | | |
|--|--------------------------|-----------------|------------|---------|-------|
| Element | Symbol | | Typical | Maximum | - Omi |
| DC supply voltage for VBATT ^a | VDDBATT | 2.3 | 3.3 | 5.5 | V |
| DC supply voltage for I/O ^a | VDDIO | 1.62 | 3.3 or 1.8 | 3.63 | V |
| DC supply voltage for WLAN PAs ^a | WRF_VDDPAG WRF_VDDPAA | 2.97 | 3.3 | 3.63 | V |
| DC Supply for BT PA ^a : | VDDTF | | | | |
| Class1 | | 2.38 | 2.5 | 2.63 | V |
| Class2 | | 1.4 | 1.5 | 1.6 | V |
| Class3 | | 1.19 | 1.25 | 1.31 | V |
| DC supply voltage for core ^a | VDDC | 1.19 | 1.25 | 1.31 | V |
| Input low voltage (VDDIO = 3.3V) | V _{IL} | - | - | 0.8 | V |
| Input high voltage (VDDIO = 3.3V) | V _{IH} | 2.0 | _ | VDDIO | V |
| Input low voltage (VDDIO = 1.8V) | V _{IL} | - | - | 0.6 | V |
| Input high voltage (VDDIO = 1.8V) | V _{IH} | 1.1 | - | VDDIO | V |
| Output low voltage | V _{OL} | - | - | 0.4 | V |
| Output high voltage | V _{OH} | VDDIO – 0.4V | | - | V |
| Input low current | IIL | _ | 0.3 | - | μA |
| Input high current | I _{IH} | - | 0.3 | - | μA |
| Output low current (VDDIO = $3.3V$, $V_{OL} = 0.4V$) | I _{OL} | - | _ | 3.0 | mA |
| Output high current (VDDIO = 3.3V, V_{OH} = 2.9V) | I _{OH} | - | - | 3.0 | mA |
| SDIO input/output current | I _{sdio} | - | _ | 12 | mA |

a. **Caution:** Functional operation is not guaranteed outside specified limits. Operation outside these limits for extended periods may adversely affect the long-term reliability of the device.

Ø

BLUETOOTH AND FM CURRENT CONSUMPTION

Note: WLAN_RST_N is low for all measurements.

Note: For Class 1, VDDTF is supplied 2.5V externally separate from VBATT. For FM, the Bluetooth is in reset. The current consumption numbers are measured based on typical output power specified in the Table 27: "Bluetooth Transmitter RF Specifications," on page 81.

| | | | Class 1 | 1 | | | |
|------|---|--------------------------|----------------|-------|-----------|-------|----|
| Test | Operating Mode | Vbat=3.6V and Vddio=3.3V | | | Vbat=3.6V | Unit | |
| Item | | VBAT | VDDTF =2.5V | VDDIO | VBAT | VDDIO | |
| 1 | Sleep | 0.18 | 0.001 | 0.005 | _ | _ | mA |
| 2 | Standard 1.28s Inquiry Scan | 0.41 | 0.004 | _ | _ | _ | mA |
| 3 | Standard 2.56s Inquiry Scan | 0.30 | 0.002 | _ | - | _ | mA |
| 4 | R1 Standard Page Scan | 0.41 | 0.004 | _ | - | _ | mA |
| 5 | Standard page and 1.28s Inquiry Scan | 0.61 | 0.01 | _ | _ | - | mA |
| 6 | Standard page and 2.56s Inquiry Scan | 0.50 | 0.005 | _ | _ | - | mA |
| 7 | 500 ms Sniff Master | 0.41 | 0.06 | _ | _ | _ | mA |
| 8 | 500 ms Sniff Slave | 0.41 | 0.06 | _ | - | _ | mA |
| 13 | 500 ms Sniff Master Page and 1.28s Inquiry Scan | 1.01 | 0.06 | - | _ | _ | mA |
| 17 | DM1/DH1 Master | 18.10 | 22.24 | _ | 23.26 | _ | mA |
| 18 | DM3/DH3 Master | 19.20 | 26.84 | _ | 25.10 | _ | mA |
| 19 | DM5/DH5 Master | 19.28 | 25.08 | _ | 24.78 | _ | mA |
| 22 | HV3 Master ^a | 10.54 | 7.42 | _ | 12.31 | - | mA |
| 23 | FM I ² S Audio | 9.50 | _ | _ | - | _ | mA |
| 24 | FM Analog Audio | 11.00 | _ | _ | _ | - | mA |
| 25 | BT_Reset + WL_Reset | 0.02 | 0.001 | 0.005 | _ | 0.005 | mA |
| а | Includes sniff | | | | | | |

Table 24: Bluetooth and FM Current Consumption

Includes sniff.

WLAN CURRENT CONSUMPTION



Note: BT_RST_N is low for all measurements.

| One wation of Ctate | VBATT = 3 | 3.6V, VDDIO = 3.3V |
|---|-----------|--------------------|
| Operational State | Typical | Units |
| Leakage (WLAN and BT/FM in reset) b, c, d | 20 | uA |
| Sleep with Buck-Boost in burst mode (driver controlled) | 250 | uA |
| Sleep with Buck-Boost shutdown (driver controlled) | 160 | uA |
| Idle between beacons | 152 | uA |
| IEEE PS@DTIM = 100 ms | 1.3 | mA |
| IEEE PS@DTIM = 300 ms | 553 | uA |
| Beacon reception | 78 | mA |
| Rx 1 Mbps | 79 | mA |
| Rx 11 Mbps | 79 | mA |
| Rx 6 Mbps | 81 | mA |
| Rx 54 Mbps | 83 | mA |
| TX 1 Mbps, 18 dBm at chip Tx output ^e | 245 | mA |
| TX 1 Mbps, 21 dBm at chip Tx output ^e | 288 | mA |
| TX 11 Mbps, 18 dBm at chip Tx output ^e | 249 | mA |
| TX 11 Mbps, 21 dBm at chip Tx output ^e | 295 | mA |
| TX 6 Mbps, 17 dBm at chip Tx output ^e | 240 | mA |
| TX 6 Mbps, 20 dBm at chip Tx output ^e | 276 | mA |
| TX 54 Mbps, 17 dBm at chip Tx output ^e | 241 | mA |
| TX 54 Mbps, 20 dBm at chip Tx output ^e | 277 | mA |

Table 25: WLAN Current Consumption using Power Topology #1 (Vbatt with Buck-Boost)^a

a. For details, refer to the *BCM4325 Power Supply Topologies* application note (document number 4325-AN60X-R).

 Additional leakage current may occur at the board level, depending on factors such as the power topology and external PU/ PD resistors, etc.

c. All measurements include VDDIO current with VDDIO = 3.3V.

d. All measurements exclude current drawn by the external 32.768 KHz oscillator, which is required for operation.

e. Chip Tx output power is based on Broadcom reference board measurements and backward calculation from antenna test port.



Section 17: Bluetooth RF Specifications

Note: Unless otherwise stated, all specifications in this section apply to the operating temperature and voltage ranges specified in Table 20 and Table 22 on page 76 and Table 23 on page 76. Functional operation outside these limits is not guaranteed.

| Parameter | Conditions | Minimum | Typical ^d | Maximum | Unit |
|-------------------------------------|------------------------------|---------|----------------------|---------|------|
| General | | | | | |
| Frequency range | - | 2402 | _ | 2480 | MHz |
| RX sensitivity ^a | GFSK, 0.1% BER, 1 Mbps | _ | -88.0 | -84.0 | dBm |
| | π/4-DQPSK, 0.01% BER, 2 Mbps | _ | -90.0 | -84.0 | dBm |
| | 8-DPSK, 0.01% BER, 3 Mbps | _ | -85.0 | -80.0 | dBm |
| Input IP3 | _ | -16 | _ | _ | dBm |
| Maximum input | _ | _ | _ | -20.0 | dBm |
| Interference Performance | | | | | |
| C/I cochannel | GFSK, 0.1% BER | _ | _ | 11.0 | dB |
| C/I 1 MHz adjacent channel | GFSK, 0.1% BER | _ | _ | 0.0 | dB |
| C/I 2 MHz adjacent channel | GFSK, 0.1% BER | _ | _ | -30.0 | dB |
| $C/I \ge 3$ -MHz adjacent channel | GFSK, 0.1% BER | _ | _ | -40.0 | dB |
| C/I image channel | GFSK, 0.1% BER | _ | _ | -9.0 | dB |
| C/I 1 MHz adjacent to image channel | GFSK, 0.1% BER | _ | _ | -20.0 | dB |
| C/I co-channel | π/4-DQPSK, 0.1% BER | _ | _ | 13.0 | dB |
| C/I 1 MHz adjacent channel | π/4-DQPSK, 0.1% BER | _ | _ | 0.0 | dB |
| C/I 2 MHz adjacent channel | π/4-DQPSK, 0.1% BER | _ | _ | -30.0 | dB |
| $C/I \ge 3$ MHz adjacent channel | 8-DPSK, 0.1% BER | - | - | -40.0 | dB |
| C/I image channel | π/4-DQPSK, 0.1% BER | _ | _ | -7.0 | dB |
| C/I 1 MHz adjacent to image channel | π/4-DQPSK, 0.1% BER | - | - | -20.0 | dB |
| C/I cochannel | 8-DPSK, 0.1% BER | _ | _ | 21.0 | dB |
| C/I 1 MHz adjacent channel | 8-DPSK, 0.1% BER | - | - | 5.0 | dB |
| C/I 2 MHz adjacent channel | 8-DPSK, 0.1% BER | - | - | -25.0 | dB |
| C/I > = 3 MHz adjacent channel | 8-DPSK, 0.1% BER | - | - | -33.0 | dB |
| C/I Image channel | 8-DPSK, 0.1% BER | - | - | 0.0 | dB |
| C/I 1 MHz adjacent to image channel | 8-DPSK, 0.1% BER | - | - | -13.0 | dB |
| Out-of-Band Blocking Performance | (CW) | | | | |
| 30 MHz – 2000 MHz | 0.1% BER | - | -10.0 | _ | dBm |
| 2000 – 2399 MHz | 0.1% BER | _ | -27 | _ | dBm |
| 2498 – 3000 MHz | 0.1% BER | _ | -27 | _ | dBm |
| 3000 MHz – 12.75 GHz | 0.1% BER | _ | -10.0 | - | dBm |

Table 26: Bluetooth Receiver RF Specifications

| Parameter | Conditions | Minimum | Typical ^d | Maximum | Unit |
|---------------------------------|--------------------------------------|---------|----------------------|---------|--------|
| Out-of-Band Blocking Performanc | e, Modulated Interferer ^b | | | | |
| 824 – 849 MHz, CDMA | - | _ | -10 | _ | dBm |
| 824 – 849 MHz, EDGE/GSM | - | _ | -2 | _ | dBm |
| 880 – 915 MHz, EDGE/GSM | - | _ | -2 | _ | dBm |
| 1710 – 1785 MHz, EDGE/GSM | - | - | -5 | - | dBm |
| 1850 – 1910 MHz, EDGE/GSM | - | _ | -5 | - | dBm |
| 1850 – 1910 MHz, CDMA | - | - | -15 | - | dBm |
| 1850 – 1910 MHz, WCDMA | - | - | -20 | - | dBm |
| 1920 – 1980 MHz, WCDMA | - | _ | -20 | - | dBm |
| 776 – 794 MHz, CDMA | - | _ | -10 | - | dBm |
| Spurious Emissions ^c | | | | | |
| 30 MHz – 1 GHz | _ | _ | -80 | -57 | dBm |
| 1 GHz – 12.75 GHz | - | _ | 51 | -47 | dBm |
| Cell-band Noise Floor | | | | | |
| 824 – 850 MHz, EDGE/GSM | _ | _ | -145 | _ | dBm/Hz |
| 880 – 915 MHz, EDGE/GSM | - | _ | -145 | _ | dBm/Hz |
| 1710 – 1785 MHz, EDGE/GSM | - | _ | -145 | _ | dBm/Hz |
| 1850 – 1910 MHz, EDGE/GSM | - | _ | -145 | _ | dBm/Hz |
| 1920 – 1980 MHz, WCDMA | - | _ | -145 | _ | dBm/Hz |

 Table 26: Bluetooth Receiver RF Specifications (Cont.)

a. The receiver sensitivity is measured at a BER of 0.1% on the device interface.

b. Bluetooth reference level of -82 dBm.

c. Includes baseband-radiated emissions.

d. Typical operating conditions are 1.25V operating voltage and 25°C ambient temperature.



Note: The maximum value represents the actual Bluetooth specification required for Bluetooth qualification as defined in the version 2.1 specification.



| Parameter | Minimum | Typical | Maximum | Unit |
|---|---------|----------------|-----------------------|--------|
| General | | | | |
| Frequency range | 2402 | _ | 2480 | MHz |
| Class1, TX max powerBT_VDDTF = 2.5V (max. up to 3.1V) | 4.5 | 7.5 | _ | dBm |
| Class2, TX max powerBT_VDDTF = 1.5V | 0 | 4 ^b | - | dBm |
| Class1, TX min powerBT_VDDTF = 2.5V (max. up to 3.1V) | - | -18 | _ | dBm |
| Class2, TX min powerBT_VDDTF = 1.5V | - | -20 | _ | dBm |
| Gain step | 2 | 4 | 6 | dB |
| In-Band Spurious Emissions | | | | |
| <u>+</u> 500 kHz | _ | _ | -20.0 | dBc |
| 1.0 MHz < M – N < 1.5 MHz | _ | _ | -26.0 | dBc |
| 1.5 MHz < M – N < 2.5 MHz | _ | _ | -40.0 | dBm |
| $ M - N \ge 2.5 MHz$ | - | _ | -60.0 | dBm |
| Out-of-Band Spurious Emissions | | | | |
| 30 MHz to 1 GHz | _ | _ | –36.0 ^{c, d} | dBm |
| 1 GHz to 12.75 GHz | _ | _ | –30.0 ^a | dBm |
| 1.8 GHz to 1.9 GHz | _ | _ | -37.0 | dBm |
| 5.15 GHz to 5.3 GHz | - | - | -37.0 | dBm |
| GPS Band Spurious Emissions | | | | |
| Without SAW filter | _ | -150 | - | dBm/Hz |
| Out-of-Band Noise Floor | | | | |
| 746 MHz to 764 MHz | - | -145 | - | dBm/Hz |
| 851 MHz to 894 MHz | _ | -145 | _ | dBm/Hz |
| 925 MHz to 960 MHz | - | -145 | _ | dBm/Hz |
| 1805 MHz to 1880 MHz | _ | -145 | _ | dBm/Hz |
| 1930 MHz to 1990 MHz | _ | -145 | - | dBm/Hz |
| 2110 MHz to 2170 MHz | _ | -145 | _ | dBm/Hz |

Table 27: Bluetooth Transmitter RF Specifications ^a

a. The RF characteristics are measured at the device interface.

b. Actual output power can be adjusted to a lower level based on product requirements.

c. The maximum value represents the value required for Bluetooth qualification as defined in the version 2.1 specification.

d. The spurious emissions during Idle mode are the same as specified in Table 26 on page 79.

Section 18: FM Receiver Specifications

Note: Unless otherwise stated, all specifications in this section apply to the operating temperature and voltage ranges specified in Table 20 and Table 22 on page 76 and Table 23 on page 76. Functional operation outside these limits is not guaranteed.

| Parameter | Conditions | Minimum | Typical | Maximum | Units |
|--|--|---------|---------|---------|-------|
| RF Parameters | | | | | |
| Operating frequency | Frequencies inclusive | 76 | - | 108 | MHz |
| Sensitivity, V _{RF} | FM only, fmod = 1kHz | - | -105 | -102 | dBm |
| | $\Delta f = 22.5 \text{ kHz} (S+N)/N=26 \text{ dB}$ | | | | |
| | BAF = 300 Hz to 15 kHz | | | | |
| | A-weighted de-emphasis = 50 μ s, f _{IN} = 76 to 108 MHz | | | | |
| | RDS. For an RDS deviation of 1.2 kHz. 95% of blocks decoded with no errors, over a sample of 5000 blocks. ^b | _ | 23 | 28 | dBuV |
| | RDS. For an RDS deviation of 2 kHz. 95% of blocks decoded with no errors, over a sample of 5000 blocks. ^b | _ | 19 | 24 | dBuV |
| Receiver adjacent channel selectivity | At ± 200 kHz. $f_{IN} = 76$ to 108 MHz, Measured for 40 dB SNR at the audio output. | 16 | - | - | dB |
| | At ±300 kHz (as above) | 25 | _ | - | dB |
| Image response (assuming image frequency ≥ ±300 kHz), mono | At $f_{wanted} \pm 2f$ IF depending on LO injection relative to F_{wanted} . Should be 40 dB SNR at the audio output | 25 | - | - | dB |
| Image response (assuming image frequency \geq ±300 kHz), stereo | - | 0 | - | - | dB |
| Min S/N for in band blocking for offsets \geq 400 KHz and \leq 1 MHz, mono | Wanted level set to –90 dBm, Δf = 75 kHz, Interferer level set to –55 dBm, Δf = 40 kHz, 1-kHz tone, AGC on | 35 | - | _ | dB |
| Min S/N for in band blocking for offsets \geq 400 KHz and \leq 1 MHz, stereo | Wanted level set to -72 dBm, $\Delta f = 75$ kHz, 1-kHz tone. Interferer level set to -37 dBm | 35 | - | - | dB |
| Intermediate S/N in the presence of intermodulation | Overall third-order intercept point, for tones \pm 400 and \pm 800 kHz, \pm 4 and \pm 8 MHz. Reference level is – 82 dBm, tone levels set at –50 dBm. f _{IN} = 76 to 108 MHz. AGC enabled | 40 | - | - | dB |
| AM suppression, mono | Vin = –90 dBm, fmod = 1 kHz, Δf = 22.5 kHz, m = 0.3, BAF = 300 Hz to 15 kHz, L = R, de-emphasis = 75 μ s | 40 | - | - | dB |
| AM suppression, stereo | Vin = -47 dBm, fmod = 1 kHz, Δf = 22.5 kHz, m = 0.3, BAF = 300 Hz to 15 kHz, L = R, de-emphasis = 75 μ s | 40 | - | - | dB |

Table 28: FM Receiver Specifications

6/30/09

| Parameter | Conditions | Minimum | Typical | Maximum | Units |
|--|---|---------|---------|---------|------------|
| Intermediate S/N | Vin = -90 dBm, fmod = 1 kHz, Δf = 22.5 kHz, m = 0.3, BAF = 300 Hz to 15 kHz A-weighted, MONO, de-emphasis = 50 µs | 45 | - | - | dB |
| RF Input | | | | | |
| RF input impedance | Single-ended input with optional external matching circuitry | _ | 50 | _ | Ω |
| RF input level | Maximum on-channel input level 76–108 MHz. | _ | _ | -10 | dBm |
| RF input impedance return loss | With external matching circuitry | - | _ | -6 | dB |
| RF conducted emissions | Local oscillator breakthrough measured on the reference port | - | - | -55 | dBm |
| | 925–960 MHz, 1805 –1880 MHz and 1930– 1990 MHz | - | _ | -90 | dBm |
| RF blocking levels at the FM antenna input. (Assumes | 824–915 MHz, GSM 200 kHz BW, CDMA 1.2 MHz BW | - | - | 0 | dBm |
| presence of an external matching circuit.) | 1710–1980 MHz, GSM 200 kHz BW, CDMA 1.2 MHz BW, WCDMA 4 MHz BW | - | - | -5 | dBm |
| | 2.4–2.4835 GHz, BT 1 MHz BW, WLAN 20 MHz BW | _ | - | -20 | dBm |
| PLL | | | | | |
| Frequency step | Channel offset | _ | _ | 50 | kHz |
| Settling time | Single frequency switch in any direction to a frequency within the bands 88–108 MHz or 76–90 MHz. Time measured to within 5 kHz of the final frequency. | - | 5 | - | ms |
| Sweep time | Total time for an automatic search to sweep from 88–108 MHz or 76–90 MHz (and reverse direction) assuming no channels found. | - | 8 | - | Sec |
| Soft Mute | | | | | |
| Soft mute start level ^a | Mute attenuation = 3 dB | 3 | 5 | 10 | uV |
| Soft mute attenuation | Vin = 1 μ V, Δ f = 22.5 kHz, L = R fmod = 1 kHz, BAF = 300 Hz to 15 kHz, de-emphasis = 75 μ s | 10 | 20 | 30 | dB |
| General Audio | | | | | |
| Audio output level | $ \begin{array}{l} \mbox{Vin} = 1 \mbox{ mV}, \ \Delta f = 22.5 \mbox{ kHz}_p \mbox{ fmod} = 1 \mbox{ kHz}, \mbox{ L} = R, \\ \mbox{de-emphasis} = 75 \ \mbox{ \mus}. \ \Delta f \ \mbox{Pilot} = 6.75 \mbox{ kHz}_p, \\ \mbox{Rload} > 30 \mbox{ k}\Omega \end{array} $ | 60 | 75 | 90 | mV, rms |
| Maximum audio output level | $ \begin{array}{l} \mbox{Vin} = 1 \mbox{ mV}, \ensuremath{\Delta f} = 100 \mbox{ kHz}_p \mbox{ fmod} = 1 \mbox{ kHz}, \ensuremath{L} = R, \mbox{ demphasis} = 75 \mu s. \ensuremath{\Delta f} \mbox{ Pilot} = 6.75 \mbox{ kHz}_p, \\ \mbox{ Rload} > 30 \kappa \Omega \end{array} $ | . – | _ | 360 | mV, rms |
| Audio output level difference | Vin = 1 mV, Δf = 22.5 kHz, fmod = 1 kHz, L = R, de-emphasis = 75 μ s | -1 | - | 1 | dB |
| Max signal plus noise to noise ratio (S+N)/N, mono | Vin = 1 mV, Δf = 22.5 kHz, fmod = 1 kHz, de-emphasis = 50 µs, L = R, BAF = 300 Hz to | 53 | 57 | - | dB |
| Max signal plus noise to noise ratio (S+N)/N, stereo | [–] 15 kHz (A-Weighted) f _{IN} = 76 to 108 MHz | 48 | 53 | - | dB |

Table 28: FM Receiver Specifications (Cont.)

| Parameter | Conditions | Minimum | Typical | Maximum | Units |
|---|---|---------|---------|---------|-------|
| Total harmonic distortion, mono | Vin = 1 mV, Δf = 75 kHz, L = R, fmod = 400 Hz, deemphasis = 50 μ s. | _ | 0.4 | 0.8 | % |
| | Vin = 1 mV, Δf = 75 kHz, L = R, fmod = 1 kHz, de-emphasis = 50 μ s. | - | 0.4 | 0.8 | % |
| | Vin = 1 mV, Δf = 100 kHz, L = R, fmod = 1 kHz, deemphasis = 50 $\mu s.$ | - | 0.5 | 1.0 | % |
| Total harmonic distortion, stereo | Vin = 1 mV, Δf = 75 kHz, L = R, fmod = 3 kHz, de-emphasis = 50 μ s. | - | 0.9 | 1.5 | % |
| Audio spurious products | Vin = 1 mV, Δf = 22.5 kHz, fmod = 1 kHz, de-emphasis = 50 µs, L = R, BAF = 300 Hz to 15 kHz (A-Weighted), f _{IN} = 76 to 108 MHz, With respect to 1 kHz tone. | _ | - | 60 | dBc |
| Audio bandwidth, upper (-3 dB point) | Vin = 1 mV, Δf = 22.5 kHz, for both 50 and 75 μ s de-emphasis, pre-emphasis applied. | 15 | _ | - | KHz |
| Audio bandwidth, lower (-3 dB point) | - | - | - | 20 | Hz |
| Deviation of the audio response from an ideal de-emphasis curve | 100 Hz to 13 kHz, Vin = 1 mV, Δf = 22.5 kHz, for both 50 and 75 μ s de-emphasis, pre-emphasis applied. | - | _ | ±0.5 | dB |
| De-emphasis time constant tolerance | With respect to 50 and 75 $\mu s.$ | - | - | ±5 | % |
| Audio output impedance | When FM function is disabled, or when left or right channels are hard-muted via the bus. | 50 | _ | - | KΩ |
| Audio output impedance | When FM function is enabled and in any of the | _ | 50 | - | Ω |
| Left and right AC_mute | following modes: autosearch, AC-muted by | 60 | _ | _ | dB |
| Right audio output hard muting attenuation | | 80 | _ | - | dB |
| Left audio output hard muting attenuation | - | 80 | _ | - | dB |
| Pause Detection | | | | | |
| Audio level at which a pause is detected | Relative to 1 kHz tone, 22.5 kHz deviation, 50 μs de-emphasis | _ | - | - | - |
| | Four values in 3 dB steps | -21 | _ | -12 | dB |
| Audio pause duration | Four values | 20 | _ | 40 | ms |
| Stereo Decoder | | | | | |
| Stereo channel separation | SNC OFF, increasing RF input, switched from mono to stereo Δf = 75 kHz, fmod = 1 kHz, 30 μ V input level, R = 0, L = 1 including 9% pilot | 27 | 30 | - | dB |
| Pilot suppression | Measured at audio outputs. $\Delta f = 75 \text{ kHz}$, fmod = 1 kHz. de-emphasis = 75 us | 46 | - | - | dB |

| Table 28: | FM Receiver Specifications | (Cont.) |
|-----------|----------------------------|---------|
|-----------|----------------------------|---------|

b. RDS sensitivity range is only from 87.5 MHz to 108 MHz.



Section 19: WLAN RF Specifications

INTRODUCTION

The BCM4325 includes an integrated dual-band direct conversion radio that supports either the 2.4 GHz IEEE 802.11g band or the 5 GHz IEEE 802.11a band. The BCM4325 does not provide simultaneous 2.4 GHz and 5 GHz operation. This section describes the RF characteristics of the 2.4 GHz and 5 GHz portions of the radio.



Note: Unless otherwise stated, all specifications in this section apply to the operating temperature and voltage ranges specified in Table 20 and Table 22 on page 76 and Table 23 on page 76. Functional operation outside these limits is not guaranteed.

CELLULAR BLOCKING

WLAN and cellular transceivers have separate antennas. The isolation between the antennas is 20 dB in all cases (for example, the maximum EGSM900 signal power at the WLAN RF port is +13 dBm).

| System | Frequency (MHz) | Maximum Power Output | Modulation |
|---------------------------------|-----------------|----------------------|------------|
| GSM | 824–849 | +33 dBm | GMSK |
| | | +27 | EDGE |
| CDMA | 824–849 | +25 | QPSK |
| EGSM900 | 880–915 | +33 | GMSK |
| | | +27 | EDGE |
| DCS1800 | 1710–1785 | +30 | GMSK |
| | | +26 | EDGE |
| PCS1900 | 1850–1910 | +30 | GMSK |
| | | +26 | EDGE |
| CDMA | 1850–1910 | +24 | QPSK |
| WDCMA FDD | 1920–1980 | +21 | QPSK |
| Wideband noise from cellular TX | 2400–2500 | –150 dBm/Hz | - |

 Table 29: Blocking Signals from Embedded Cellular Transmitter at Cellular Antenna Port

Note: GMSK and EDGE transmissions have duty cycle of 1/8 or 1/4. Nominal repetition rate of transmission is about 217 Hz. QPSK transmissions for (W)CDMA have a duty cycle of 1.

WLAN RECEIVER BLOCKING PERFORMANCE

The total contribution of out-of-band signals from a cellular band transmitter and wideband noise falling on the WLAN band does not reduce the sensitivity of the WLAN receiver more than 1 dB compared to the performance without interference. Only one cellular transmitter is active at a time.

The cited specifications assume the use of an external cellular blocking filter that has the following characteristics:

- (NdBa) TiO₃ ($E_r = 88/T_{Cf} = 0 \pm 10$ ppm/K) with a coating of copper (10 µm thick) and tin (>5 µm thick) •
- Operating temperature = -30° C to $+85^{\circ}$ C
- Center frequency = 2.450 GHz
- Insertion loss = 0.7 dB (typical), 1.0 dB (maximum) ٠
- Pass band (2400-2500) = 100 MHz (minimum)
- Amplitude ripple (peak-to-peak) = 0.4 dB (typical), 0.8 dB (maximum)
- SWR = 1.5 (typical), 2.0 (maximum)
- Impedance = 50Ω (typical)
- Attenuation:
 - @ DC to 880 MHz 50 dB (minimum), 55 dB (typical)
 - @ 880 to 960 MHz 45 dB (minimum), 50 dB (typical)
 - @ 960 to 1990 MHz 40 dB (minimum), 45 dB (typical)
 - @ 1990 to 2100 MHz 25 dB (minimum), 30 dB (typical)

2.4 GHz BAND GENERAL RF SPECIFICATIONS

Table 30: 2.4 GHz Band General RF Specifications

| Item | Condition | Minimum | Typical | Maximum | Unit |
|-------------------|------------------------|---------|---------|---------|------|
| TX/RX Switch Time | Including TX ramp down | - | 5 | 10 | μs |
| RX/TX Switch Time | Including TX ramp up | _ | 5 | 5 | μs |

2.4 GHz BAND LOCAL OSCILLATOR SPECIFICATIONS

|--|

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|---|---------------|---------|----------------------|---------|--------|
| VCO Frequency Range | _ | 2412 | _ | 2484 | MHz |
| Reference Input Frequency Range | _ | _ | Various ^a | _ | MHz |
| Reference Spurs | _ | _ | _ | -34 | dBc |
| Local Oscillator Phase Noise, single-sided from 1 to 300 kHz offset | _ | _ | _ | -86.5 | dBc/Hz |
| Clock Frequency Tolerance | _ | _ | _ | ±20 | ppm |
| a Beference supported frequencies range from 13 | MHz to 52 MHz | | | | |



2.4 GHz BAND RECEIVER RF SPECIFICATIONS

| Table 32: 2.4 GHz Band Receiver RF Specific | cations |
|---|---------|
|---|---------|

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|--|----------------------------|---------|---------|---------|------|
| Cascaded Noise Figure | - | - | 4 | _ | dB |
| Maximum Receive Level (when using a suitable external switch) | @ 1, 2 Mbps | -4 | - | _ | dBm |
| | @ 5.5, 11 Mbps | -10 | - | _ | dBm |
| | @ 54 Mbps | -10 | - | _ | dBm |
| PGA DC Rejection Servo Loop Bandwidth | WB mode | - | 1 | _ | MHz |
| | NB mode | 120 Hz | - | 230 kHz | - |
| LPF DC Rejection Servo Loop Bandwidth | WB mode | - | 500 | _ | kHz |
| | NB mode | 120 Hz | - | 230 kHz | - |
| Adjacent Channel Power Rejection (DSSS at 11Mbps ^a) | $Rx = -70 \text{ dBm}^{b}$ | 35 | - | - | dB |
| Maximum Receiver Gain | - | _ | >100 | _ | dB |

a. The difference between the interfering and desired signal (> 25 MHz apart) at 8% PER for 1024 octet PSDU with desired signal level, as specified.

b. Values are measured at the input to the BCM4325. Accordingly, they include insertion losses from the integrated baluns, but these values do not include the insertion loss of the external RF path. Reference sensitivity (10% PER for OFDM and 8% PER for DSSS for 1000-octet PSDU) at chip input.

2.4 GHz Receiver Performance Specifications

| Rate/Modulation | Typical Receive Sensitivity ^a | |
|-----------------|--|--|
| 1 Mbps DSSS | –96.0 dBm | |
| 2 Mbps DSSS | –95.0 dBm | |
| 5.5 Mbps DSSS | –93.0 dBm | |
| 11 Mbps DSSS | –90.5 dBm | |
| 6 Mbps OFDM | –91.5 dBm | |
| 9 Mbps OFDM | –91.0 dBm | |
| 12 Mbps OFDM | –90.5 dBm | |
| 18 Mbps OFDM | –89.0 dBm | |
| 24 Mbps OFDM | –85.5 dBm | |
| 36 Mbps OFDM | –82.5 dBm | |
| 48 Mbps OFDM | –77.0 dBm | |
| 54 Mbps OFDM | –75.5 dBm | |

Table 33: 2.4 GHz Receiver Performance Specifications

a. Values are measured at the input to the BCM4325. Accordingly, they include insertion losses from the integrated baluns, but these values do not include the insertion loss of the external RF path. Reference sensitivity (10% PER for OFDM and 8% PER for DSSS for 1000-octet PSDU) at chip input.

2.4 GHz BAND TRANSMITTER RF SPECIFICATIONS

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|--|--|---------|---------|------------------|-------------|
| RF Output Frequency Range | - | 2400 | _ | 2500 | MHz |
| Output Power (EVM Compliant) | Maximum gain | _ | _ | +22 ^c | dBm |
| Gain Flatness | Maximum gain | _ | _ | 2 | dB |
| Output IP3 | Maximum gain | _ | 37 | _ | dBm |
| Output P1dB | - | _ | 27 | _ | dBm |
| Carrier Suppression | - | 15 | _ | _ | dBr |
| TX Spectrum mask @ maximum gain | fc - 22 MHz < f < fc - 11 MHz | _ | - | -30 | dBr |
| ССК | fc + 11 MHz < f< fc + 22 MHz | - | - | -30 | dBr |
| | f < fc - 22 MHz; and $f > fc + 22 MHz$ | _ | _ | -50 | dBr |
| TX Spectrum mask | f < fc - 11 MHz and $f > fc + 11$ MHz | _ | _ | -26 | dBc |
| (chip output power = 16 dBm) | f < fc - 20 MHz and $f > fc + 20$ MHz | _ | - | -35 | dBr |
| OFDM | f < fc - 30 MHz and $f > fc + 30$ MHz | _ | _ | -40 | dBr |
| TX Modulation Accuracy (EVM) at maximum gain | IEEE 802.11b mode | _ | _ | 35% | - |
| | IEEE 802.11g mode QAM64 54 Mbps | - | - | 5% | - |
| Gain Control Step Size | NA | _ | 0.25 dB | _ | dB/step |
| Amplitude Balance ^a | DC input | -1 | _ | 1 | dB |
| Phase Balance ^a | DC input | -1.5 | _ | 1.5 | ° (degrees) |
| Baseband Differential Input Voltage | Shaped pulse | _ | 0.6 | _ | Vpp |
| TX Power Ramp Up | 90% of final power | _ | - | 2 | μsec |
| TX Power Ramp Down | 10% of final power | _ | - | 2 | μsec |
| Out-of-Band Noise and Spurious En | nissions | | | | |
| 100 kHz to 1930 MHz | 21 dBm at Chip Tx output ^b | _ | -145 | _ | dBm/Hz |
| 1930 to 2170 MHz | 21 dBm at Chip Tx output ^b | _ | -135 | _ | dBm/Hz |
| 2170 to 2300 MHz | 21 dBm at Chip Tx output ^b | _ | -125 | _ | dBm/Hz |
| 2300 to 2390 MHz | 21 dBm at Chip Tx output ^b | _ | -115 | _ | dBm/Hz |
| 2484 to 2655 MHz | 21 dBm at Chip Tx output ^b | _ | -115 | _ | dBm/Hz |
| 2655 to 4700 MHz | 21 dBm at Chip Tx output ^b | _ | -125 | _ | dBm/Hz |
| 4700 to 12750 MHz | 21 dBm at Chip Tx output ^b | _ | -135 | _ | dBm/Hz |

Table 34: 2.4 GHz Band Transmitter RF Specifications

a. At a 3 MHz offset from the carrier frequency.

b. +21 dBm Chip Tx output power is based on Broadcom reference board level measurements and backward calculation from antenna test port.

c. Referred to the chip output. The maximum output power at the antenna test port depends on board layout and output matching.



5 GHz BAND RECEIVER RF SPECIFICATIONS

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|--|------------------------------|----------------|--------------|---------|--------|
| Cascaded Noise Figure | Maximum RX gain | _ | 4.5 | _ | dB |
| Maximum Receive Level ^a (5.24 GHz) | @ 6 Mbps | -10 | _ | _ | dBm |
| | @ 54 Mbps | -15 | _ | _ | dBm |
| DC Rejection Servo Loop Bandwidth | WB mode | _ | 500 | _ | kHz |
| (normal operation) | NB mode | 120 Hz | _ | 230 kHz | NA |
| Adjacent Channel Power Rejection | Rx at –62 dBm ^d | -1 | _ | _ | dB |
| (OFDM at 54 Mbps ^b) | | | | | |
| Alternate Adjacent Channel Power Rejection (OFDM at 54Mbps ^c) | Rx at –61.5 dBm ^d | 15 | - | - | dB |
| Minimum RX Gain | _ | _ | 15 | _ | dB |
| Maximum RX Gain | - | _ | >100 | - | dB |
| IQ Amplitude Balance | - | _ | 0.5 | _ | dB |
| IQ Phase Balance | - | _ | 1.5 | - | Degree |
| Out-of-Band Blocking Performance with | thout RF Band-Pass Filte | er (–1dB desei | nsitization) | | |
| CW | 30 – 4300 MHz | -10 | _ | _ | dBm |
| CW | 4300 – 4800 MHz | -25 | _ | - | dBm |
| CW | 5900 – 6400 MHz | -25 | _ | _ | dBm |
| | | | | | |

Table 35: 5 GHz Band Receiver RF Specifications ^a

a. With minimum RF gain.

b. The difference between the interfering and tehe desired signal (20 MHz apart) at 10% PER for 1000 octet PSDU with the desired signal level, as specified.

c. The difference between the interfering and the desired signal (40 MHz apart) at 10% PER for 1000 octet PSDU with desired signal level, as specified.

d. Values are measured at the input pin of the BCM4325. Accordingly, they include insertion losses from the integrated baluns but do not include the insertion loss of the external RF path.

5 GHz BAND TRANSMITTER RF SPECIFICATIONS

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|-------------------------------------|---------------------------------------|---------|---------|---------|------------|
| RF Output Frequency Range | NA | 4920 | _ | 5805 | MHz |
| Gain Flatness | Maximum gain | - | - | 1 | dB |
| Output IP3 | Maximum gain | - | 35 | - | dBm |
| Output P1dB | Maximum gain | - | 25 | - | dBm |
| Output Power (EVM Compliant) | Minimum gain | - | - | - | dBm |
| Carrier Suppression | - | -15 | _ | - | dBr |
| TX Spectrum mask | f < fc - 11 MHz and $f > fc + 11 MHz$ | - | - | -26 | dBc |
| (chip output power = 16 dBm) | f < fc - 20 MHz and $f > fc + 20 MHz$ | - | - | -35 | dBr |
| OFDM | f < fc - 30 MHz and $f > fc + 30$ MHz | _ | _ | -40 | dBr |
| Gain Control Step Size | NA | - | 0.25 | - | dB/step |
| I/Q Baseband 3 dB Bandwidth | NA | - | 12 | - | MHz |
| Amplitude Balance | DC Input | -0.5 | _ | 0.5 | dB |
| Phase Balance | DC Input | -1.5 | - | 1.5 | ° (degree) |
| Baseband Differential Input Voltage | NA | - | 0.7 | - | Vpp |
| TX Power Ramp Up | 90% of final power | _ | _ | 2 | μsec |
| TX Power Ramp Down | 10% of final power | _ | _ | 2 | μsec |

Table 36: 5 GHz Band Transmitter RF Specifications

5 GHZ BAND LOCAL OSCILLATOR FREQUENCY GENERATOR SPECIFICATIONS

Table 37: 5 GHz Band Local Oscillator Frequency Generator Specifications

| Characteristic | Condition | Minimum | Typical | Maximum | Unit |
|--|-----------------------|---------|----------------------|---------|--------|
| VCO Frequency Range | - | 4920 | _ | 5805 | MHz |
| Reference Input Frequency Range | _ | _ | various ^a | _ | MHz |
| Reference Spurs | _ | _ | _ | -30 | dBc |
| Local Oscillator Integrated Phase Noise (1–300 kHz) | 4.920–5.700 GHz | _ | 0.7 | _ | degree |
| | 5.725–5.805 GHz | - | 1.4 | _ | degree |
| Clock Frequency Tolerance | - | - | _ | ±20 | ppm |
| a Reference supported frequencies range | from 13 MHz to 52 MHz | | | | |

a. Reference supported frequencies range from 13 MHz to 52 MHz.

5 GHz Receiver Performance Specifications

Table 38: 5 GHz Receiver Performance Specifications

| Rate/Modulation | Typical Receive Sensitivity ^a |
|-----------------|--|
| 6 Mbps OFDM | –89.5 dBm |
| 9 Mbps OFDM | –89.0 dBm |
| 12 Mbps OFDM | 89.0 dBm |
| 18 Mbps OFDM | –88.5 dBm |
| 24 Mbps OFDM | –84.5 dBm |
| 36 Mbps OFDM | –81.5 dBm |
| 48 Mbps OFDM | –76.5 dBm |
| 54 Mbps OFDM | –74.5 dBm |

a. Values are measured at the BCM4325 input pin. Accordingly, they include insertion losses from the integrated baluns, but do not include the insertion loss of the external RF path. Reference sensitivity (10% PER for 1000-octet PSDU) at chip input.
Section 20: Internal Regulator Electrical Specifications

Note: Functional operation is not guaranteed outside specified limits. Operation outside these limits for extended periods may adversely affect the long-term reliability of the device.

CLDO

<u>/ľ</u>

Table 39: CLDO

| – mV steps 1.10 | 1.5 1.25 | 1.98 | Volt |
|--------------------|-------------|--|--|
| mV steps 1.10 | 1 25 | | |
| | 1.20 | 1.35 | Volt |
| _ | - | ±4 | % |
| _ | - | 200 | mA |
| _ | 10 | 15 | uA |
| _ | 0.1 | 10 | uA |
| ad – | 80 | _ | nV/rt Hz |
| pout – | 40 | - | dB |
| 150 | - | - | mV |
| - | _ | 0.5 | ms |
| | | mV steps 1.10 1.25 - - - - - 10 - 0.1 ad - 9pout - 150 - - - | mV steps 1.10 1.25 1.35 $ \pm 4$ $ -$ 200 $-$ 10 15 $-$ 0.1 10 ad $-$ 80 $ -$ 40 $ 150$ $ 0.5$ |

a. For good PSRR performance, the input supply should be at least 200 mV higher than the output.

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LNLDOI (I = 1, 2, OR 4)

LNLDO4 is only available in the 339-pin CSP package.

| Table 40: LNLDOi | | | | | | | |
|------------------------------------|------------------------|---------|---------|---------|----------|--|--|
| Specification | Notes | Minimum | Typical | Maximum | Unit | | |
| Input supply voltage ^a | LNLDOi_vo_sel=0 | - | 1.5 | 1.98 | Volts | | |
| | LNLDOi_vo_sel=1 | _ | 3.3 | 3.6 | | | |
| Output voltage | LNLDOi_vo_sel=0 | 1.10 | 1.25 | 1.35 | Volts | | |
| | LNLDOi_vo_sel=1 | 2.5 | 2.5 | 3.1 | | | |
| Absolute accuracy | - | _ | - | ±4 | % | | |
| Output current for LNLDO1 | _ | _ | _ | 130 | mA | | |
| Output current for LNLDO2 | - | _ | _ | 80 | mA | | |
| Output current for LNLDO4 | - | _ | _ | 80 | mA | | |
| Quiescent current for LNLDO1 | LNLDOi_vo_sel=0 | _ | 31 | 44 | uA | | |
| | LNLDOi_vo_sel=1 | _ | 110 | 206 | | | |
| Quiescent current for LNLDO2 and 4 | LNLDOi_vo_sel=0 | _ | 29 | 42 | uA | | |
| | LNLDOi_vo_sel=1 | - | 108 | 202 | | | |
| Leakage current for LNLDO1 | LNLDO1_pu=0 | _ | - | - | | | |
| | LNLDOi_vo_sel=0 | - | 0.1 | 5 | uA | | |
| | LNLDOi_vo_sel=1 | - | 0.1 | 9 | | | |
| Leakage current for LNLDO2 and 4 | LNLDO1_pu=0 | - | - | - | | | |
| | LNLDOi_vo_sel=0 | - | 0.1 | 2 | uA | | |
| | LNLDOi_vo_sel=1 | _ | 0.1 | 4 | | | |
| Output noise | @30 kHz, 50 mA load | - | - | - | | | |
| | LNLDOi_vo_sel=0 | - | 20 | - | nV/rt Hz | | |
| | LNLDOi_vo_sel=1 | _ | 31 | - | | | |
| PSRR | @1 kHz, 150 mV dropout | _ | 50 | _ | dB | | |
| Dropout voltage | - | 150 | _ | _ | mV | | |
| Start-up time | _ | _ | _ | 0.5 | ms | | |

a. For good PSRR performance, the input supply should be at least 200 mV higher than the output.

CORE BUCK REGULATOR

| Specification | Notes | Minimum | Typical | Maximum | Units |
|--|--|---------|-----------------|---------|-------|
| Input supply voltage | - | 2.3 | _ | 5.5 | Volts |
| PWM mode switching frequency | - | 2.24 | 2.8 | 3.36 | MHz |
| PWM output current | - | - | - | 300 | mA |
| Output voltage range | Programmable, 25 mV steps | 1 | 1.5 | 1.75 | Volts |
| PWM ripple voltage, static load | - | - | - | 20 | mVp-p |
| PWM ripple voltage, dynamic load | 200 mA, 1 μs rise/fall current step | - | - | 85 | mVp-p |
| Burst mode ripple voltage, static | - | - | - | 80 | mVp-p |
| PWM mode efficiency | 200 mA load current | 80 | 90 ^b | _ | % |
| Burst mode efficiency | 10 mA load current | 70 | 80 ^b | - | % |
| Quiescent current | Burst Mode | - | 25 | - | μA |
| | Low Power Burst Mode | - | 20 | _ | μA |
| | Power Down | - | 1 | - | μA |
| Start-up time from power down | - | | 500 | 1000 | μs |
| Settling time: burst to PWM mode | Ensure light-load (<30 mA) during mode-change | - | 200 | 400 | μs |
| Settling time: PWM to burst mode | Ensure light-load (<30 mA) during mode-change | - | - | 100 | μs |
| Input supply voltage ramp-up time 1 a | 0 to 4.3V | 44 | - | - | μs |
| Input supply voltage ramp-up time 2 ^a | 4.3 to 5.5V | 100 | _ | - | μs |

Table 41: Core Buck Regulator

a. The 0 to 4.3V and 4.3 to 5V ramp up assumes a Li-ion insertion causing a max ramp slope

b. VBAT=3.3V, Vout=1.5V, fsw=2.76 MHz, inductor DCR=160 mOhms.



BUCK-BOOST REGULATOR

| Specification | Notes | Minimum | Typical | Maximum | Unit |
|-------------------------------------|---|---------|-----------------|---------|-------------------|
| Input supply voltage | _ | 2.3 | _ | 5.5 | Volts |
| PWM mode switching frequency | _ | _ | 1.4 | | MHz |
| PWM output current | _ | _ | _ | 300 | mA |
| Output voltage range | Programmable, 50 mV steps | 2.25 | 3.3 | 3.5 | Volts |
| PWM ripple voltage, static | _ | _ | _ | 40 | mV _{p-p} |
| PWM ripple voltage, dynamic load | 100 mA, 1 μs rise/fall current step | . — | _ | 85 | mV _{p-p} |
| Burst mode ripple voltage, static | - | - | _ | 80 | mV _{p-p} |
| PWM mode efficiency | 200 mA load current | 70 | 86 ^b | _ | % |
| Quiescent current | Burst mode | - | 30 | - | μA |
| | No load | | | | |
| Start-up time from power down | _ | _ | 500 | 1000 | μs |
| Settling time: Burst-to-PWM mode | Ensure light-load (<30 mA) during mode change | _ | 200 | 400 | μs |
| Settling time: PWM-to-Burst mode | Ensure light-load (<30 mA) during mode change | - | - | 100 | μs |
| Input supply voltage ramp-up time 1 | 0 to 4.3V ^a | 44 | _ | _ | μs |
| Input supply voltage ramp up time 2 | 4.3 to 5.5V ^a | 100 | - | - | μs |

Table 42: Buck-Boost Regulator

a. The 0 to 4.3V and 4.3 to 5V ramp up assumes a Li-ion insertion causing a max ramp slope.

b. VBAT=3.65V, Vout=3.3V, fsw=1.38 MHz, inductor DCR=156 mOhms.

Section 21: Interface Timing and AC Characteristics



Note: Unless otherwise stated, all specifications in this section apply to the operating temperature and voltage ranges specified in Table 20 and Table 22 on page 76 and Table 23 on page 76. Functional operation outside these limits is not guaranteed.

BLUETOOTH PERIPHERAL TRANSPORT UNIT TIMING SPECIFICATIONS

This section describes the Peripheral Transport Unit (PTU) timing.

The following conditions apply:

 $V_{DD} = 3.3V$, $V_{SS} = 0V$, $T_{A} = 0$ to 85 °C

BLUETOOTH UART TIMING



Figure 16: UART Timing

| Reference | Description | Minimum | Typical | Maximum | Unit |
|-----------|--|---------|---------|---------|----------------|
| 1 | Delay time, BT_UART_CTS_N low to UART_TXD valid | - | - | 24 | Baudout cycles |
| 2 | Setup time, BT_UART_CTS_N high before midpoint of stop bit | - | - | 10 | ns |
| 3 | Delay time, midpoint of stop bit to BT_UART_RTS_N high | _ | _ | 2 | Baudout cycles |

PCM INTERFACE TIMING

Short Frame Sync, Master Mode



Figure 17: PCM (Short Frame Sync, Master Mode) Timing

| Table 44· | PCM (Short | Frame Sync | Master Mode) | Timina | Specifications |
|------------|-------------|-------------|--------------|----------|----------------|
| i abie 44. | FCIM (SHOIL | Frame Sync, | master moue) | riiiiiig | Specifications |

| Reference | Description | Minimum | Typical | Maximum | Unit |
|-----------|--|---------|---------|---------|------|
| 1 | PCM bit clock frequency | 128 | - | 2048 | kHz |
| 2 | PCM bit clock high time | 128 | - | _ | ns |
| 3 | PCM bit clock low time | 209 | - | _ | ns |
| 4 | Delay from BT_PCM_CLK rising edge to BT_PCM_SYNC high | - | - | 50 | ns |
| 5 | Delay from BT_PCM_CLK rising edge to BT_PCM_SYNC low | _ | - | 50 | ns |
| 6 | Delay from BT_PCM_CLK rising edge to data valid on BT_PCM_OUT | - | - | 50 | ns |
| 7 | Setup time for BT_PCM_IN before BT_PCM_CLK falling edge | 50 | - | - | ns |
| 8 | Hold time for BT_PCM_IN after BT_PCM_CLK falling edge | 10 | - | - | ns |
| 9 | Delay from falling edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance | - | - | 50 | ns |

Short Frame Sync, Slave Mode



Figure 18: PCM (Short Frame Sync, Slave Mode) Timing

| Reference | Description | Minimum | Typical | Maximum | Unit |
|-----------|--|---------|---------|---------|------|
| 1 | PCM bit clock frequency | 128 | _ | 2048 | kHz |
| 2 | PCM bit clock high time | 209 | - | - | ns |
| 3 | PCM bit clock low time | 209 | - | - | ns |
| 4 | Setup time for BT_PCM_SYNC before falling edge of BT_PCM_BCLK | 50 | - | _ | ns |
| 5 | Hold time for BT_PCM_SYNC after falling edge of BT_PCM_CLK | 10 | - | _ | ns |
| 6 | Hold time of BT_PCM_OUT after BT_PCM_CLK falling edge | _ | _ | 175 | ns |
| 7 | Setup time for BT_PCM_IN before BT_PCM_CLK falling edge | 50 | _ | - | ns |
| 8 | Hold time for BT_PCM_IN after BT_PCM_CLK falling edge | 10 | - | - | ns |
| 9 | Delay from falling edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance | - | - | 100 | ns |



Long Frame Sync, Master Mode



Figure 19: PCM (Long Frame Sync, Master Mode) Timing

| Reference | Description | Minimum | Typical | Maximum | Unit |
|-----------|--|---------|---------|---------|------|
| 1 | PCM bit clock frequency | 128 | - | 2048 | kHz |
| 2 | PCM bit clock high time | 209 | - | - | ns |
| 3 | PCM bit clock low time | 209 | - | - | ns |
| 4 | Delay from BT_PCM_CLK rising edge to BT_PCM_SYNC high during first bit time | - | - | 50 | ns |
| 5 | Delay from BT_PCM_CLK rising edge to BT_PCM_SYNC low during third bit time | - | - | 50 | ns |
| 6 | Delay from BT_PCM_CLK rising edge to data valid on BT_PCM_OUT | - | - | 50 | ns |
| 7 | Setup time for BT_PCM_IN before BT_PCM_CLK falling edge | 50 | - | - | ns |
| 8 | Hold time for BT_PCM_IN after BT_PCM_CLK falling edge | 10 | - | - | ns |
| 9 | Delay from falling edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance | - | _ | 50 | ns |
| | | | | | - |

Table 46: TPCM (Long Frame Sync, Master Mode) Timing Specifications

Long Frame Sync, Slave Mode



Figure 20: PCM (Long Frame Sync, Slave Mode) Timing

| Reference | Description | Min | Тур | Max | Unit |
|-----------|--|-----|-----|------|------|
| 1 | PCM bit clock frequency | 128 | _ | 2048 | kHz |
| 2 | PCM bit clock high time | 209 | _ | _ | ns |
| 3 | PCM bit clock low time | 209 | _ | _ | ns |
| 4 | Setup time for BT_PCM_SYNC before falling edge of BT_PCM_CLK during first bit time | 50 | - | - | ns |
| 5 | Hold time for BT_PCM_SYNC after falling edge of BT_PCM_CLK during second bit period. (BT_PCM_SYNC may go low any time from second bit period to last bit period) | 10 | - | - | ns |
| 6 | Delay from rising edge of BT_PCM_CLK or BT_PCM_SYNC (whichever is later) to data valid for first bit on BT_PCM_OUT | _ | - | 50 | ns |
| 7 | Hold time of BT_PCM_OUT after BT_PCM_CLK falling edge | - | - | 175 | ns |
| 8 | Setup time for BT_PCM_IN before BT_PCM_CLK falling edge | 50 | _ | _ | ns |
| 9 | Hold time for BT_PCM_IN after BT_PCM_CLK falling edge | 10 | _ | - | ns |
| 10 | Delay from falling edge of BT_PCM_CLK or BT_PCM_SYNC (whichever is later) during last bit in slot to BT_PCM_OUT becoming high impedance | _ | - | 100 | ns |

| Table 17. | PCM /I ong | Eramo Sunc | Slave Mode) | Timina | Specifications |
|------------|------------|-------------|-------------|----------|----------------|
| 1 avie 47. | FCIM (LONG | Frame Sync, | Slave Mouej | riiiiiig | Specifications |

FM I²S TIMING

The timing illustrated in Figure 21 and Figure 22 are described in Table 48 on page 102.

Note: The times given in Figure 21 and Figure 22 are determined by the transmitter speed. The specification of the receiver must be capable of matching the performance of the transmitter.







Figure 22: I²S Receiver Timing



| | Transmitter | | | Receiver | | | | | |
|-------------------------------------|-----------------|---------------------|--------------------------|----------|----------------|---------------------|-------------|-----|-------|
| Parameter | Lower Limit | | Upper Limit | | Lower Limit | | Upper Limit | | Notes |
| | Min | Max | Min | Max | Min | Max | Min | Max | - |
| Clock Period T ^b | T _{TR} | _ | _ | - | T _r | _ | - | - | а |
| Master Mode: Clock generat | ed by trai | nsmitter o | or receiver ^a | ; | | | | | |
| High t _{HC} | $0.35T_{TR}$ | _ | _ | - | $0.35T_{TR}$ | _ | - | _ | b |
| Low t _{LC} | $0.35T_{TR}$ | _ | _ | _ | $0.35T_{TR}$ | _ | _ | _ | b |
| Slave Mode: Clock accepted | l by trans | mitter or r | receiver ^d | | | | | | |
| High t _{HC} | _ | $0.35T_{TR}$ | _ | - | _ | 0.35T _{TR} | - | _ | С |
| Low t _{LC} | _ | 0.35T _{TR} | _ | - | _ | 0.35T _{TR} | _ | _ | С |
| Rise-time t _{RC} | _ | _ | 0.15T _{TR} | _ | _ | _ | | _ | d |
| Transmitter | | | | | | | | | |
| Delay t _{DTR} ^e | - | _ | _ | 0.8T | - | - | - | _ | е |
| Hold time t _{HTR} | 0 | - | _ | _ | _ | _ | _ | _ | d |
| Receiver ^f | | | | | | | | | |
| Setup time t _{SR} | _ | _ | _ | - | _ | 0.2T _R | _ | _ | f |
| Hold time t _{HR} | - | - | - | _ | - | 0 | - | - | f |

Table 48: Timing for I²S Transmitters and Receivers^a

a. All timing values are specified with respect to high and low threshold levels.

b. The system clock period T must be greater than T_{TR} and T_r because both the transmitter and receiver must be able to handle the data transfer rate.

c. The transmitter or receiver generates a clock signal with a fixed mark/space ratio. For this reason t_{HC} and t_{LC} are specified with respect to T.

d. The transmitter and receiver need a clock signal with minimum high and low periods so that they can detect the signal. So long as the minimum periods are greater than $0.35T_{\rm R}$, any clock that meets the requirements can be used.

e. Because the delay (t_{DTR}) and the maximum transmitter speed (defined by T_{TR}) are related, a fast transmitter driven by a slow clock edge can result in t_{DTR} not exceeding t_{RC} which means t_{HTR} becomes zero or negative. Therefore, the transmitter has to guarantee that t_{HTR} is greater than or equal to zero, provided the clock rise-time t_{RC} is not more than t_{RCmax} , where t_{RCmax} is not less than 0.15T_{TR}. To allow data to be clocked out on a falling edge, the delay is specified with respect to the rising edge of the clock signal and T, always giving the receiver sufficient setup time.

f. The data setup and hold time must not be less than the specified receiver setup and hold time.



FM I²C-COMPATIBLE TIMING



Table 49: FM I2C-Compatible Interface Timing

| Parameter | Symbol | Minimum | Maximum | Unit |
|--|---------------------|-------------------------------------|---------|------|
| I2C_CK clock frequency | f _{I2C_CK} | 0 | 400 | kHz |
| Bus-free times between a stop and start condition | t _{BUF} | 1.3 | _ | μs |
| Hold time (repeated) start condition. After this period, the first clock pulse is generated. | t _{HD,STA} | 0.6 | - | μs |
| Low period of the I2C_CK clock | t _{LOW} | 1.3 | _ | μs |
| High period of the I2C_CK clock | t _{HIGH} | 0.6 | _ | μs |
| Setup time for a repeater start condition | t _{SU,STA} | 0.6 | - | μs |
| Data hold time | t _{HD,DAT} | 0 | 0.9 | μs |
| Data setup time | t _{SU,DAT} | _ | - | μs |
| Rise time of both I2C_DA and I2C_CK signals | t _r | 20 + 0.1C _b ^a | 300 | ns |
| Fall time of both I2C_DA and I2C_CK signals | t _r | 20 + 0.1C _b ^a | 300 | ns |
| Setup time for stop condition | t _{SU,STO} | 0.6 | - | μs |

a. C_b = Total capacitance of one bus line in pF. The maximum capacitive load for each bus line is 400 pF.

SPROM TIMING

Table 50: SPROM Timing Characteristics

| Signal Name | Period | Output Max | Output Min | Setup | Hold |
|--------------------------------------|---------|------------|------------|--------|---------|
| SPROM_CLK | 1.92 μs | - | - | _ | - |
| SPROM_CLK falling edge to SPROM_DOUT | - | 0.5 μs | 0.3 µs | _ | - |
| SPROM_CLK falling edge to SPROM_CS | - | 0.5 μs | 0.3 µs | _ | - |
| SPROM_CLK rising edge to SPROM_DIN | - | - | - | 0.5 μs | –0.3 μs |

JTAG TIMING

| Table 51: | JTAG | Timing | Characteristics |
|-----------|------|--------|-----------------|
|-----------|------|--------|-----------------|

| Signal Name | Period | Output Max | Output Min | Setup | Hold |
|-------------|--------|------------|------------|-------|------|
| ТСК | 125 ns | _ | - | - | - |
| TDI | _ | _ | _ | 20 ns | 0 ns |
| TMS | _ | _ | - | 20 ns | 0 ns |
| TDO | _ | 100 ns | 0 ns | - | - |
| JTAG_TRST | 250 ns | _ | _ | - | - |

SDIO TIMING

This section describes the SDIO timing in both default and high-speed modes.



Figure 23: SDIO Bus Timing (Default Mode)



| Parameter | Symbol | Min | Typical | Max | Unit | | |
|--|--------|-----|---------|-----|------|--|--|
| Clock: SDIO_CLK (All values are referred to min. VIH and max. VIL ^b) | | | | | | | |
| Frequency—Data Transfer Mode | fPP | 0 | _ | 25 | MHz | | |
| Frequency—Identification Mode | fOD | 0 | - | 400 | kHz | | |
| Clock Low Time | tWL | 10 | _ | - | ns | | |
| Clock High Time | tWH | 10 | _ | - | ns | | |
| Clock Rise time | tTLH | _ | _ | 10 | ns | | |
| Clock Low Time | tTHL | _ | _ | 10 | ns | | |
| Inputs: CMD, DATA (referenced to SDIO_CLK) | | | | | | | |
| Input Setup Time | tISU | 5 | _ | - | ns | | |
| Input Hold Time | tIH | 5 | _ | _ | ns | | |
| Outputs: CMD, DATA (referenced to SDIO_CLK) | | | | | | | |
| Output Delay time—Data Transfer Mode | tODLY | 0 | _ | 14 | ns | | |
| Output Delay time—Identification Mode | tODLY | 0 | _ | 50 | ns | | |
| | | | | | | | |

Table 52: SDIO Bus Timing ^a Parameters (Default Mode)

a. Timing is based on CL \leq 40pF load on CMD and Data.

b. min (Vih) = 0.7*Vdd and max (Vil) = 0.2*Vdd



Figure 24: SDIO Bus Timing (High-Speed Mode)



| Parameter | Symbol | Min | Typical | Max | Unit |
|--|-----------------------|-----|---------|-----|------|
| Clock: SDIO_CLK (all values are referred to min. VIH and max | k. VIL ^b) | | | | |
| Frequency—Data Transfer Mode | fPP | 0 | _ | 50 | MHz |
| Frequency—Identification Mode | fOD | 0 | _ | 400 | kHz |
| Clock Low Time | tWL | 7 | _ | _ | ns |
| Clock High Time | tWH | 7 | _ | _ | ns |
| Clock Rise time | tTLH | _ | _ | 3 | ns |
| Clock Low Time | tTHL | _ | _ | 3 | ns |
| Inputs: CMD, DATA (referenced to SDIO_CLK) | | | | | |
| Input Setup Time | tISU | 6 | _ | _ | ns |
| Input Hold Time | tIH | 2 | _ | _ | ns |
| Outputs: CMD, DATA (referenced to SDIO_CLK) | | | | | |
| Output Delay time—Data Transfer Mode | tODLY | _ | _ | 14 | ns |
| Output Hold time | tOH | 2.5 | _ | _ | ns |
| Total System Capacitance (each line) | CL | _ | _ | 40 | pF |
| Tining is here day OL 440 Elevel of OMD and Date | | | | | |

Table 53: SDIO Bus Timing ^a Parameters (High-Speed Mode)

a. Timing is based on CL \leq 40pF load on CMD and Data. b. Minimum (Vih) = 0.7*Vdd and maximum (Vil) = 0.2*Vdd



Section 22: Power-Up Sequence and Timing

SDIO HOST TIMING REQUIREMENT

The SDIO host must wait a minimum of 150 ms before initiating access to the BCM4325 after the VDDC (1.25V DC supply for core) ramps up and settles. The specifics of this requirement depend on the power supply topology being used. For example, if the topology shown in Figure 5 on page 4 is being used, reset and host access timing depends on the CLDO and CBUCK outputs and the VDDC's bypass network. For an additional safety margin, a longer delay should be used.

RESET AND REGULATOR CONTROL SIGNAL SEQUENCING

The BCM4325 has four signals (see Table 54) that enable or disable the Bluetooth, WLAN, and internal regulator blocks, allowing the host to control power consumption. This section contains detailed timing diagrams of these signals and the required power-up sequences. These timing diagrams are provided to illustrate proper sequencing of the signals in various operational states. The timing values indicated in the diagrams are the minimum requirements. Longer delays are also acceptable.

| Table 54: | Control | Signal | Descriptions |
|-----------|---------|--------|--------------|
|-----------|---------|--------|--------------|

| Signal | Description |
|-----------|--|
| WL_REG_ON | This signal is used by the PMU (along with BT_REG_ON) to decide whether or not to power down the internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. If WL_RST_N is low (regardless of BT_RST_N state), the WLAN core will be powered off. |
| BT_REG_ON | This signal is used by the PMU (along with WL_REG_ON) to decide whether or not to power down the internal BCM4325 regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. |
| WL_RST_N | Low Asserting Reset for WLAN Core This pin must be driven high or low (not left floating). |
| BT_RST_N | Low asserting reset for Bluetooth core. This pin must be driven high or low (not left floating) |



Note: WL_REG_ON and BT_REG_ON are OR gated together in the BCM4325.



SIGNAL AND POWER-UP SEQUENCE TIMING DIAGRAMS

Note: The timing diagrams presented in this section are not to scale and are for illustrative purposes only.

The timing diagrams show the signals going high at the same time (which is true when both REG signals are controlled by a single host GPIO). However, if two independent host GPIOs are used (one for WL_REG_ON and one for BT_REG_ON), only one signal has to be high in order to enable the BCM4325's regulators. Additionally, the reset requirements for the Bluetooth core also apply to the FM core. Therefore, if FM is to be used, the Bluetooth core must be enabled.



Figure 25: Power-Up Timing for WL On and BT On



Figure 26: Power-Up Timing for WL On and BT Off

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Figure 27: Power-Up Timing for WL Off and BT On



Figure 28: Power-Up Timing for WL Off and BT Off (VDDC Provided by BCM4325)

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Figure 29: Power-Up Timing for WL Off and BT Off (VDDC Provided Externally)



Figure 30: Power-Up Timing for WL On and BT On (REG_ON signals are connected to RST_N signals)



Figure 31: Power-Up Timing for WL Off and BT On (REG_ON signals are connected to RST_N signals)



Figure 32: Power-Up Timing for WL ON and BT ON (WL REG_ON signal connected to WL_RST_N, BT separated)

BCM4325



Figure 33: Power-Up Timing for WL OFF and BT ON (WL REG_ON signal connected to WL_RST_N, BT separated)



Figure 34: Power-Up Timing for WL ON and BT OFF (WL REG_ON signal connected to WL_RST_N, BT separated)



Section 23: Package Information

PACKAGE THERMAL CHARACTERISTICS

| Table 55: | Thermal | Characteristics | (Values in | Still Air) ² |
|-----------|---------|-----------------|------------|-------------------------|
|-----------|---------|-----------------|------------|-------------------------|

| Characteristic | 196-Ball FBGA Package | 339-WLCSP Package |
|--|-----------------------|-------------------|
| θ _{JA} (°C/W) | 36.3 | 36.7 |
| $\theta_{\sf JB}$ (°C/W) | 4.9 | 1.23 |
| θ_{JC} (°C/W) | 10.9 | 0.06 |
| <u>Ψ</u> JT (°С/W) | 0.27 | 0.27 |
| Maximum Junction Temperature T _j (°C) | 125 | 125 |

a. No heat sink, TA = 70° C. This is an estimate based on a 2-layer PCB and P = 1.2W continuous dissipation.

JUNCTION TEMPERATURE ESTIMATION AND PSIJT VERSUS THETAJC

Package thermal characterization parameter PSI-J_T (Ψ_{JT}) yields a better estimation of actual junction temperature (T_J) versus using the junction-to-case thermal resistance parameter Theta-J_C (θ_{JC}). The reason for this is θ_{JC} assumes that all the power is dissipated through the top surface of the package case. In actual applications, some of the power is dissipated through the bottom and sides of the package. Ψ_{JT} takes into account power dissipated through the top, bottom. and sides of the package. The equation for calculating the device junction temperature is as follows:

 $T_J = T_T + P \times \Psi_{JT}$

Where:

- T_J = Junction temperature at steady-state condition (°C)
- T_T = Package case top center temperature at steady-state condition (°C)
- P = Device power dissipation (Watts)
- Ψ_{JT} = Package thermal characteristics; no airflow (°C/W)

ENVIRONMENTAL CHARACTERISTICS

For environmental characteristics data, see "Environmental Ratings" on page 76.

MISCELLANEOUS CHARACTERISTICS

Table 56: Miscellaneous Characteristics

| Characteristics | Value | Units | Conditions/Comments |
|----------------------------------|------------------|-------|---------------------|
| Moisture Sensitivity Level (MSL) | 3 | _ | - |
| Ball Metallurgy | SnAg1.0Cu0.5 | _ | - |
| Under bump Metallurgy | E'lytic Ti/Cu/Ni | _ | - |
| With bump Metallurgy | SnCu2.5 | _ | - |
| FBGA peak reflow temperature | 260 | °C | - |



Section 24: Mechanical Information



196-BALL FBGA PACKAGE



339-PIN WLCSP PACKAGE





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Section 25: WLCSP Keepout Area

This section shows the PCB keepout areas of the BCM4325 WLCSP package; there should not be any metal on these layers.



Figure 37: WLAN Section Top Metal Keepout Area



Figure 38: WLAN Section Second Metal Keepout Area



Figure 39: BT and FM Keepout Area



Note: The shaded area in Figure 39 is enlarged in Figure 40 on page 119.



Figure 40: BT and FM first and Second Keepout Area Enlargement



Note: Figure 40 above is an enlargement of the BT and FM keepout area; see Figure 39 on page 119 to view the entire layer.



Section 26: Ordering Information

| Part Number | Package | Ambient Temperature |
|--------------|---|---------------------|
| BCM4325GKFBG | Single-band 2.4 GHz WLAN, Bluetooth 3.0 + HS, 196-ball flip-chip FBGA (7.5 mm x 7.5 mm x 1.05 mm, 0.50 mm pitch) | -30°C to +85°C |
| BCM4325FKFBG | Single-band 2.4 GHz WLAN, Bluetooth 3.0 + HS, FM Rx, 196-ball flip-chip FBGA (7.5 mm x 7.5 mm x 1.05 mm, 0.50 mm pitch) | -30°C to +85°C |
| BCM4325GKWBG | Single-band 2.4 GHz WLAN, Bluetooth 3.0 + HS, 339-pin WLCSP (6.51 mm X 5.8 mm X 0.4 mm, 0.250 mm pitch) | -30°C to +85°C |
| BCM4325FKWBG | Single-band 2.4 GHz WLAN, Bluetooth 3.0 + HS, FM Rx, 339-pin WLCSP (6.51 mm X 5.8 mm X 0.4 mm, 0.250 mm pitch) | -30°C to +85°C |

Table 57: Ordering Information



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